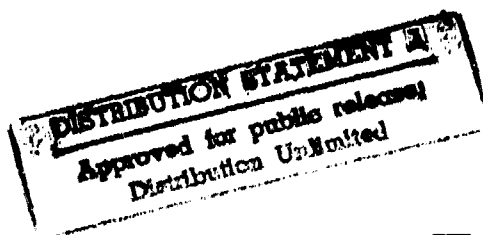
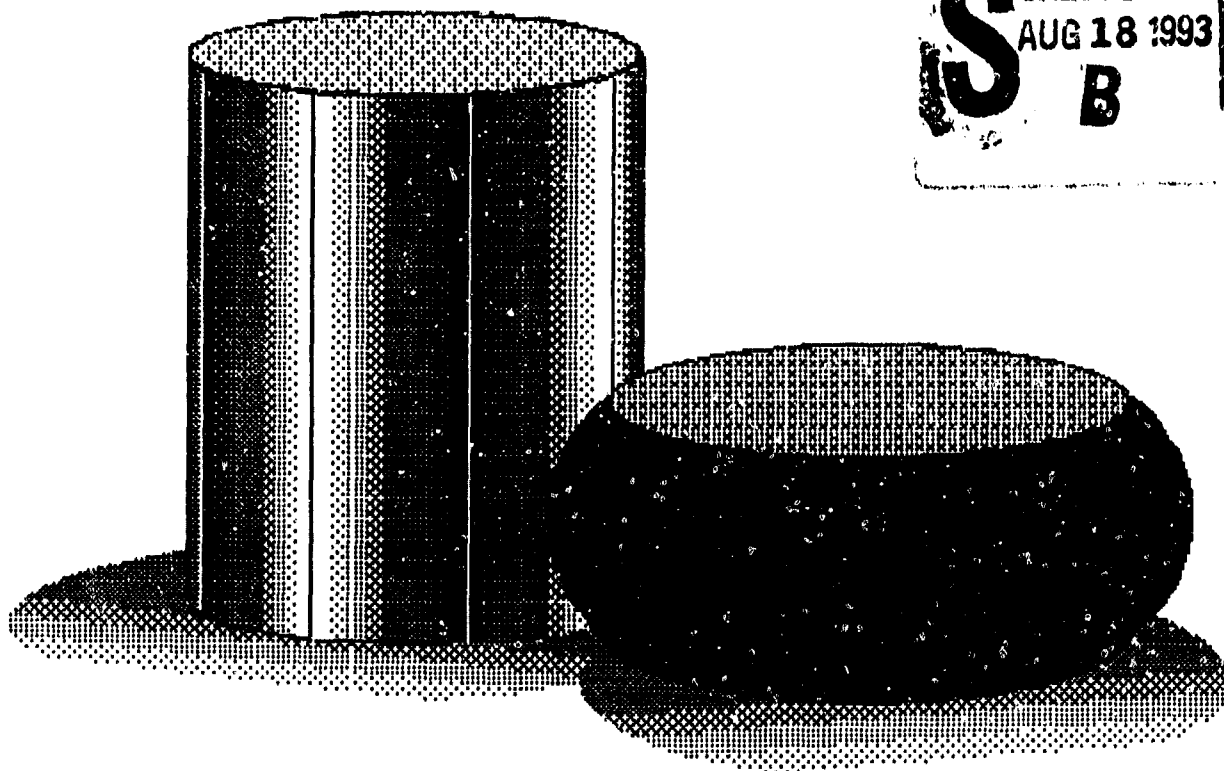
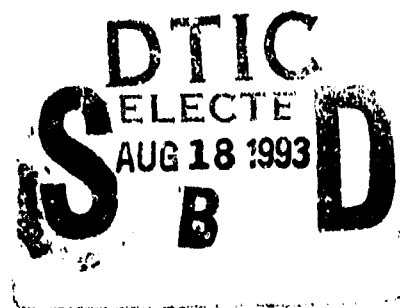


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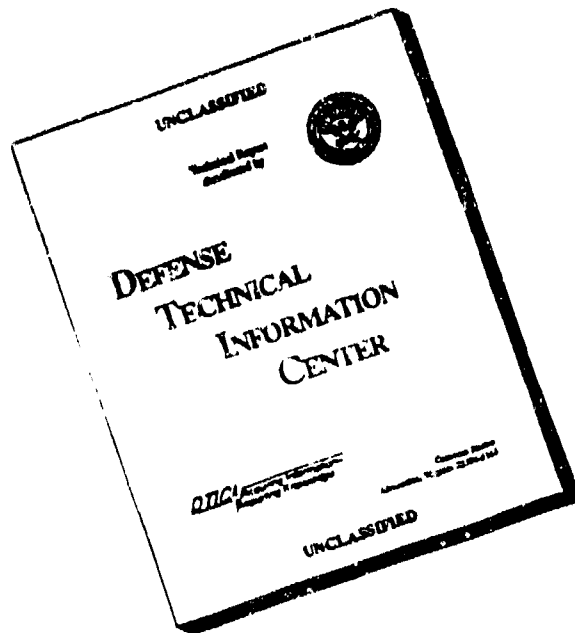
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ATLAS OF FORMABILITY

TI-6AL-4V ELI

by

Prabir K. Chaudhury and Dan Zhao

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for

**Naval Industrial Resource Support Activity
Building 75-2, Naval Base
Philadelphia, PA 19112-5078**

October 31, 1992

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Ti-6Al-4V ELI

Introduction

Ti-6Al-4V is one of the conventional titanium alloys with a variety of applications in the aerospace industry. The understanding of mechanical and microstructural behavior during high temperature deformation is very important for this alloy since the microstructure and mechanical properties are strongly affected by the thermomechanical processing history. In this investigation, the flow behavior of Ti-6Al-4V, ELI grade was studied by conducting compression testing at various temperatures and strain rates. Constitutive relations were determined from the flow behavior and then, a dynamic material modeling for this alloy was performed. Thus, the optimum processing conditions in terms of temperature and strain rate were determined. Microstructural changes during high temperature deformation were also characterized to aid process design engineers to select processing conditions in terms of resulting microstructure.

Experimental Procedure

The material used in this investigation was commercially available Ti-6Al-4V ELI in the form of hot rolled and annealed bar with a 0.687 inch diameter. The typical microstructure of the as-received materials consisted of elongated α grains with an aspect ratio of 1.8 containing very fine intergranular β as shown in Figure 1. The composition of this alloy is as follows:

C	N	Fe	Al	V	Y	O	H
0.01	0.011	.20	5.80	3.82	<50PPM	0.124	62PPM

Cylindrical compression test specimens with a diameter of 12.7 mm and a height of 15.9 mm were machined from the bars. Isothermal compression tests in vacuum environment were conducted on an MTS machine. The test matrix was as follows:

Temperature, C (F):	800 (1472), 850 (1562), 900 (1652), 950 (1742), 1000 (1832), 1040 (1904), 1080 (1976);
Strain rate, s ⁻¹ :	0.001, 0.01, 0.1, 1, 5 and 25.

Load and stroke data from the testing was acquired by a computer and later converted to true stress-true strain curves. Immediately after the compression test, the specimens were quenched with forced helium gas in order to retain the deformed microstructure. Longitudinal section of the specimens were examined with optical microscope and photomicrographs were taken from the center of the longitudinal section of the specimens.

Results

Table 1 gives a list of the figures, testing conditions and the observed microstructures. The true stress-true strain flow curves with the corresponding deformed microstructure are shown in Figure 2 to Figure 43. True stress versus strain rate was plotted in a log-log scale in Figure 44 at a true strain of approximately 0.3. The slope of the plot gives the strain rate sensitivity m , which is not constant over the range of strain rate tested. Log stress vs. $1/T$ at the same true strain is shown in Figure 45. A processing map at this strain was developed and is shown in Figure 46. The optimum processing condition from the map can be obtained by selecting the temperature and strain rate combination which provides the maximum efficiency in the stable region. This condition is approximately 896 C and 0.001 s⁻¹ for this material.

Table 1. List of figures, testing conditions and microstructural observations for Ti-6Al-4V ELI

Figure No	Temperature C (F)	Strain Rate s ⁻¹	Microstructure Optical Microscopy	Page No
1	As received		Elongated α grains with an aspect ratio of 1.8 containing very fine intergranular β .	4
2	800 (1472)	0.001	Equiaxed α grains with a uniform size of $\sim 5.5 \mu\text{m}$ containing $\sim 10\text{-}15\%$ of very fine intergranular β .	5
3	800 (1472)	0.01		6
4	800 (1472)	0.1	Equiaxed α grains with a uniform size of $\sim 5 \mu\text{m}$ containing $\sim 10\text{-}15\%$ of very fine intergranular β .	7
5	800 (1472)	1	Equiaxed α grains with a size of $\sim 5 \mu\text{m}$, but there is a small proportion of α elongated grains. Very fine β is present at the grain boundaries.	8
6	800 (1472)	5		9
7	800 (1472)	25	Elongated and equiaxed α grains. the equiaxed grains ($\sim 20\%$) have a size of $\sim 4 \mu\text{m}$. Very fine intergranular β .	10
8	850 (1562)	0.001	Equiaxed α grains with an irregular size. The smaller grains are in a proportion of $10\text{-}12\%$ and have a size of $1\text{-}3 \mu\text{m}$. The larger α grains have an average size of $\sim 10 \mu\text{m}$. β is fine and intergranular.	11
9	850 (1562)	0.01	Equiaxed α grains with an average size of $\sim 7 \mu\text{m}$ and a small proportion ($\sim 3\%$) of α grains with a size between $1\text{-}3 \mu\text{m}$. β is intergranular.	12
10	850 (1562)	0.1	Small equiaxed α grains ($\sim 5 \mu\text{m}$). There are some larger α grains with a size of $\sim 7 \mu\text{m}$. β is intergranular.	13
11	850 (1562)	1		14
12	850 (1562)	5	Same as above.	15
13	850 (1562)	25	Equiaxed α grains with a duplex size. The larger grains have a size of $\sim 5 \mu\text{m}$. The smaller grains are in a proportion of $\sim 5\%$ and have a size of $\sim 1\text{-}2 \mu\text{m}$. β is very fine and is intergranular.	16
14	900 (1652)	0.001	Uniform equiaxed α grains with an average size of $5.4 \mu\text{m}$ and $\sim 3\text{-}5\%$ of very fine acicular α (transformed β). There is also some intergranular β .	17
15	900 (1652)	0.01		18

16	900 (1652)	0.1	Equiaxed α grains with a uniform size ($\sim 5 \mu\text{m}$). There is a small proportion of very fine acicular α (transformed β grains of $\sim 3 \mu\text{m}$). There is also the presence of intergranular β .	19
17	900 (1652)	1	Equiaxed α grains with an irregular size. Although the larger proportion of the α grains have a size of $\sim 4 \mu\text{m}$. The smaller α grains have a size of $\sim 2 \mu\text{m}$. There is $\sim 1\%$ of transformed β containing very fine acicular α and, β is very fine and intergranular.	20
18	900 (1652)	5		21
19	900 (1652)	25	Equiaxed α grains with a uniform size ($\sim 7 \mu\text{m}$). There is very fine transformed β at the grain boundary triple points, in addition to a small proportion of intergranular β .	22
20	950 (1742)	0.001	Equiaxed α grains with a uniform size ($7.1 \pm 0.6 \mu\text{m}$). There is $\sim 10\%$ of acicular α (transformed β) and intergranular β .	23
21	950 (1742)	0.01	Equiaxed α grains with a uniform size ($\sim 6 \mu\text{m}$). There is $\sim 10\text{-}12\%$ of acicular α (transformed β) with intergranular β .	24
22	950 (1742)	0.1	Same as above	25
23	950 (1742)	1	Same as above. But the grain size is smaller ($\sim 4.5 \mu\text{m}$) and $15\text{-}20\%$ of acicular α . The acicular spacing is $\sim 1.7 \mu\text{m}$.	26
24	950 (1742)	5	Same as above	27
25	950 (1742)	25	Equiaxed α grains with a uniform size ($7.8 \pm 0.5 \mu\text{m}$). There is $\sim 15\%$ of acicular α (transformed β) and intergranular β .	28
26	1000 (1882)	0.001	Large equiaxed transformed β grains ($\sim 194 \pm 30 \mu\text{m}$) into plate-like $\alpha+\beta$, and α at prior β grain boundaries. The α plate spacing is $\sim 1.8 \mu\text{m}$.	29
27	1000 (1882)	0.01	Same as above, but the prior β grains are $\sim 180 \mu\text{m}$ and the interplate or interlamellar spacing is approximately $1.6 \mu\text{m}$.	30
28	1000 (1882)	0.1	Same as above, but the prior β grains are slightly smaller.	31
29	1000 (1882)	1	Large equiaxed transformed β grains into plate-like $\alpha+\beta$ and some coarse acicular α , and α at prior β grain boundaries.	32
30	1000 (1882)	5		33
31	1000 (1882)	25	Same as above, but smaller grain size.	34
32	1040 (1904)	0.001	Large equiaxed transformed β grains ($\sim 280 \mu\text{m}$) into plate-like $\alpha+\beta$ and some coarse acicular α , and α at prior β grain boundaries.	35

33	1040 (1904)	0.01	Same as above, but the grain size is approximately 200 μm , while the interlamellar spacing was found to be $\sim 2\mu\text{m}$.	36
34	1040 (1904)	0.1		37
35	1040 (1904)	1	Same as above, but smaller grain size (270 μm).	38
36	1040 (1904)	5		39
37	1040 (1904)	25	Same as above, but smaller grain size (240 μm).	40
38	1080 (1976)	0.001	Very large equiaxed transformed β grains into a very fine plate-like $\alpha + \beta$, The α -phase at prior β grain boundaries is relatively thicker than at the strain rates analyzed below.	41
39	1080 (1976)	0.01		42
40	1080 (1976)	0.1	Same as above, but thinner prior β grain boundaries.	43
41	1080 (1976)	1	Very large equiaxed transformed β grains into plate-like $\alpha + \beta$ and, α at prior β grain boundaries.	44
42	1080 (1976)	5		45
43	1080 (1976)	25	Large equiaxed transformed β grain into plate-like $\alpha + \beta$ and, α at prior β grain boundaries.	46

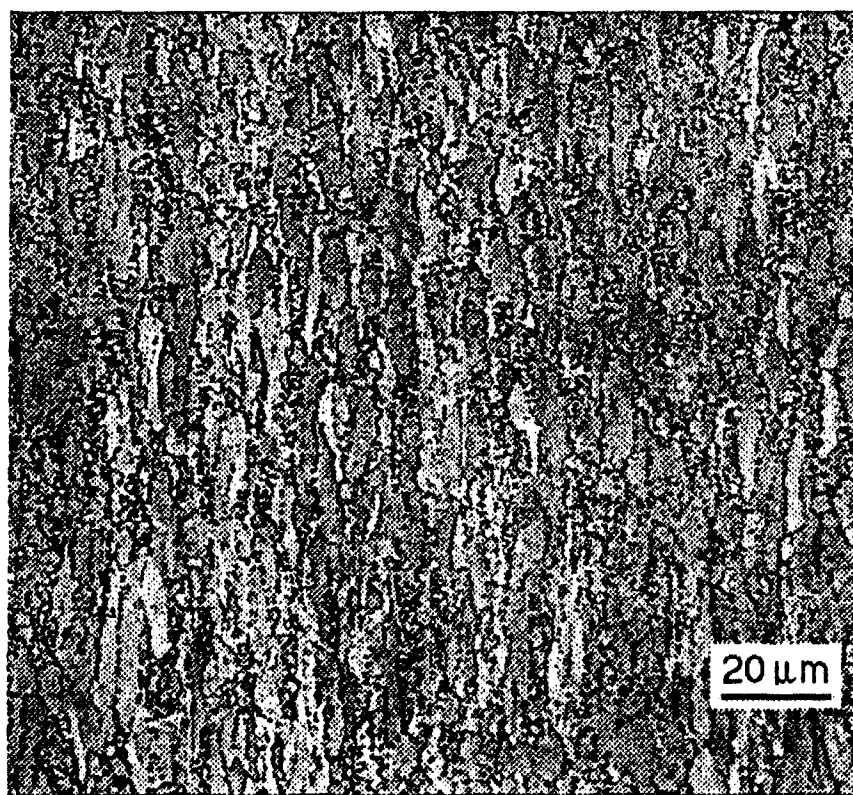


Figure 1. As-received microstructure of Ti-6Al-4V ELI.

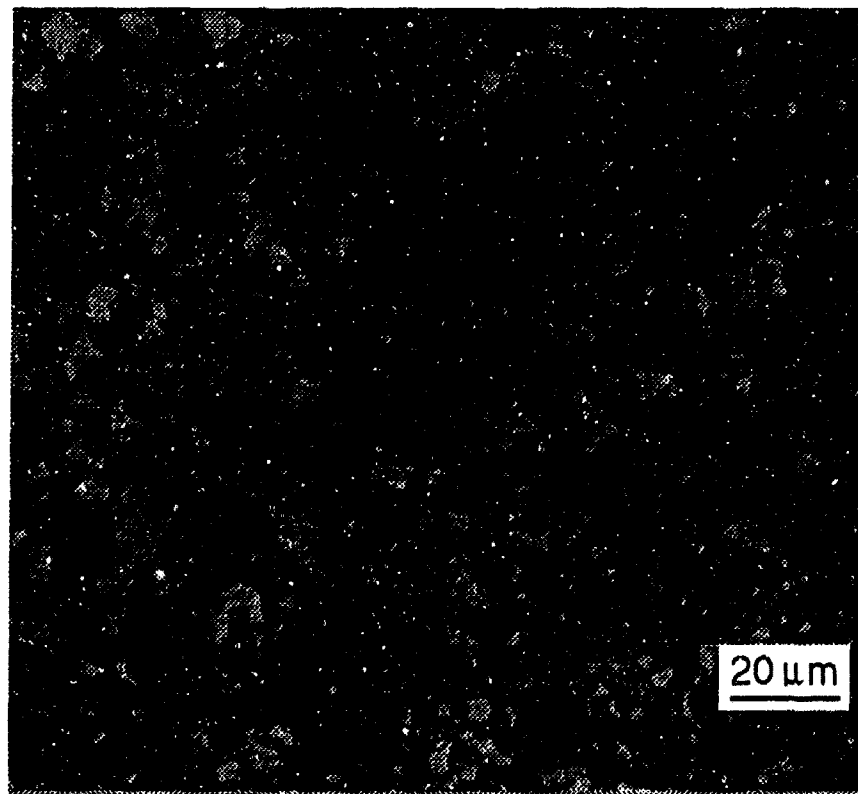
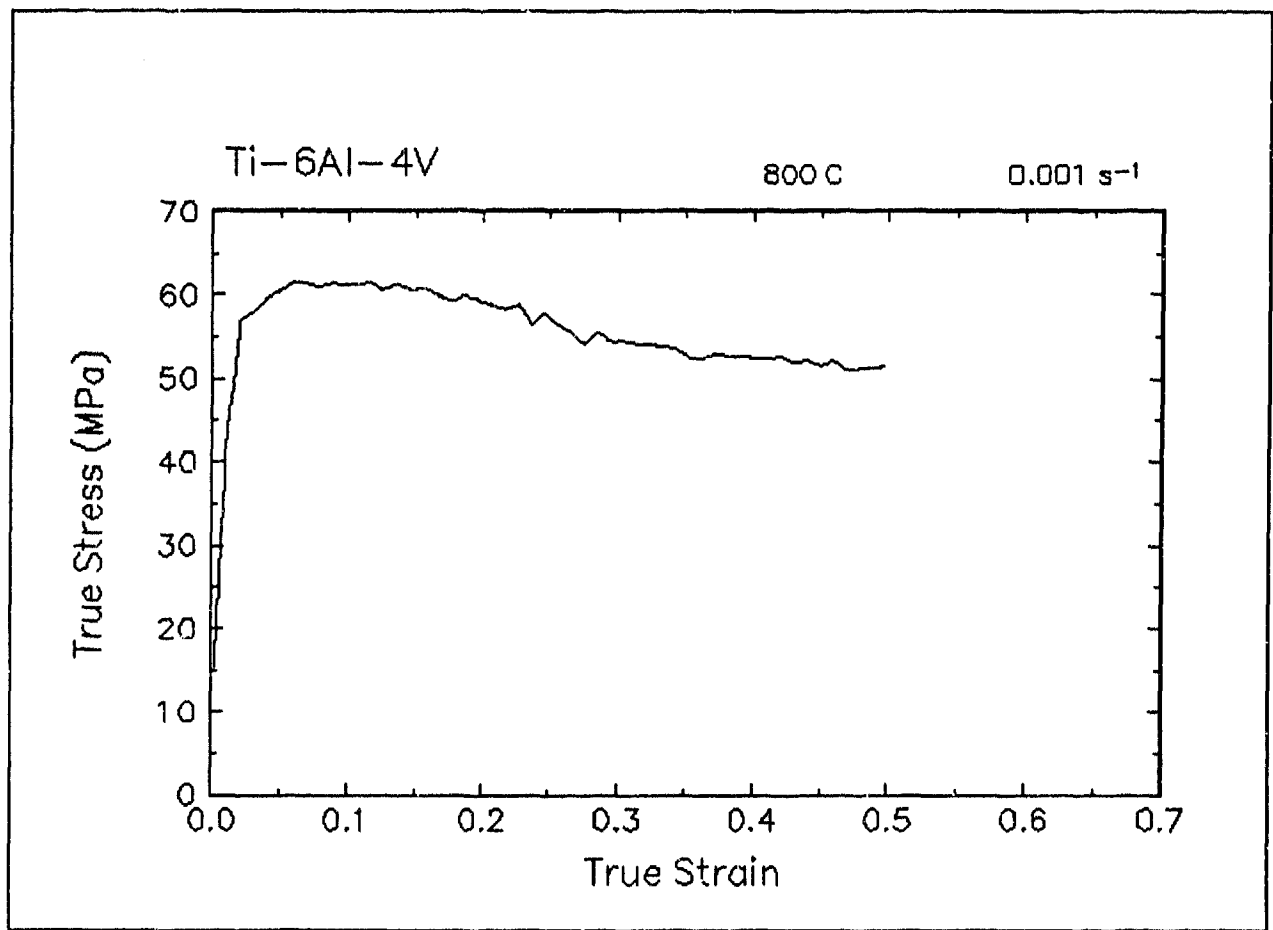


Figure 2. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 800 C and 0.001 s⁻¹.

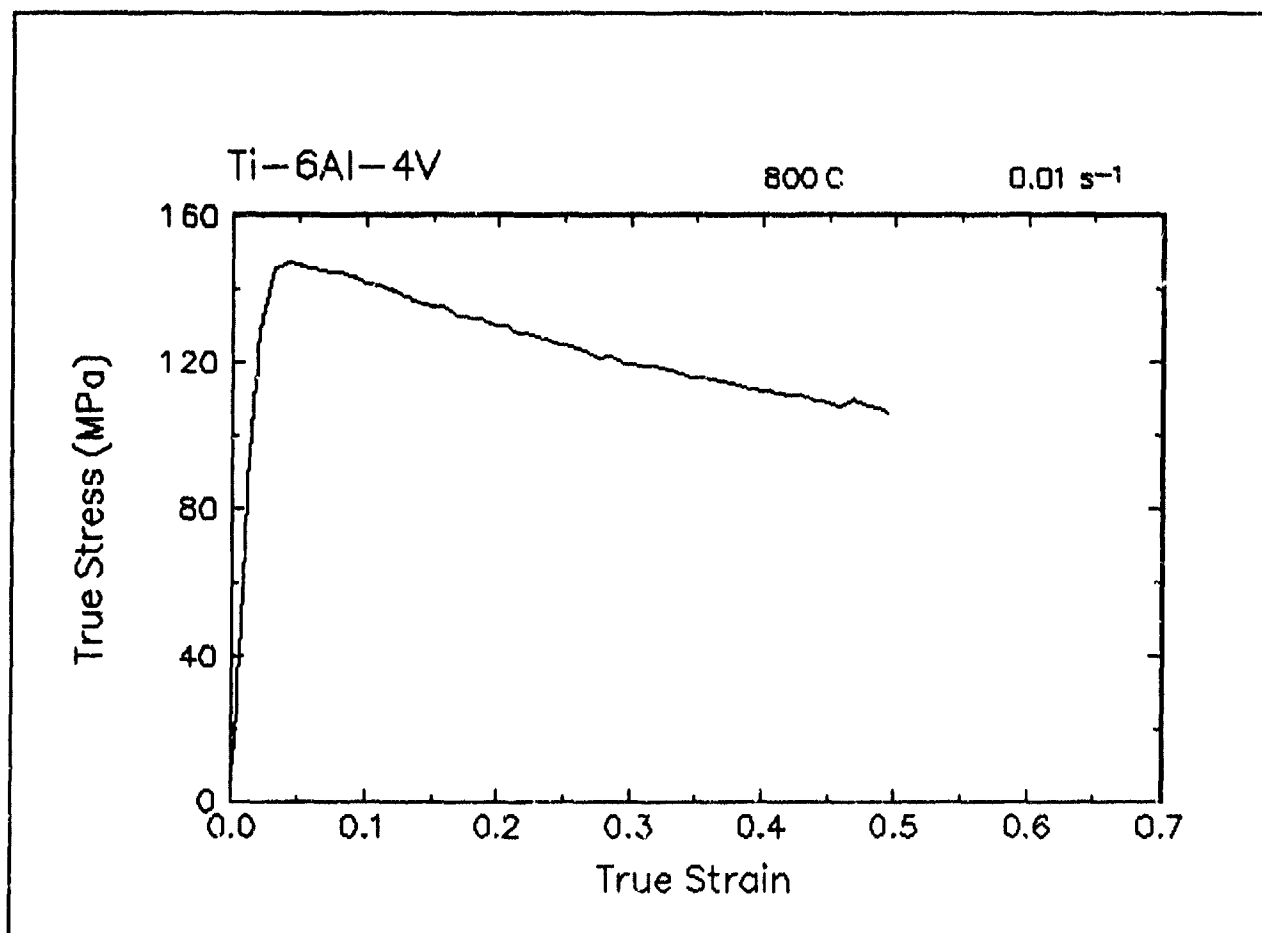


Figure 3. True stress-true strain curve, 800 C and 0.01 s⁻¹.

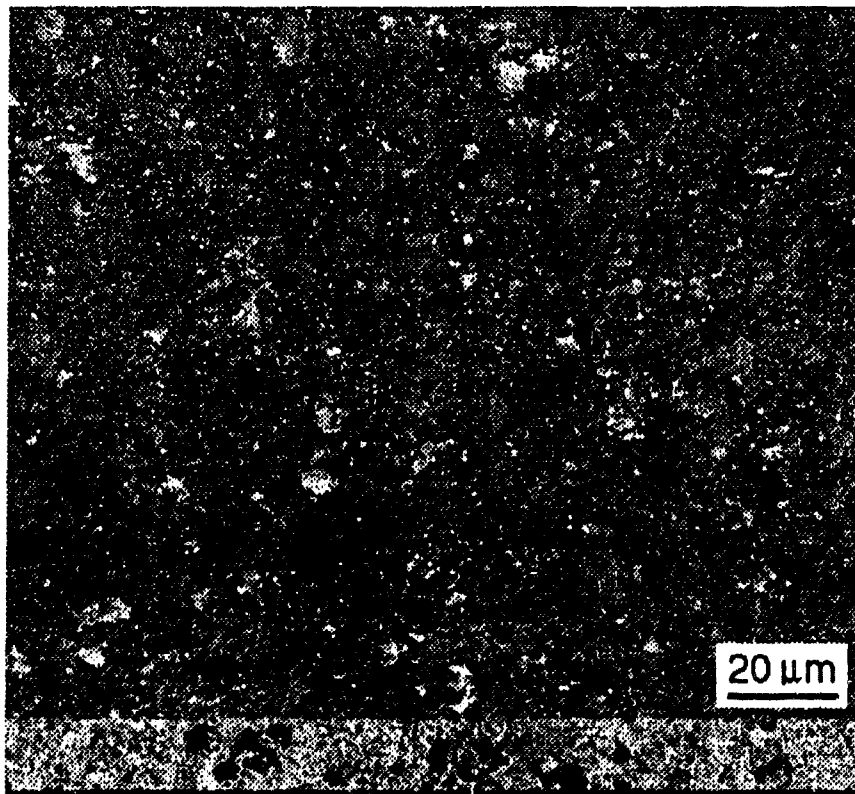
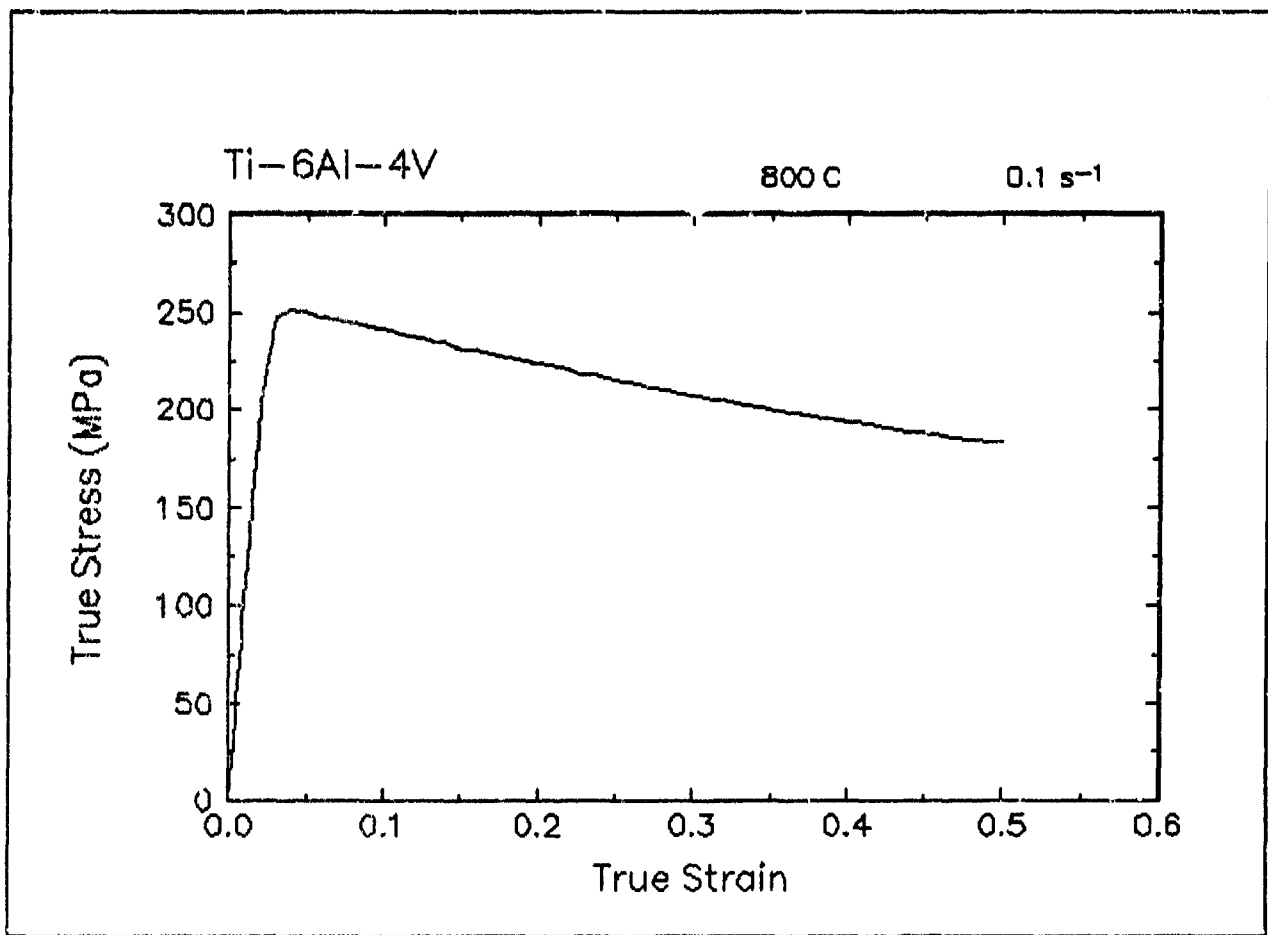


Figure 4. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 800 C and 0.1 s⁻¹.

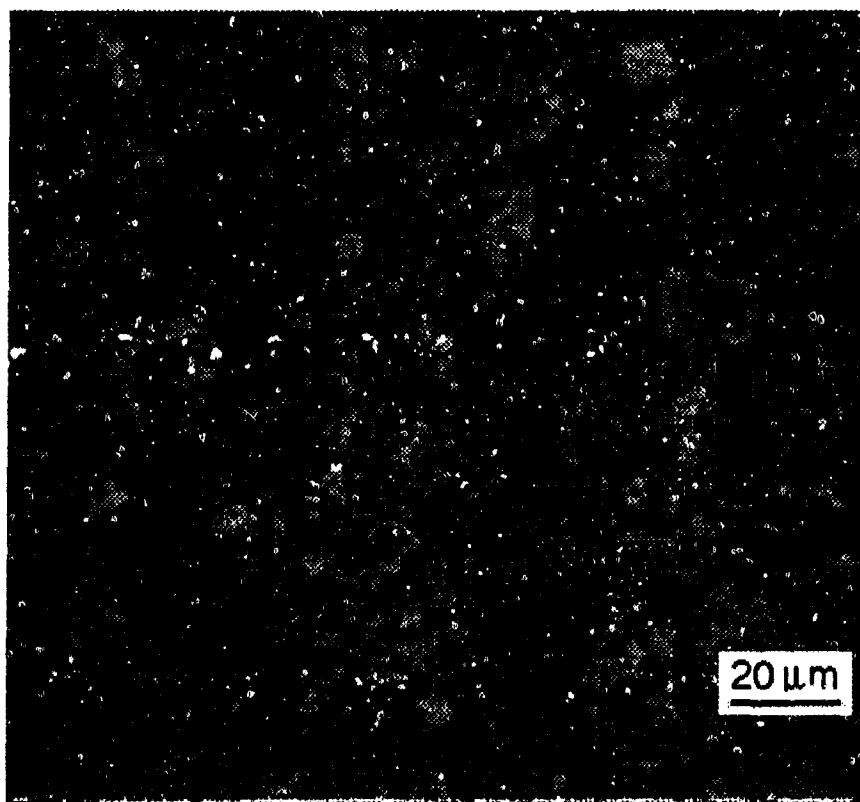
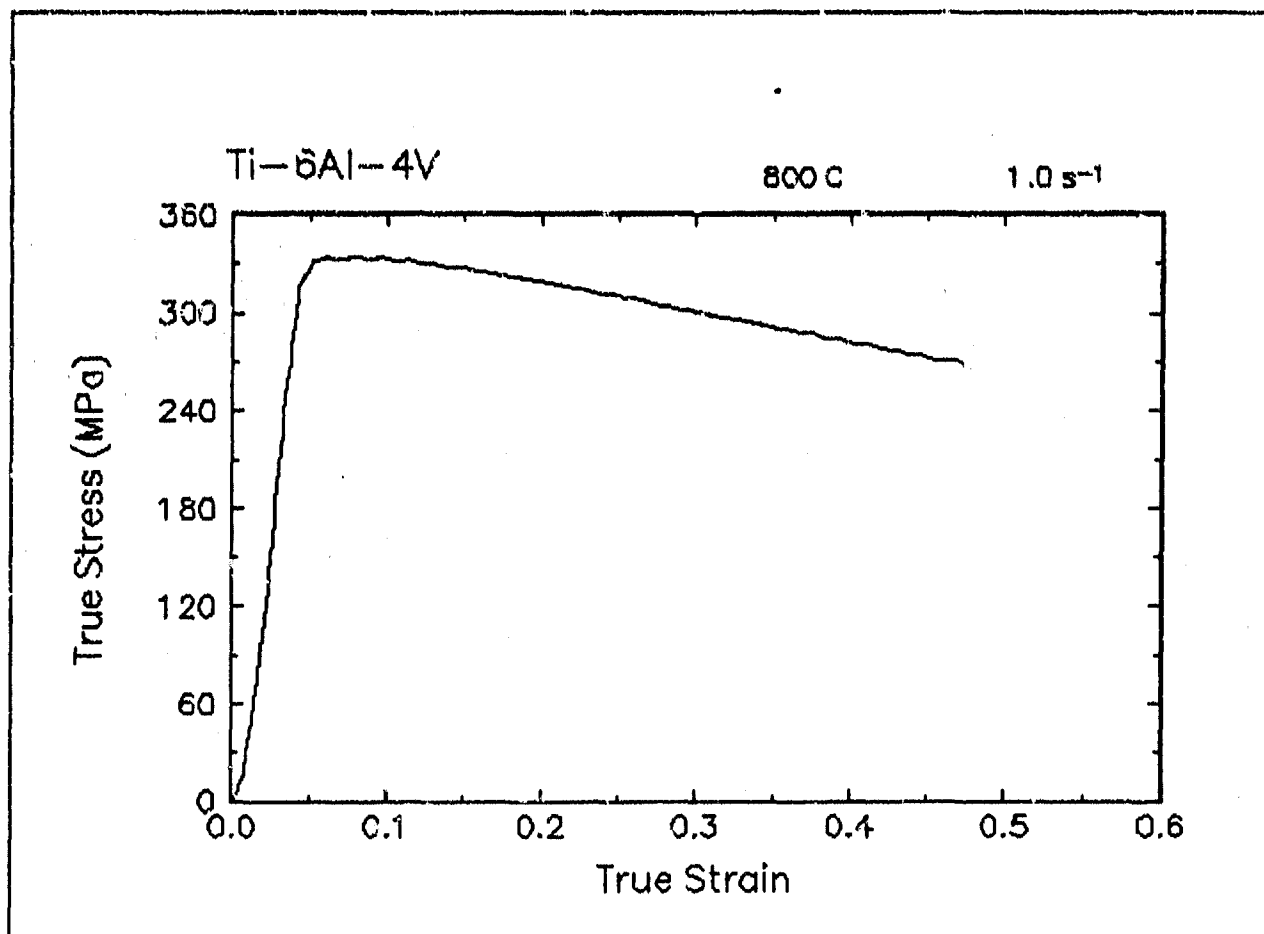


Figure 5. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 800 C and 1 s⁻¹.

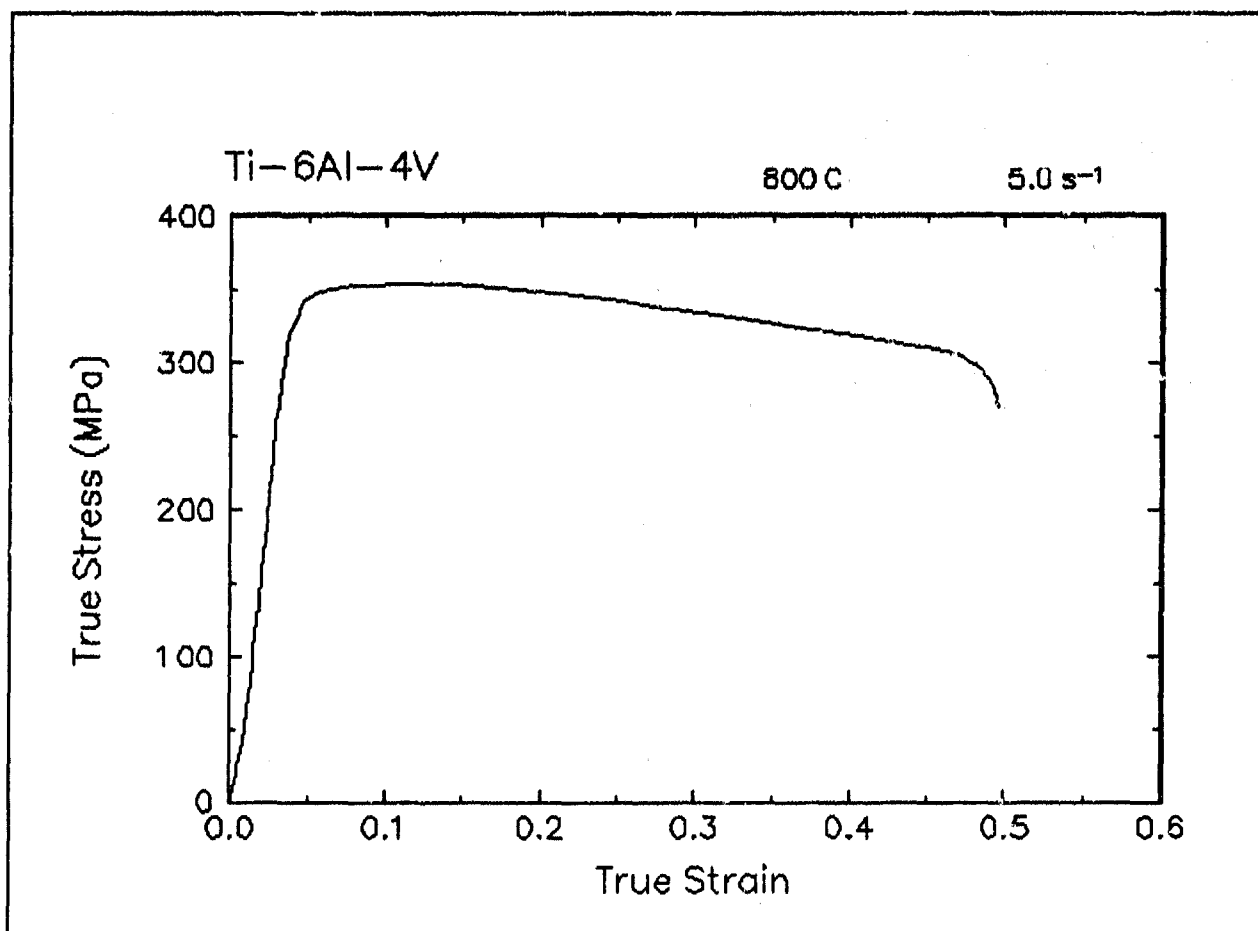


Figure 6. True stress-true strain curve, 800 C and 5 s⁻¹.

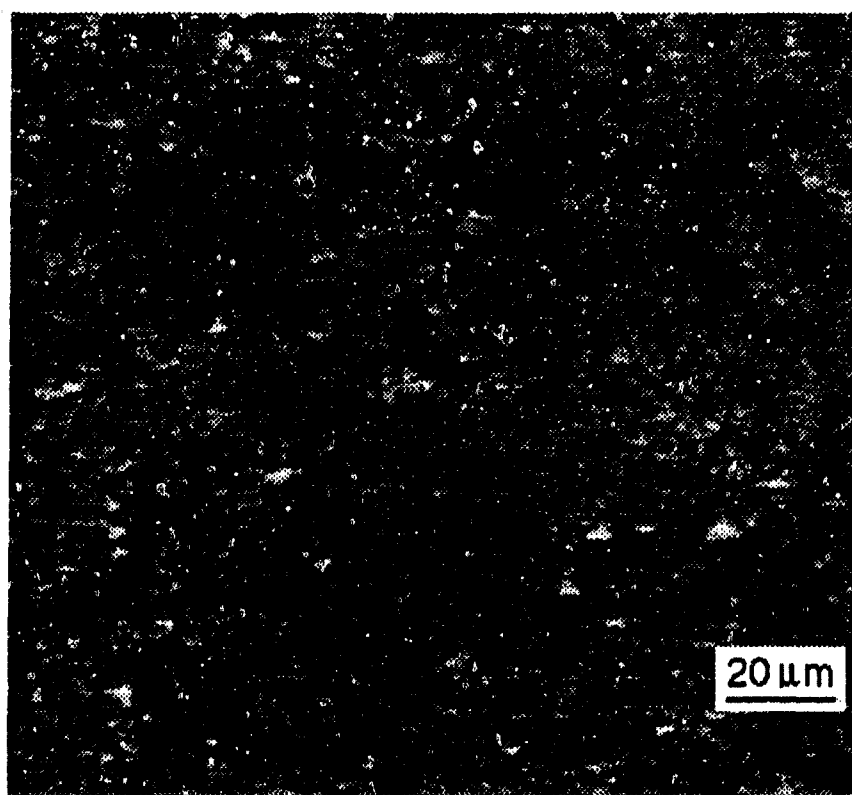
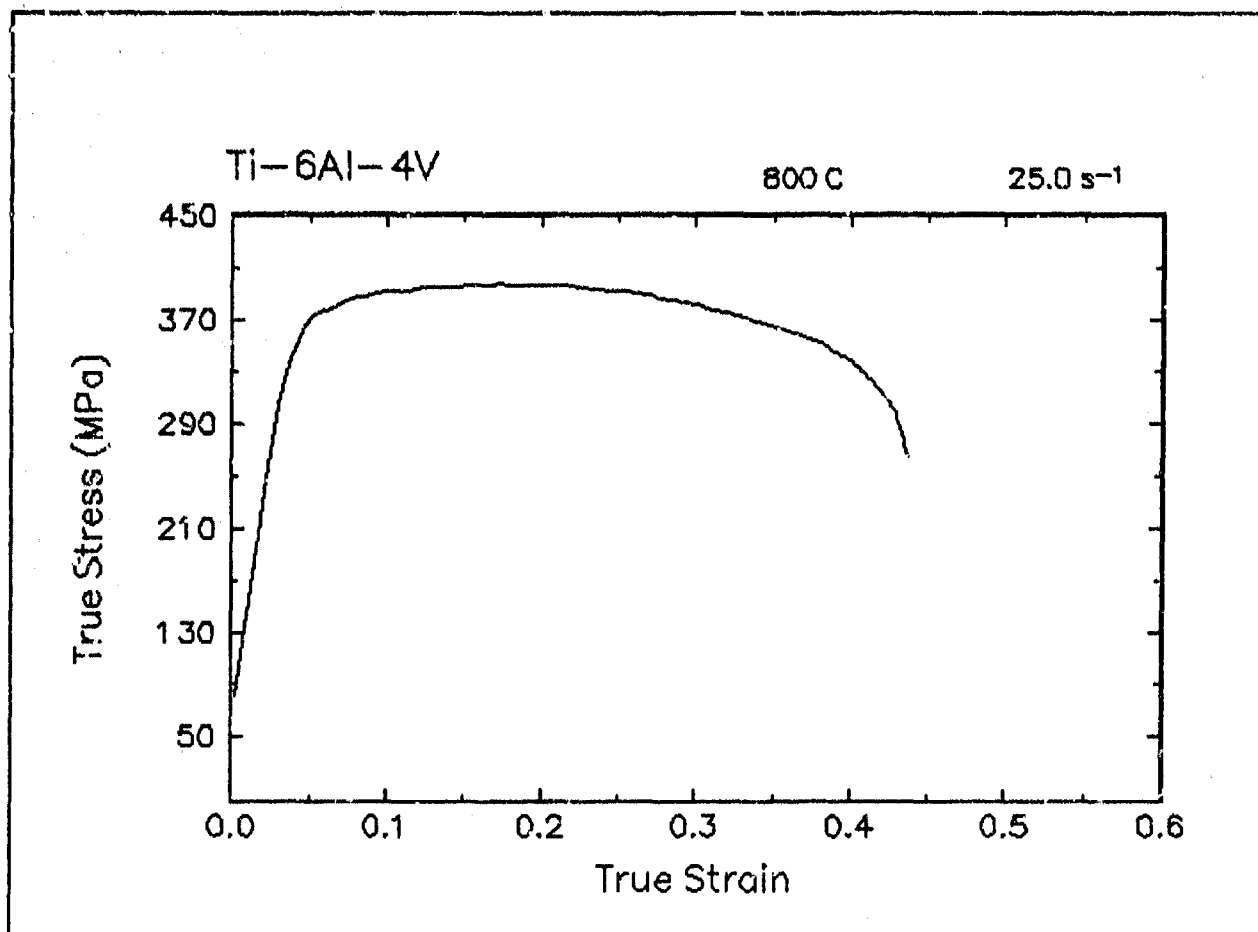


Figure 7. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 800 C and 25 s⁻¹.

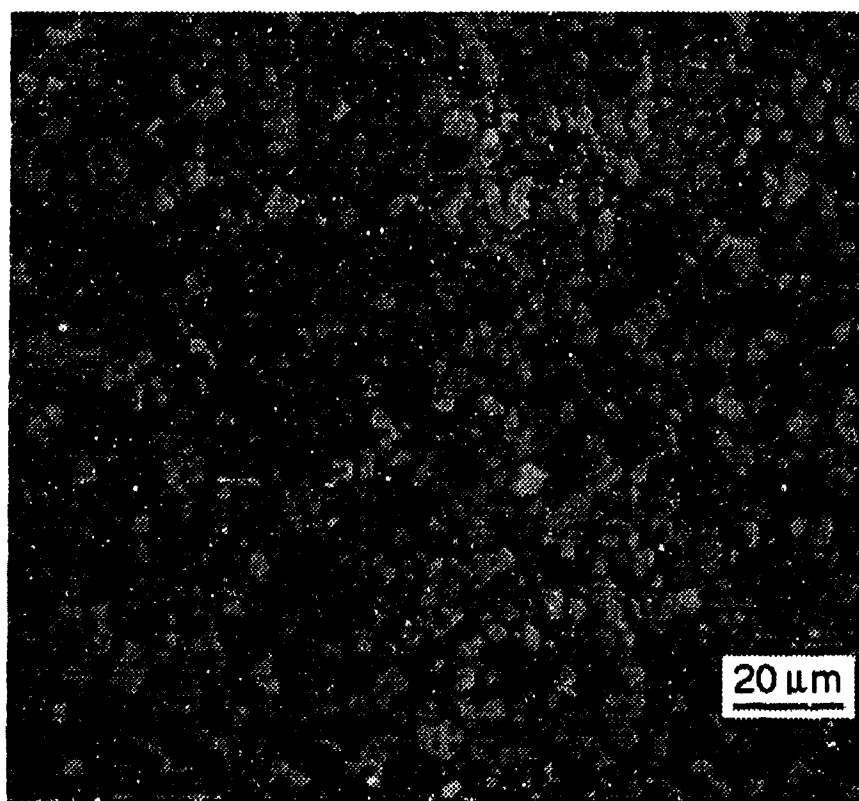
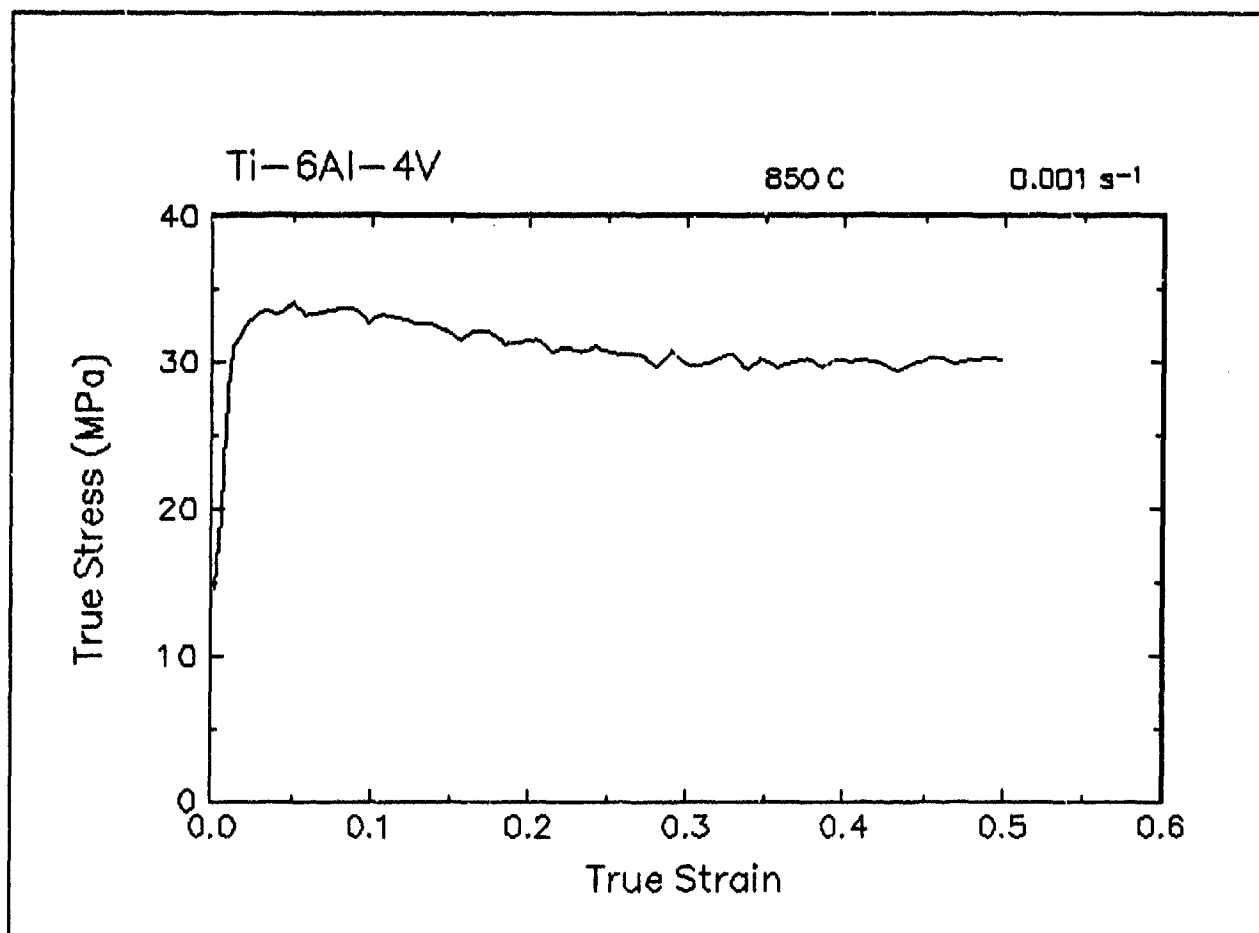


Figure 8. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 850 C and 0.001 s⁻¹.

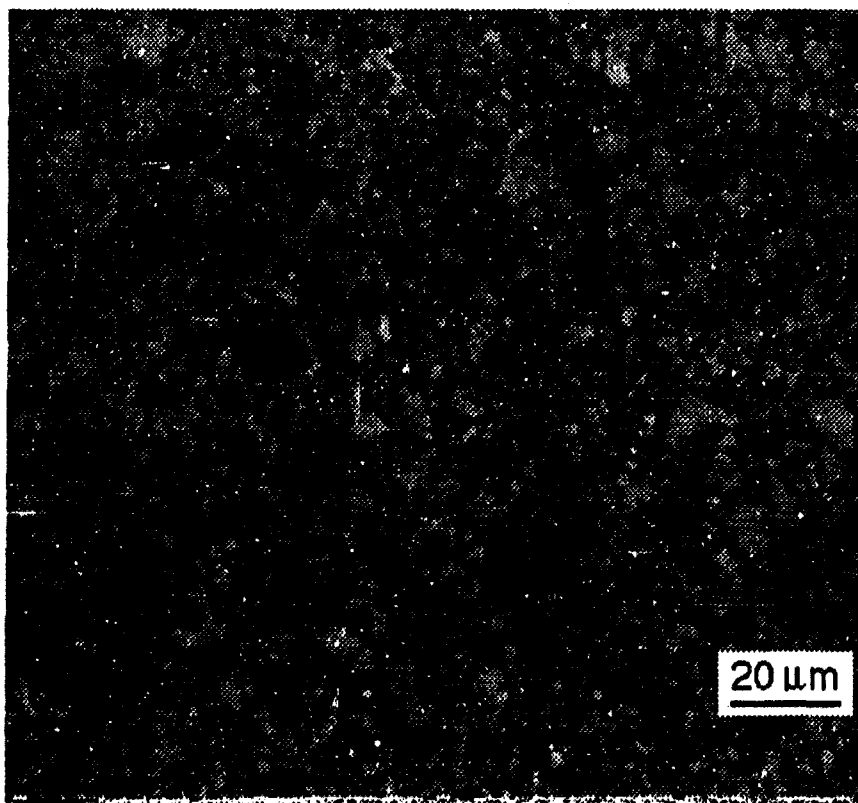
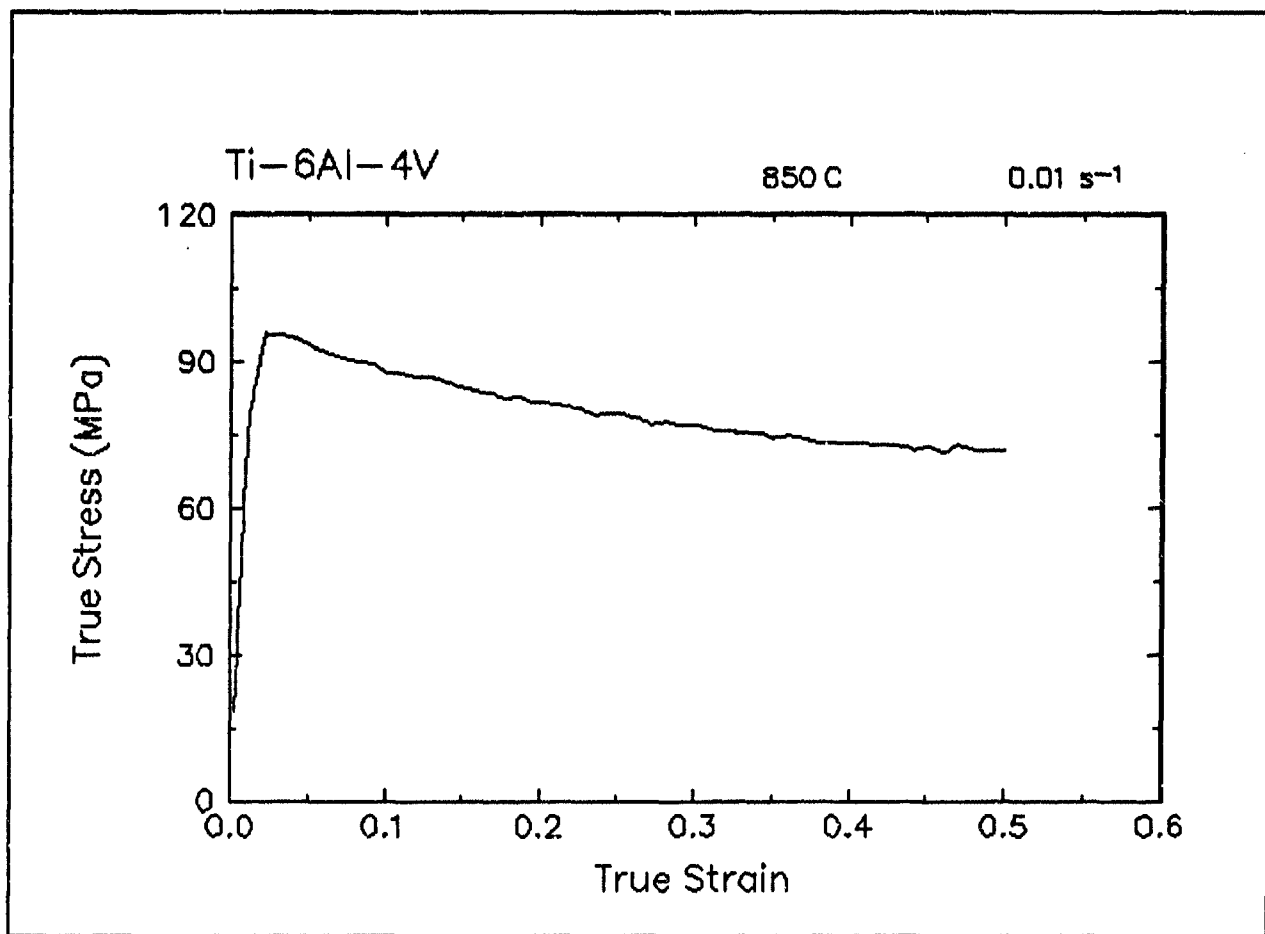


Figure 9. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 850 C and 0.01 s⁻¹.

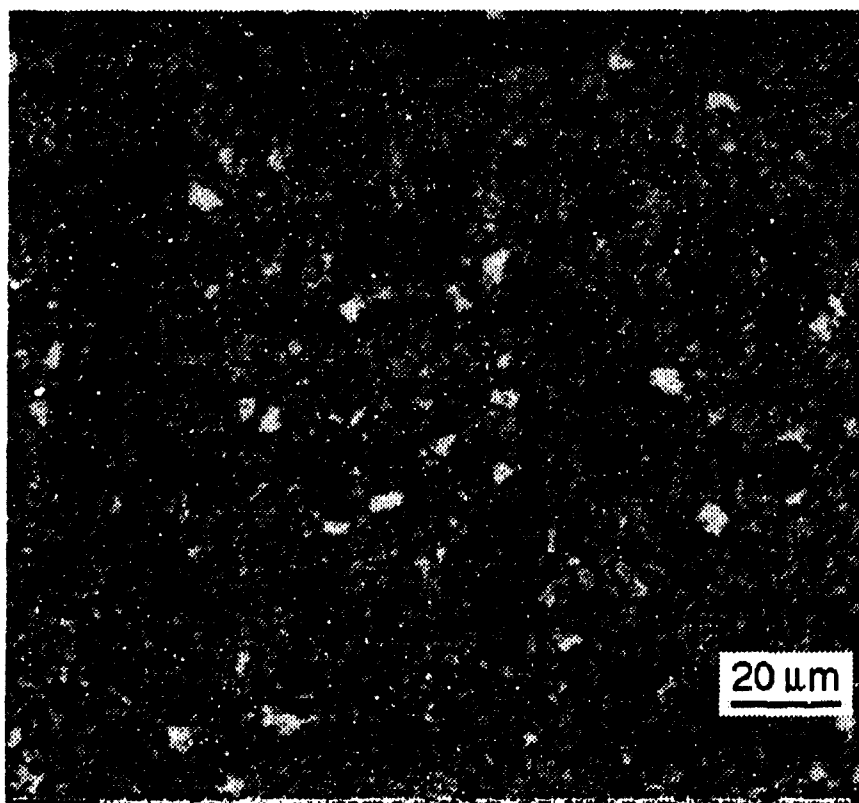
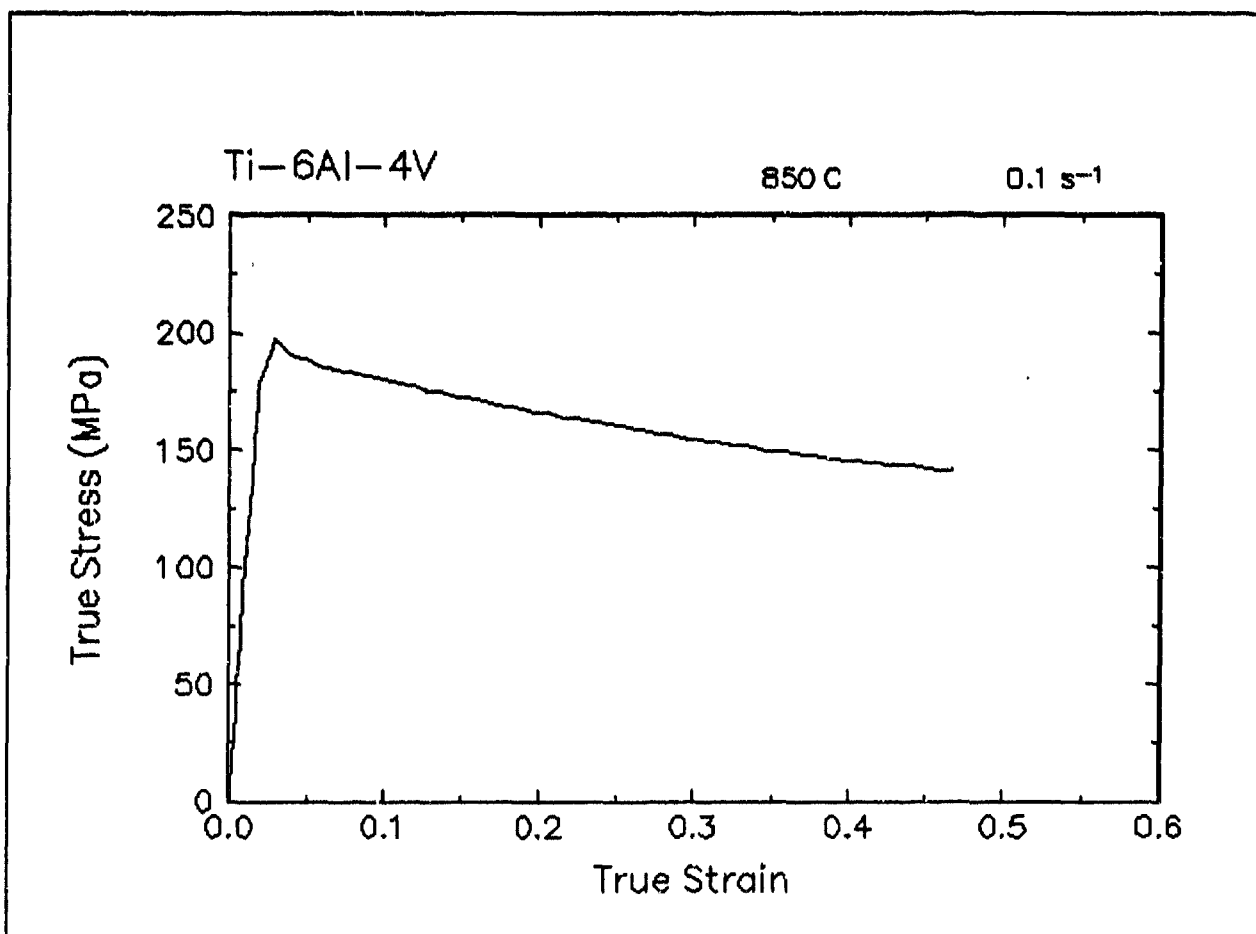


Figure 10. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 850 C and 0.1 s⁻¹.

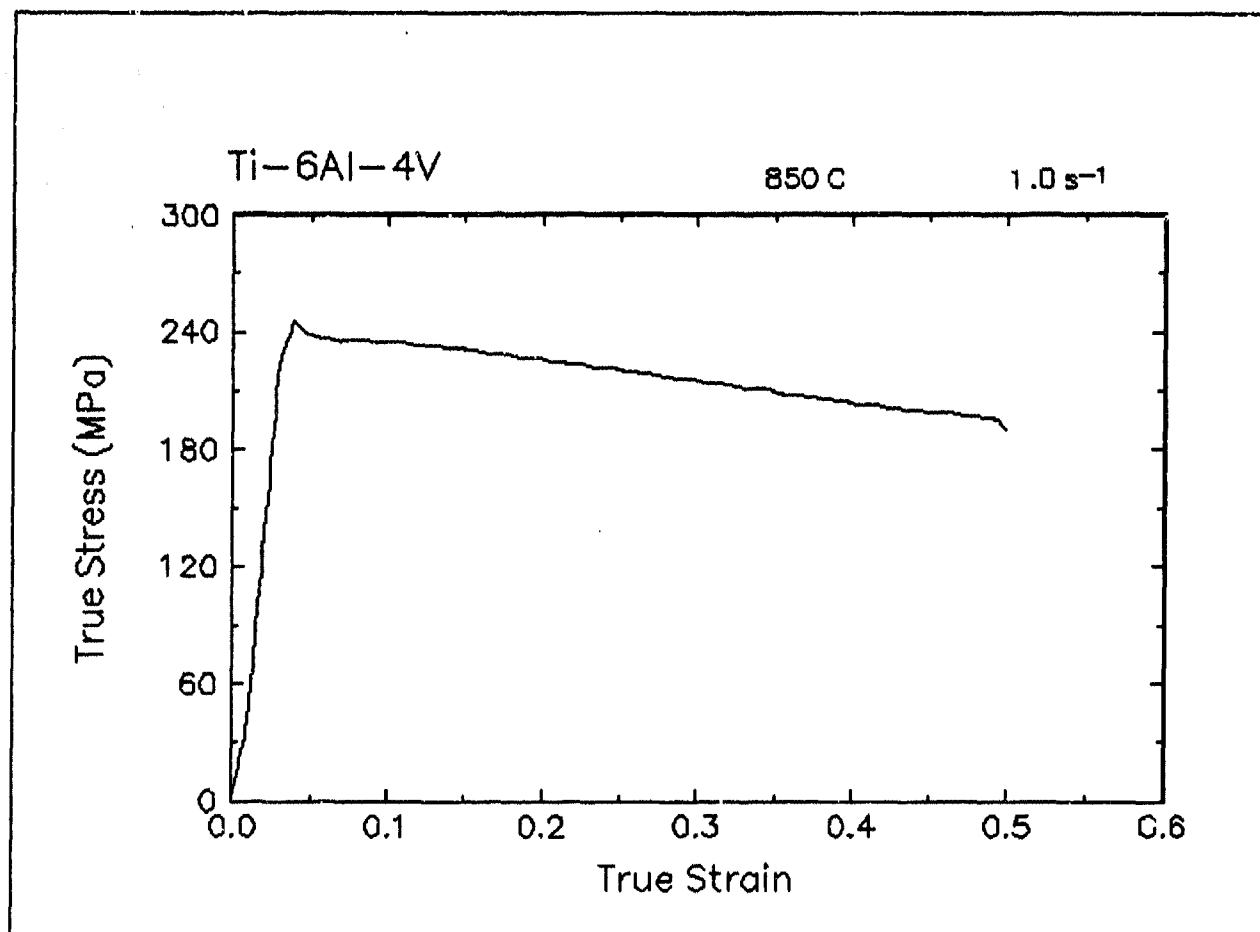


Figure 11. True stress-true strain curve, 850 C and 1 s⁻¹.

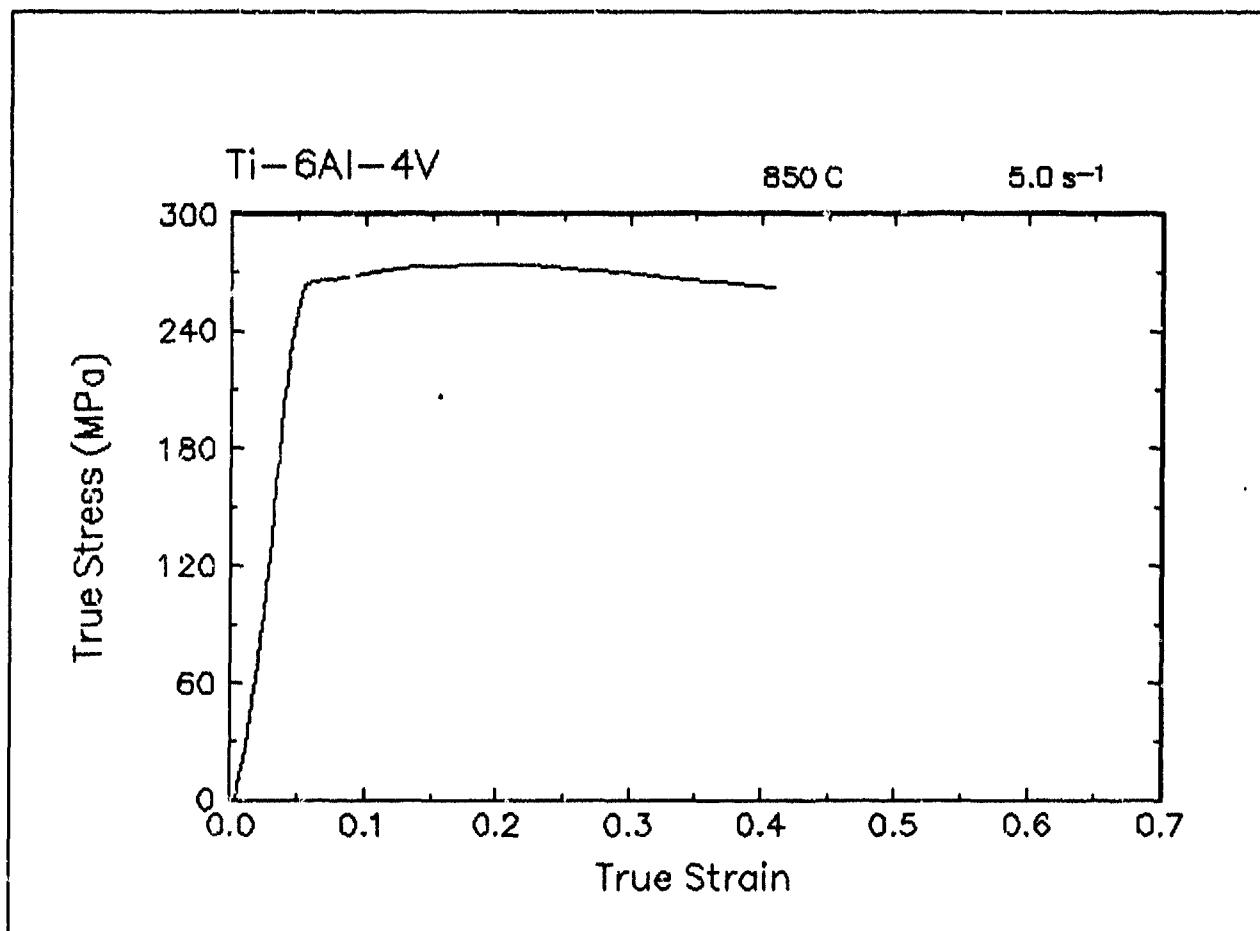


Figure 12. True stress-true strain curve, 850 C and 5 s⁻¹.

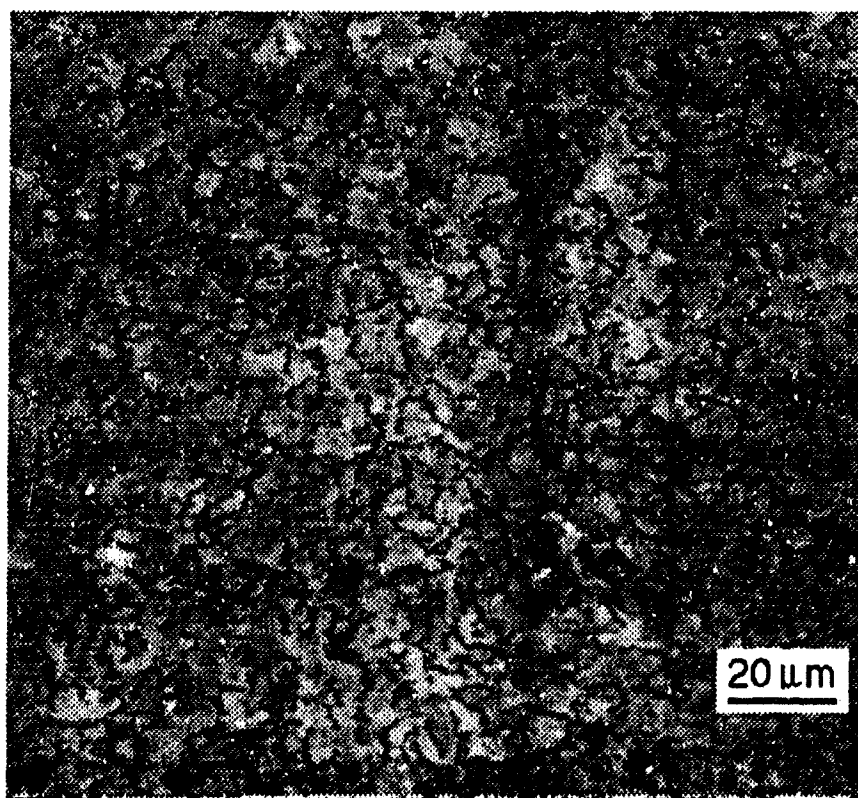
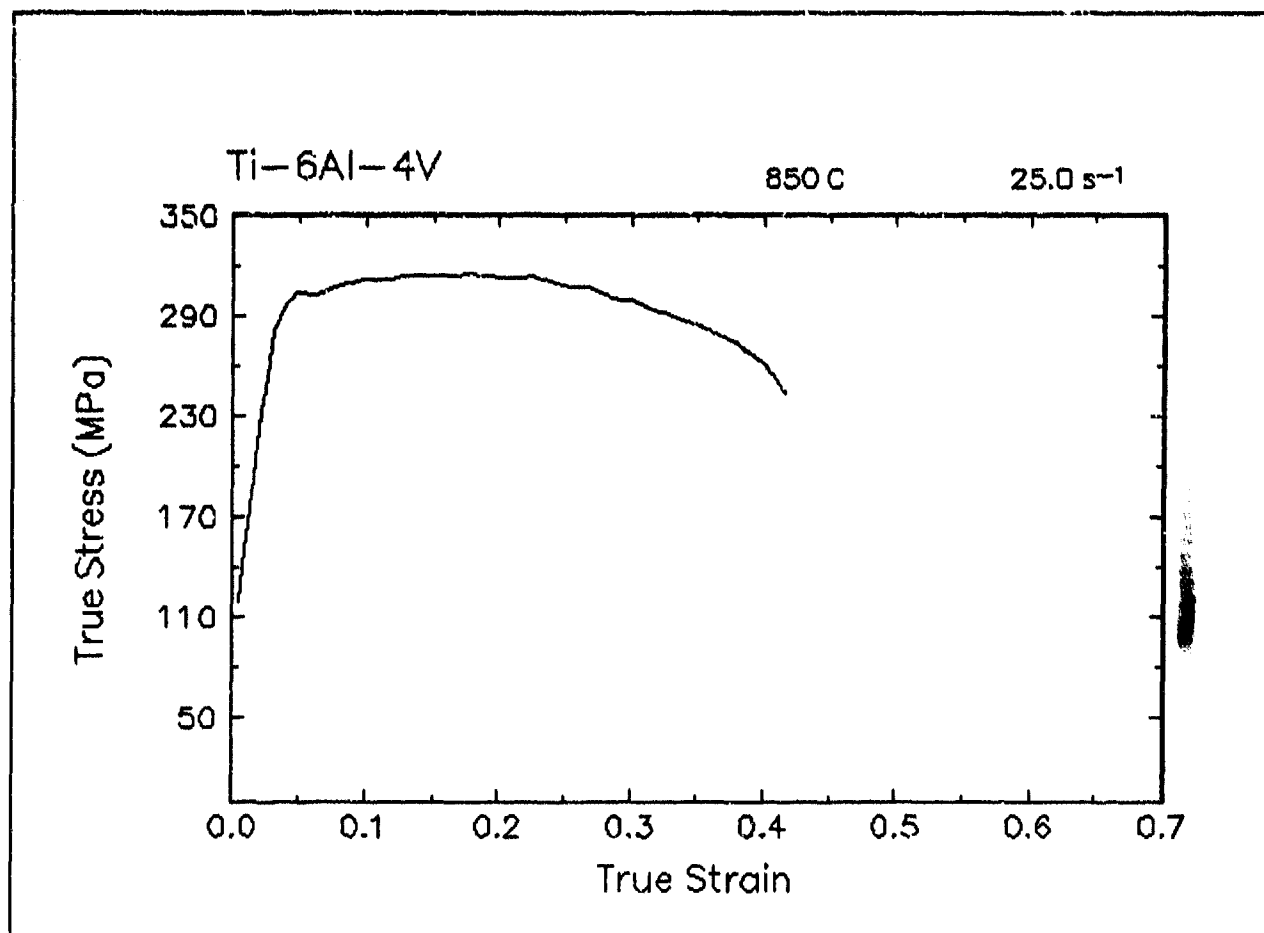


Figure 13. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 850 C and 25 s⁻¹.

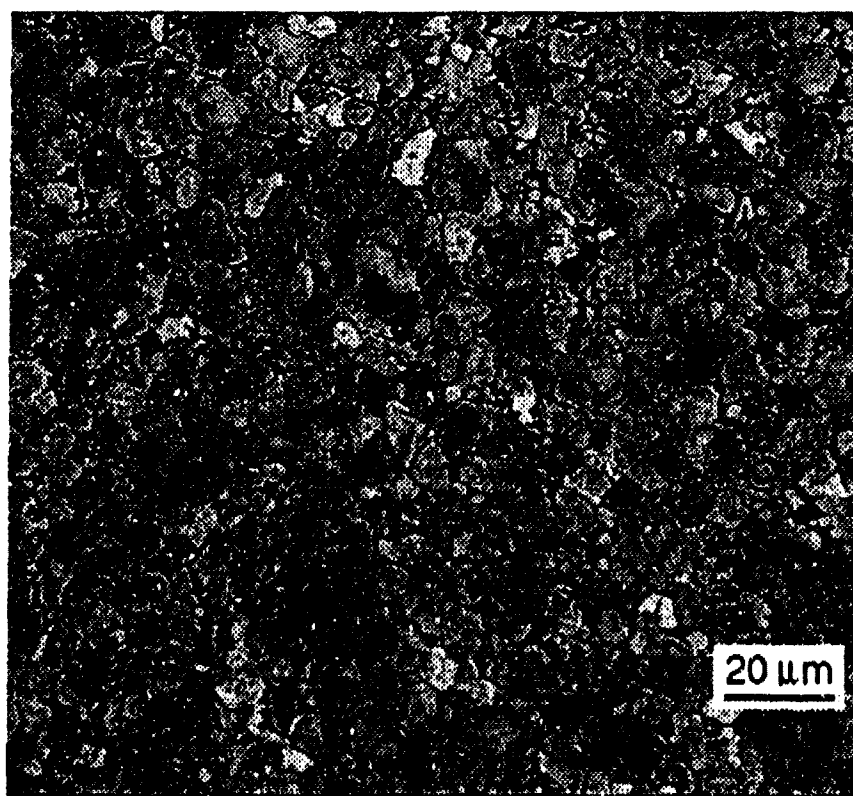
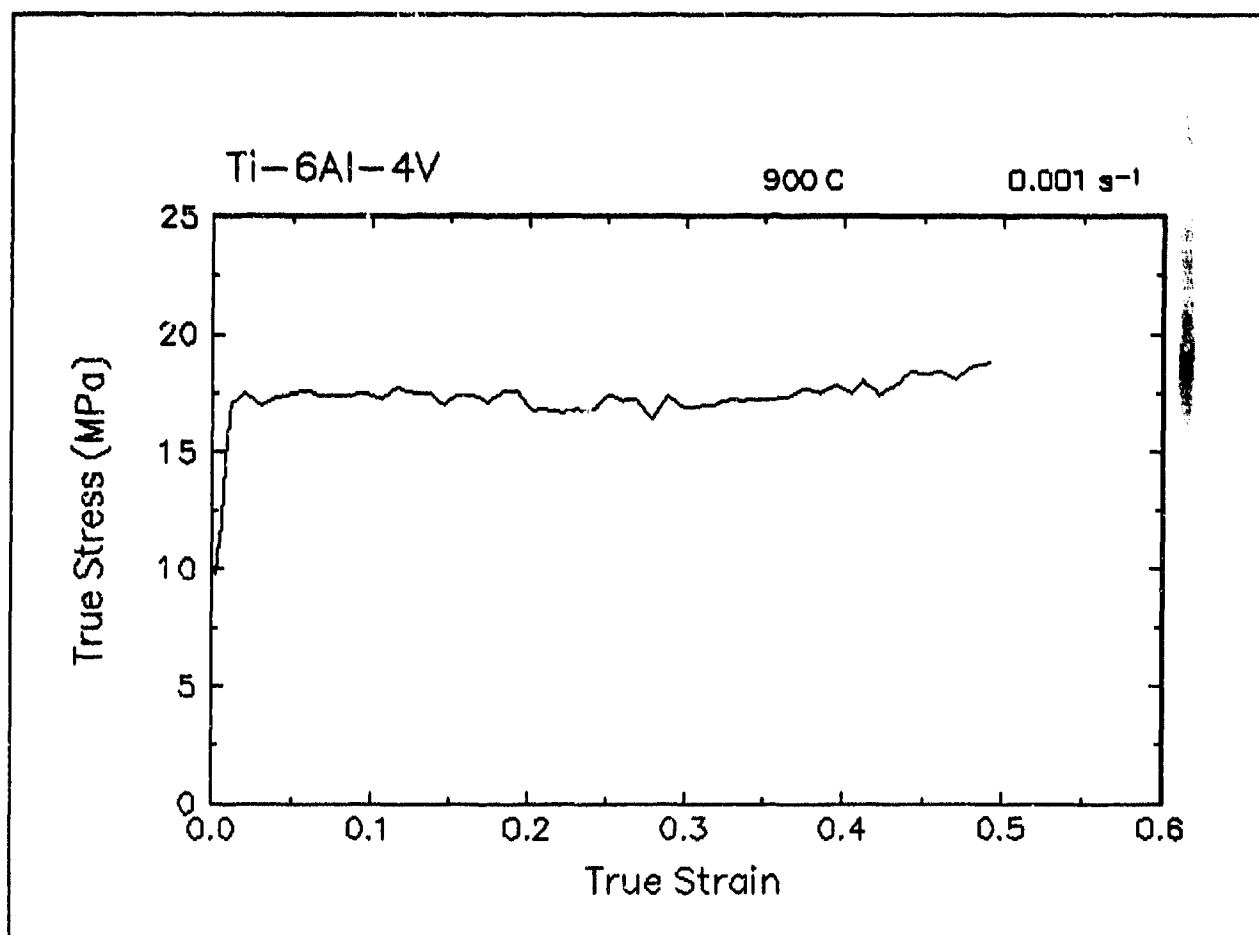


Figure 14. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 900 C and 0.001 s⁻¹.

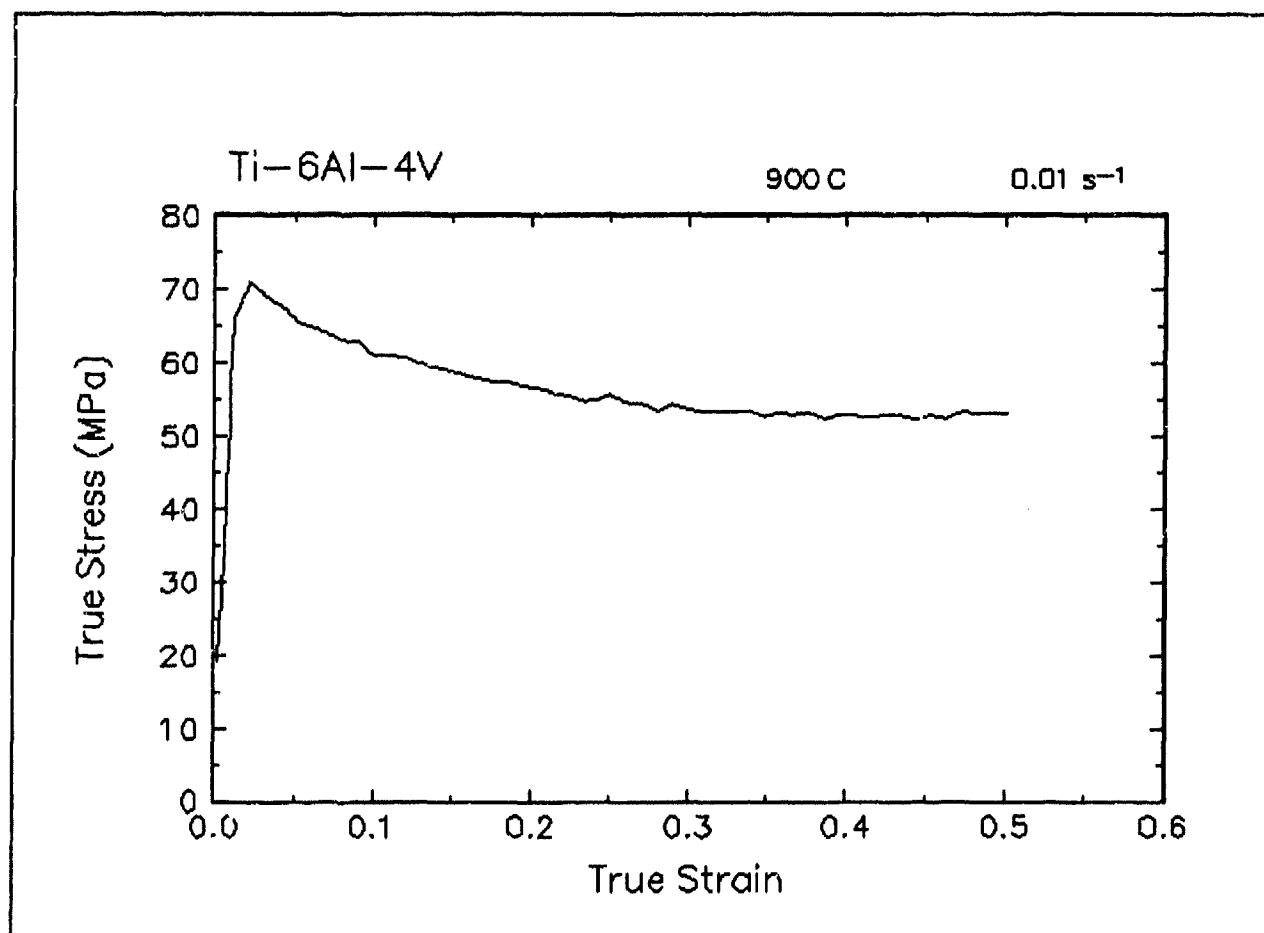


Figure 15. True stress-true strain curve, 900 C and 0.01 s⁻¹.

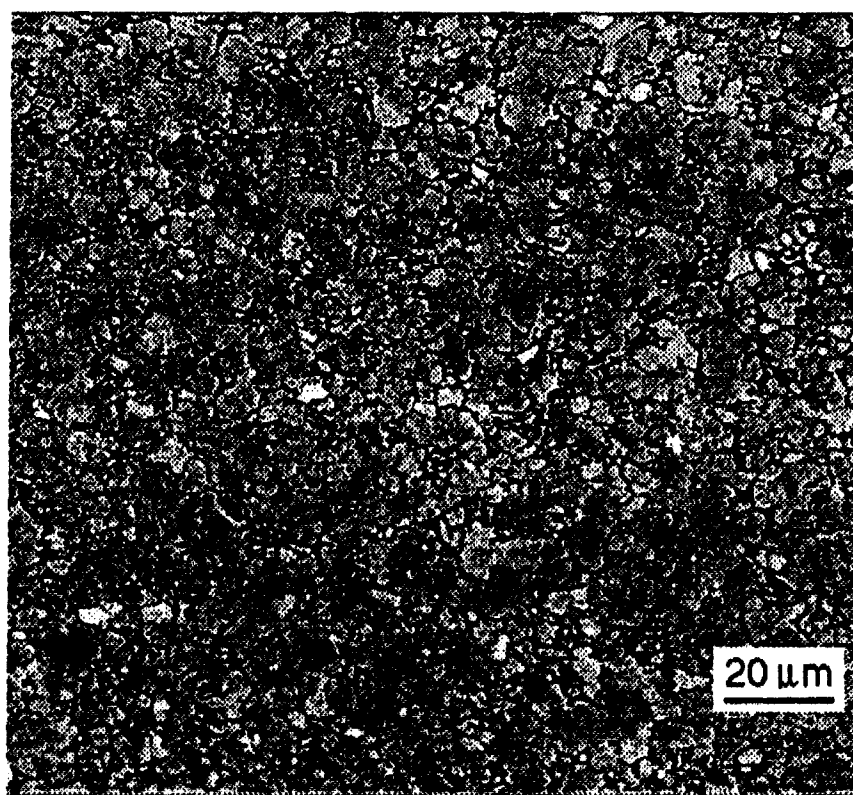
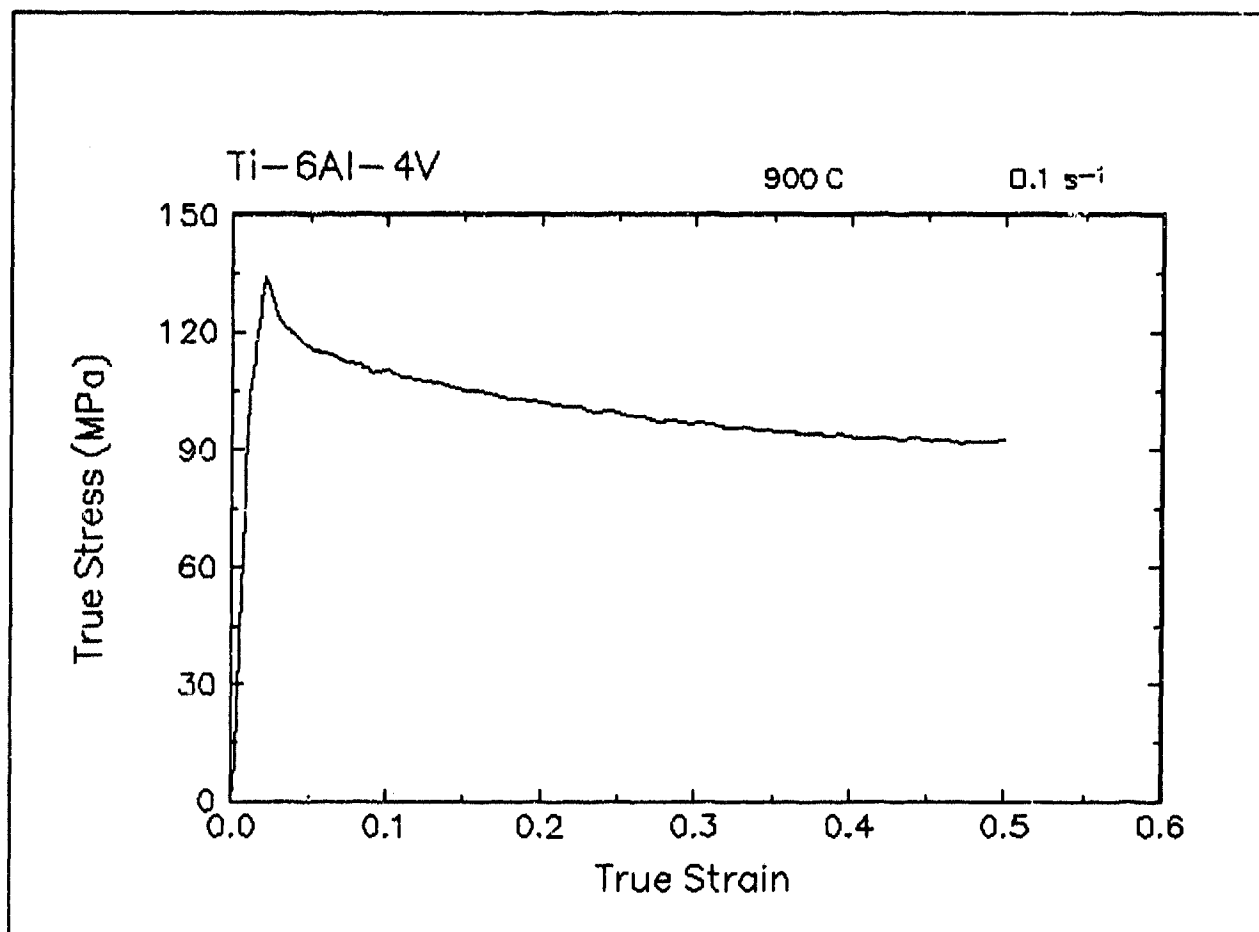


Figure 16. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 900 C and 0.1 s⁻¹.

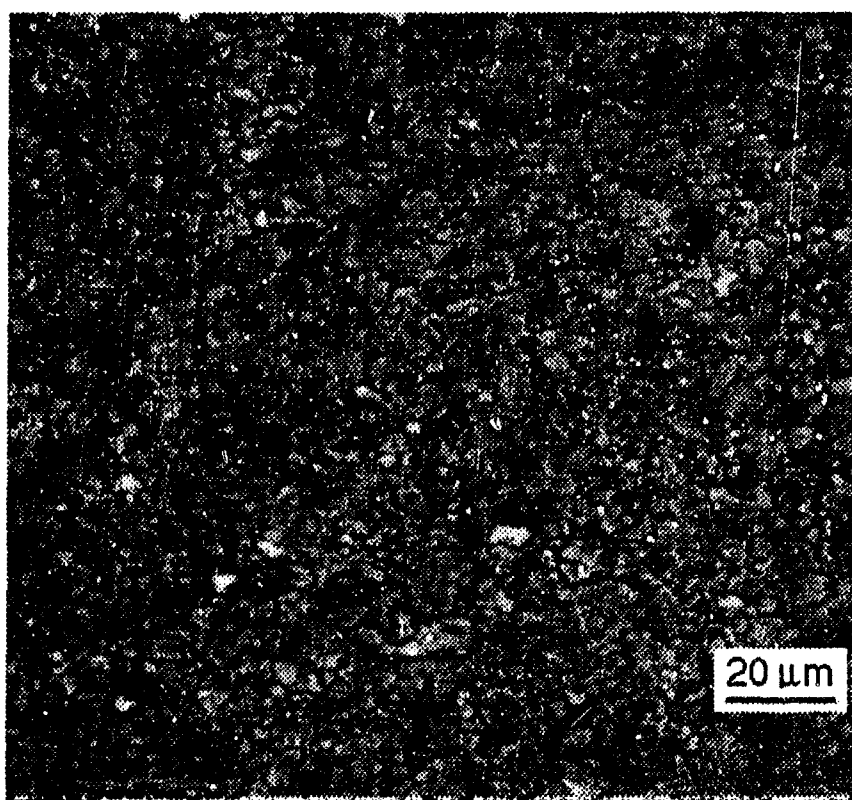
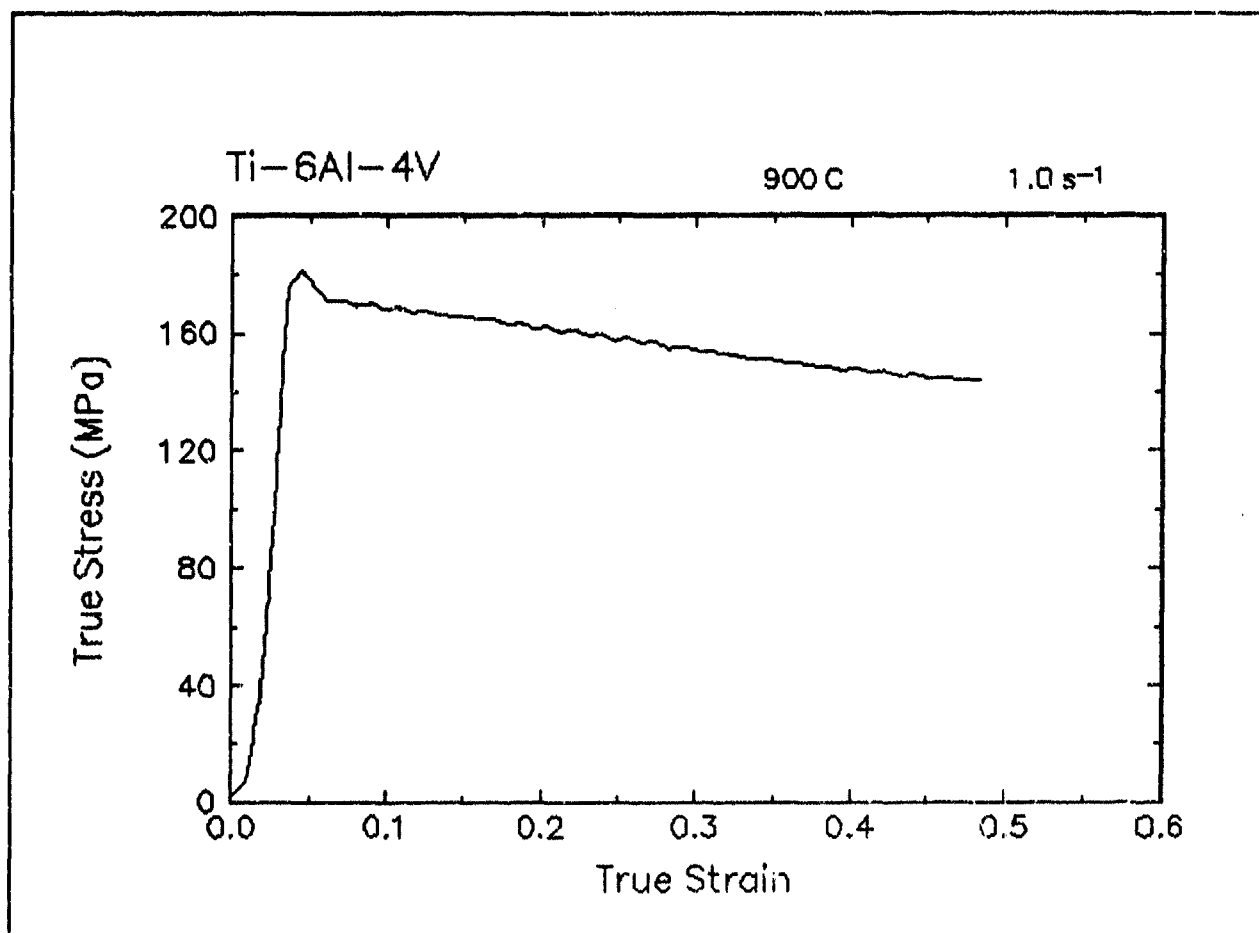


Figure 17. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 900 C and 1 s⁻¹.

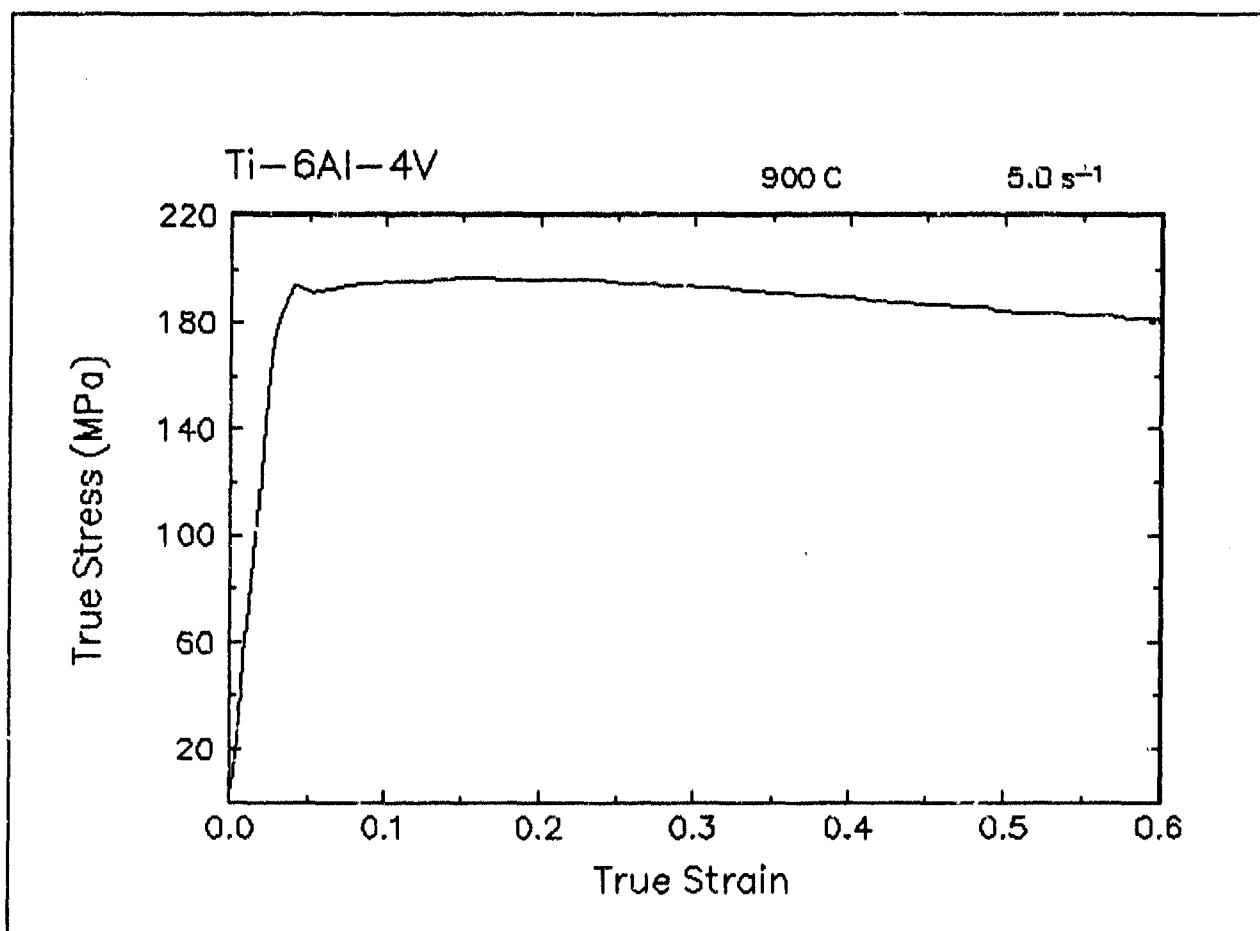


Figure 18. True stress-true strain curve, 900 C and 5 s⁻¹.

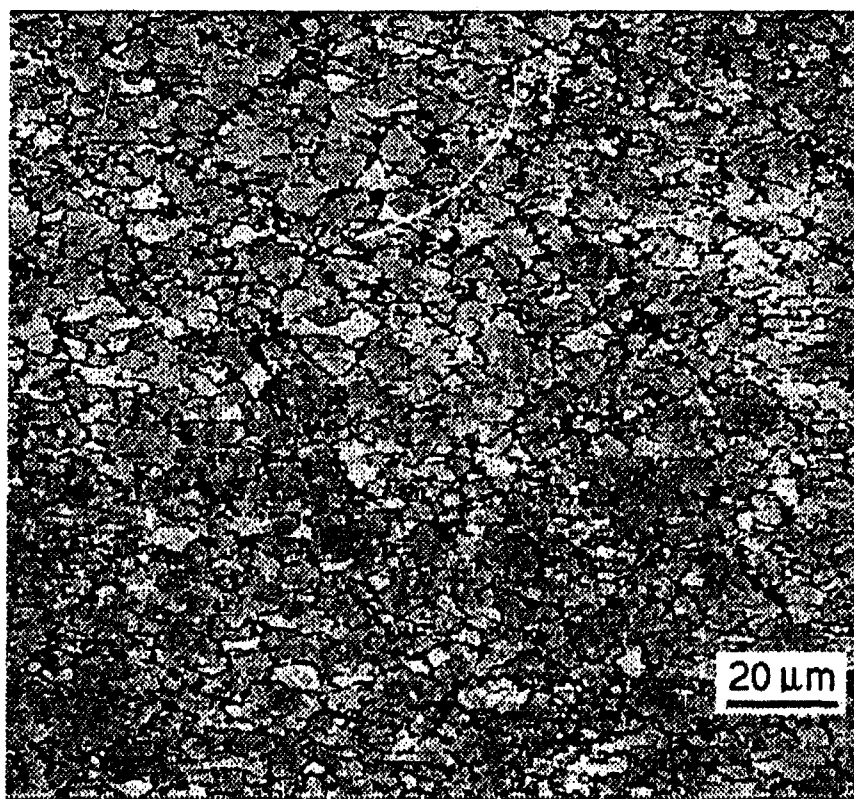
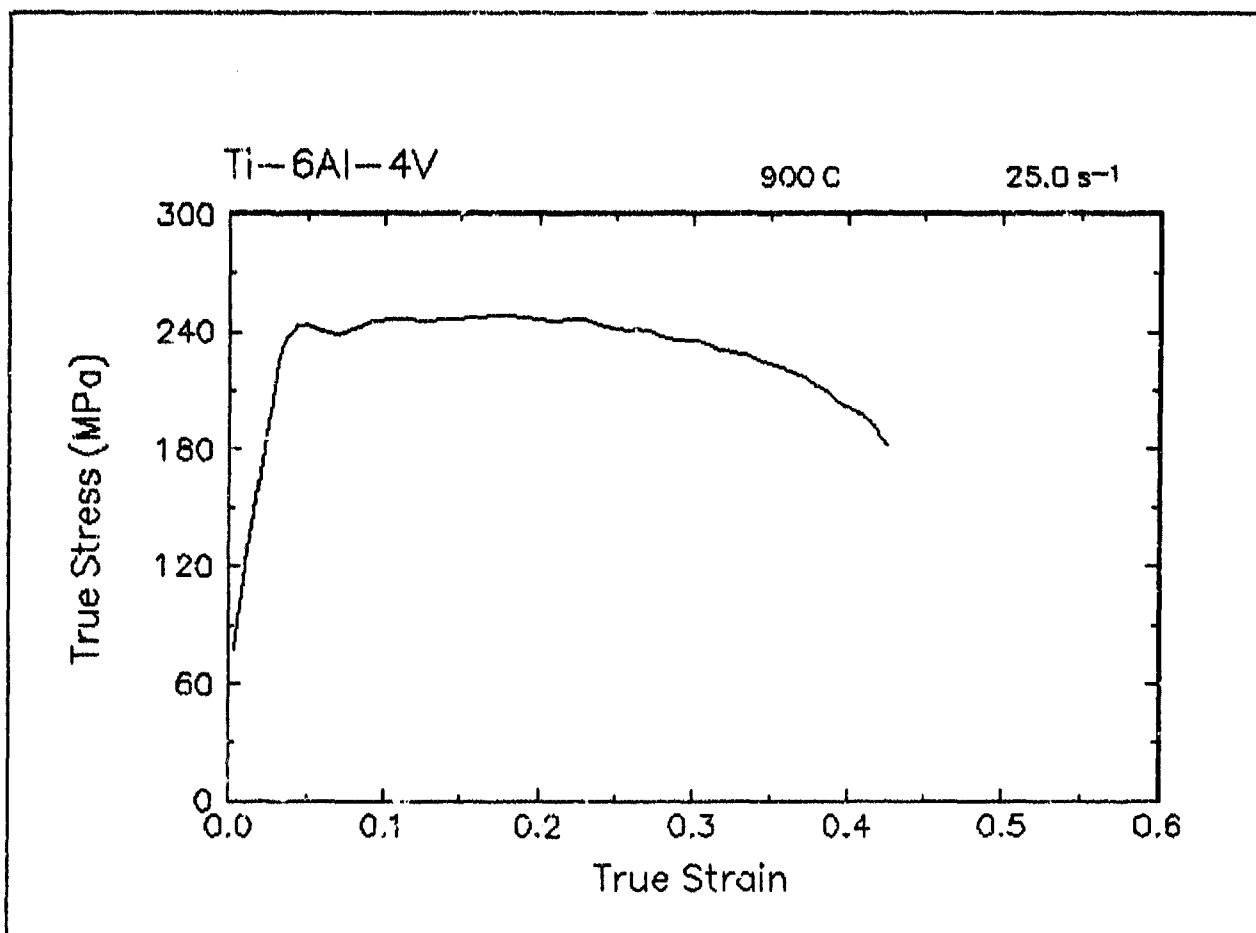


Figure 19. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 900 C and 25 s⁻¹.

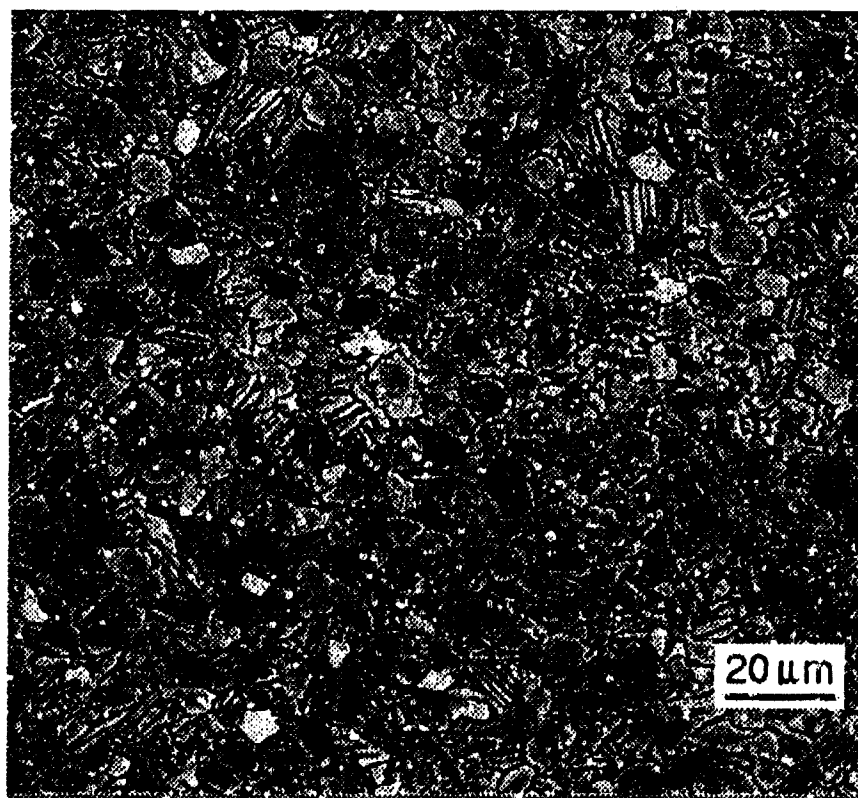
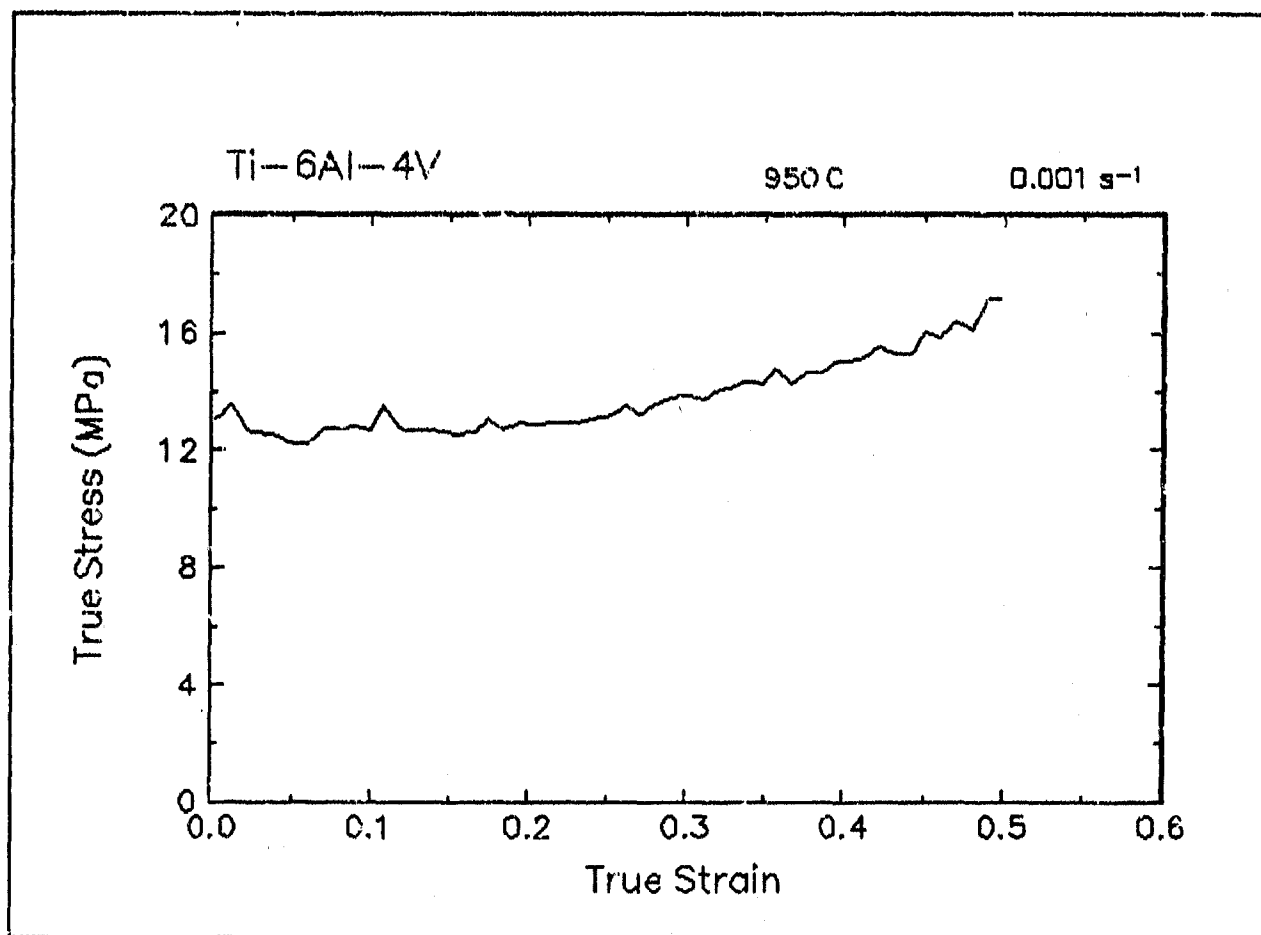


Figure 20. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 950 C and 0.001 s⁻¹.

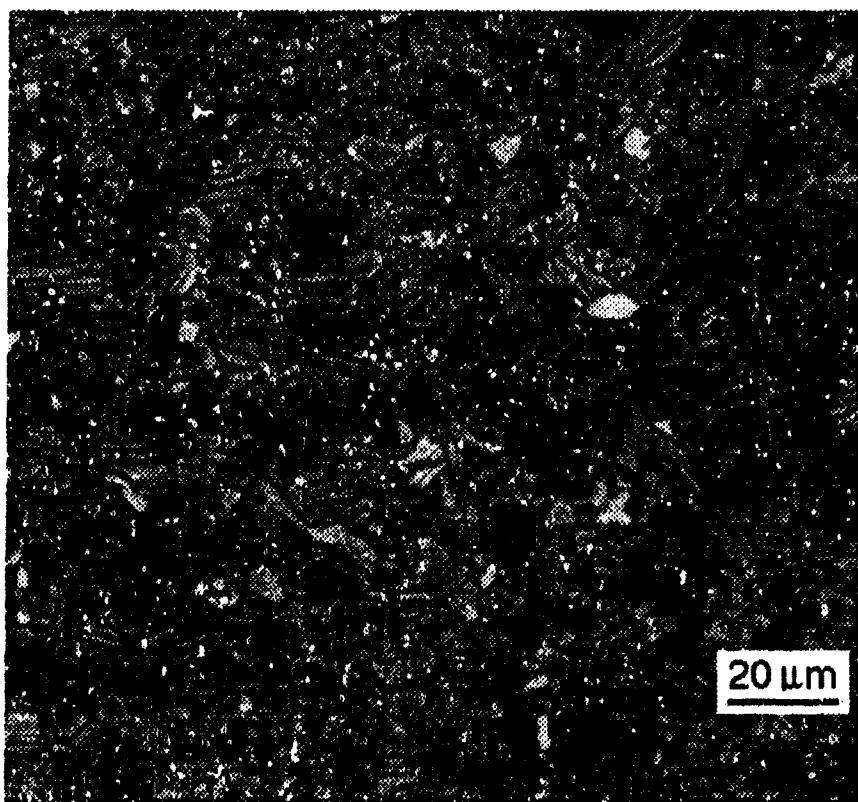
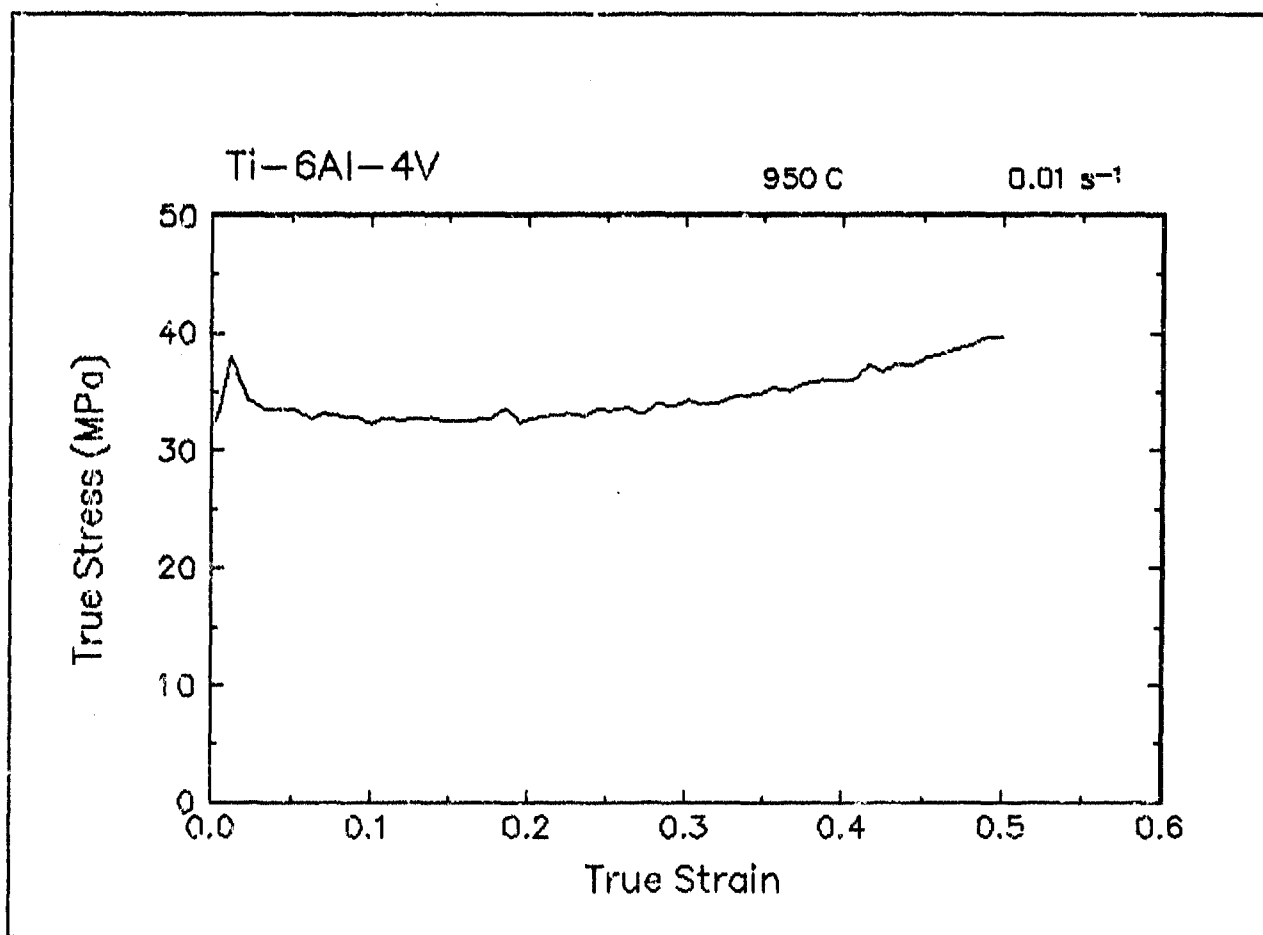


Figure 21. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 950 C and 0.01 s⁻¹.

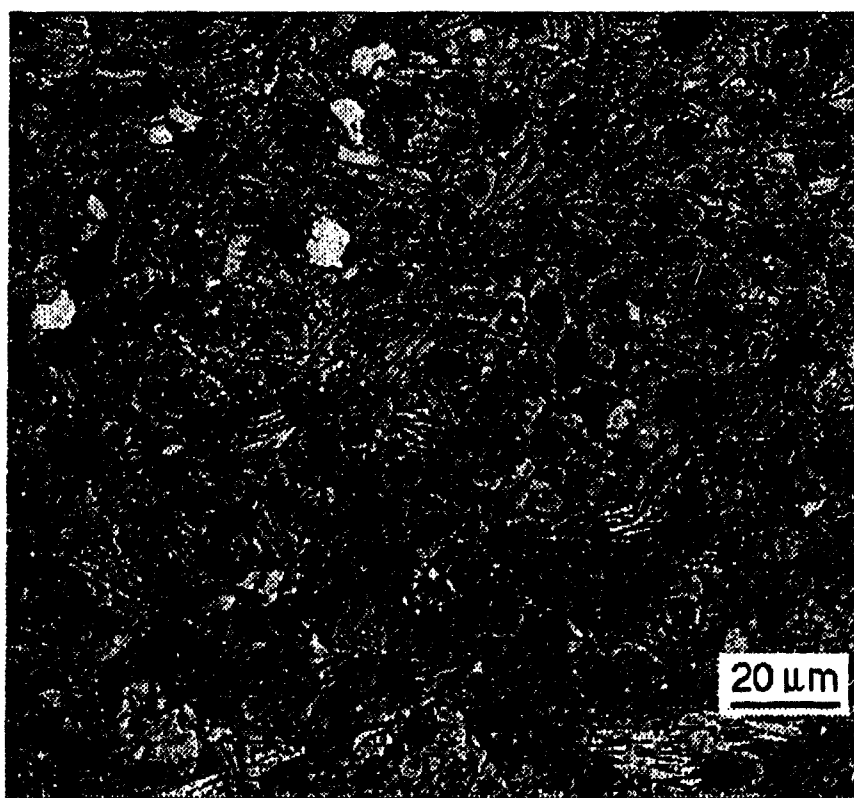
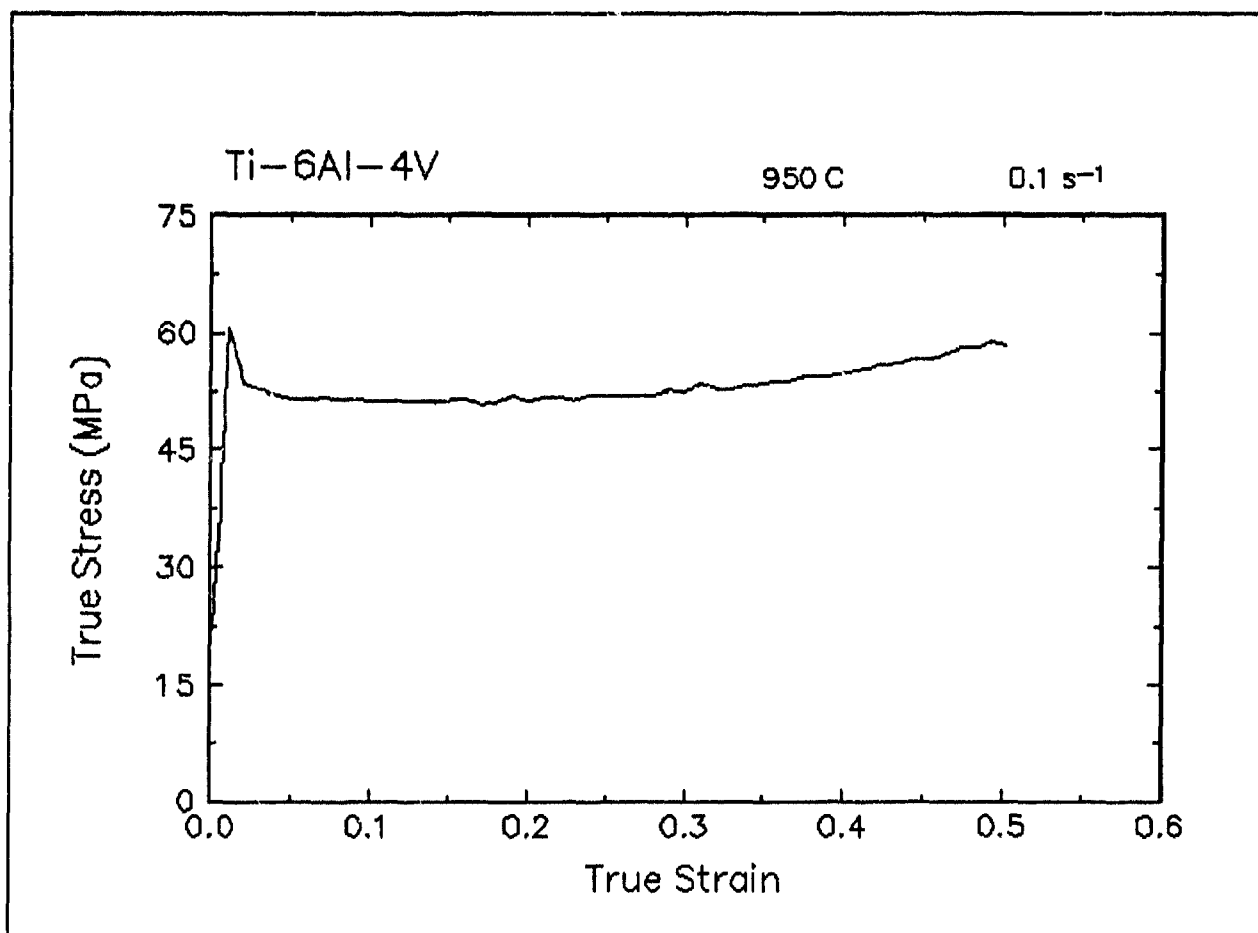


Figure 22. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 950 C and 0.1 s⁻¹.

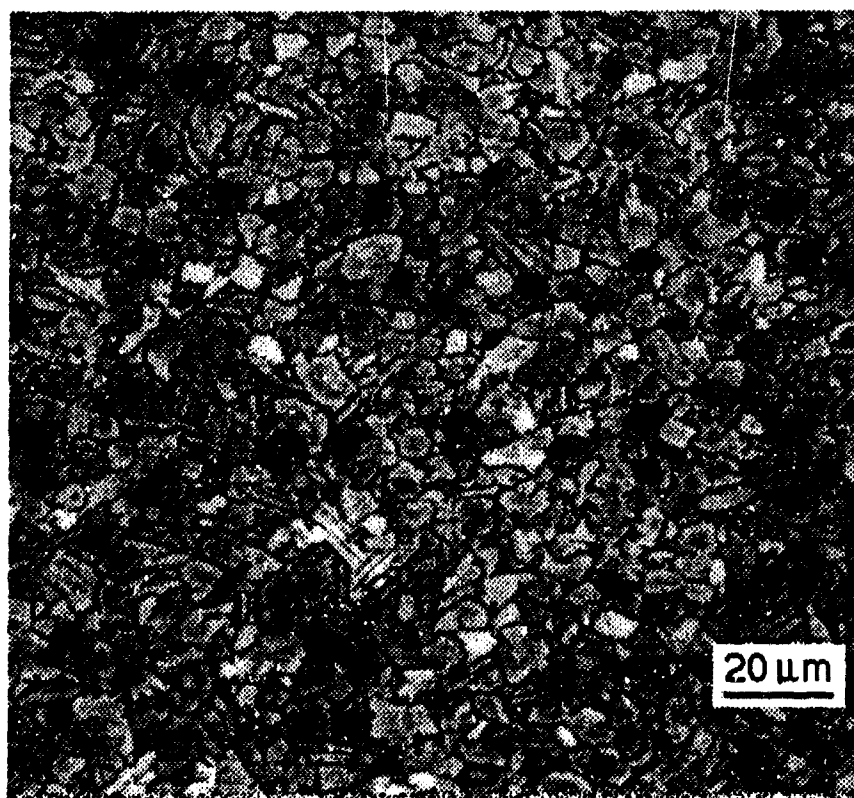
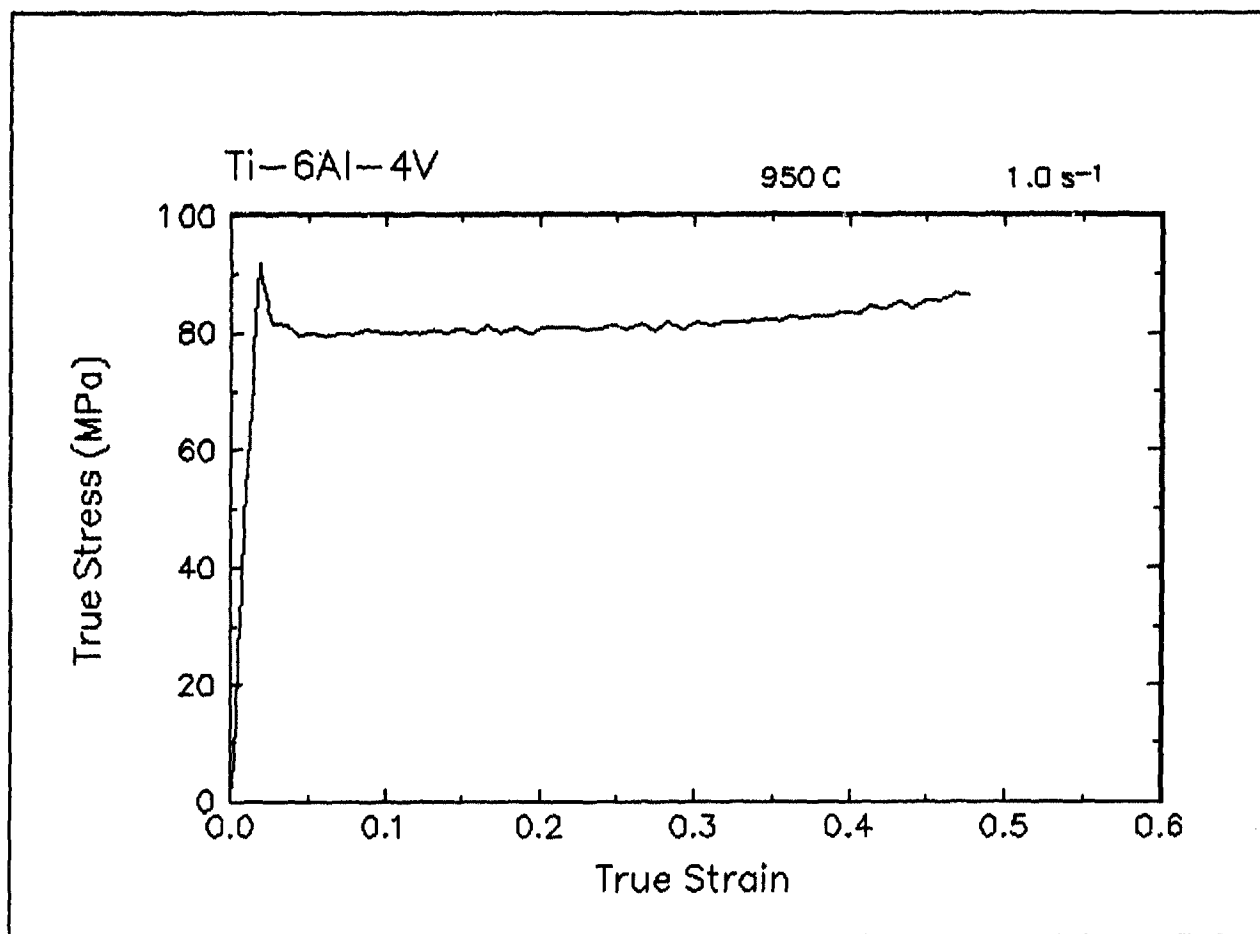


Figure 23. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 950 C and 1 s⁻¹.

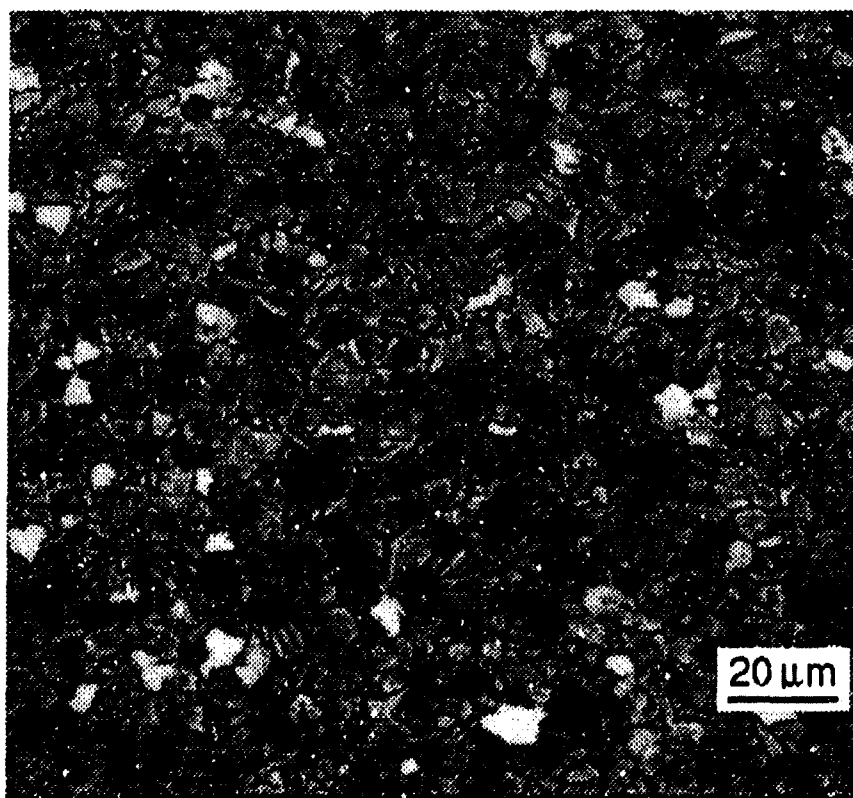
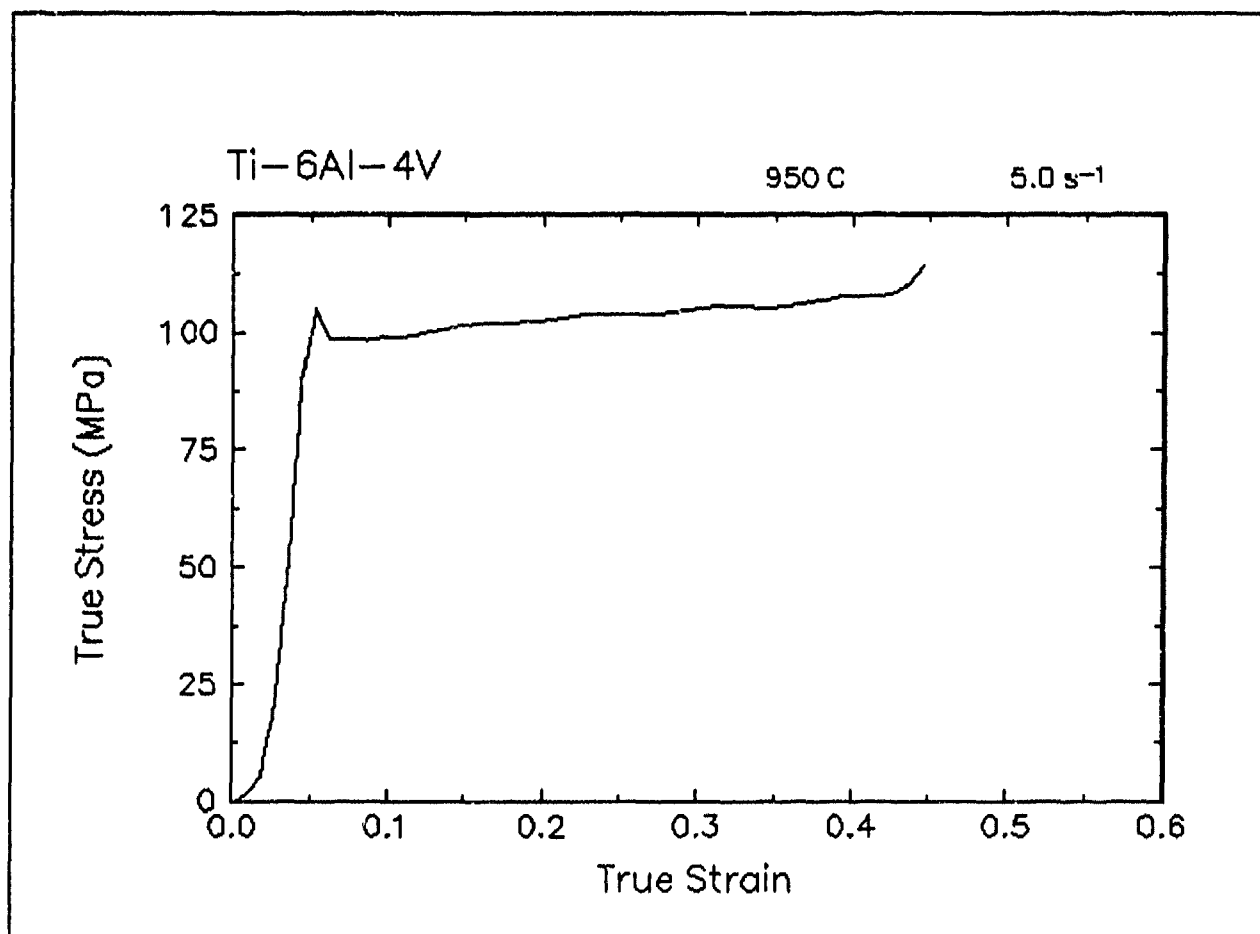


Figure 24. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 950 C and 5 s⁻¹.

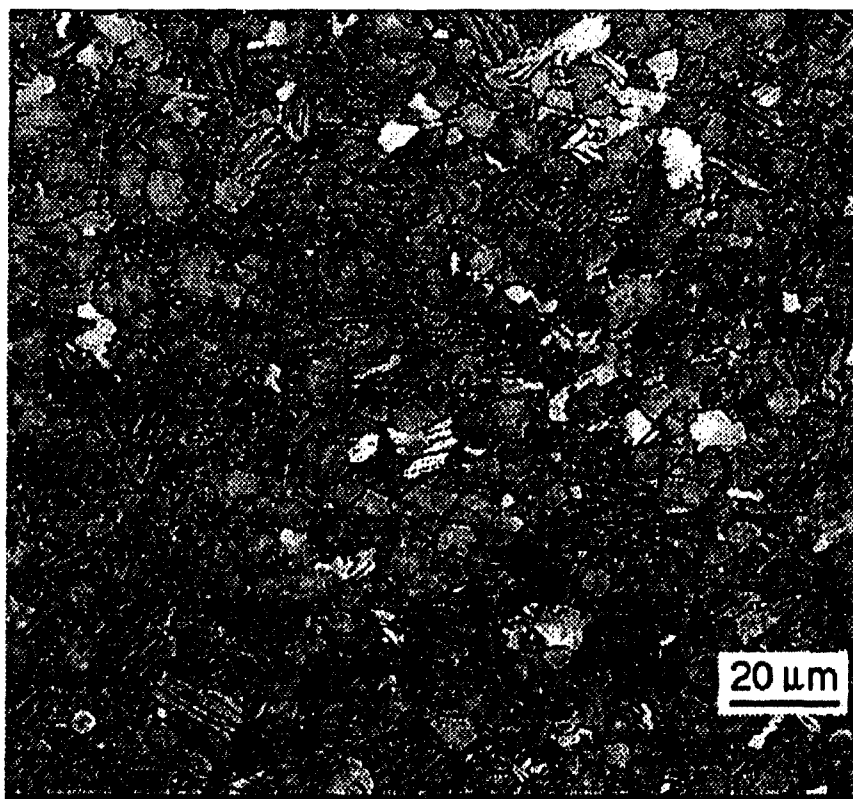
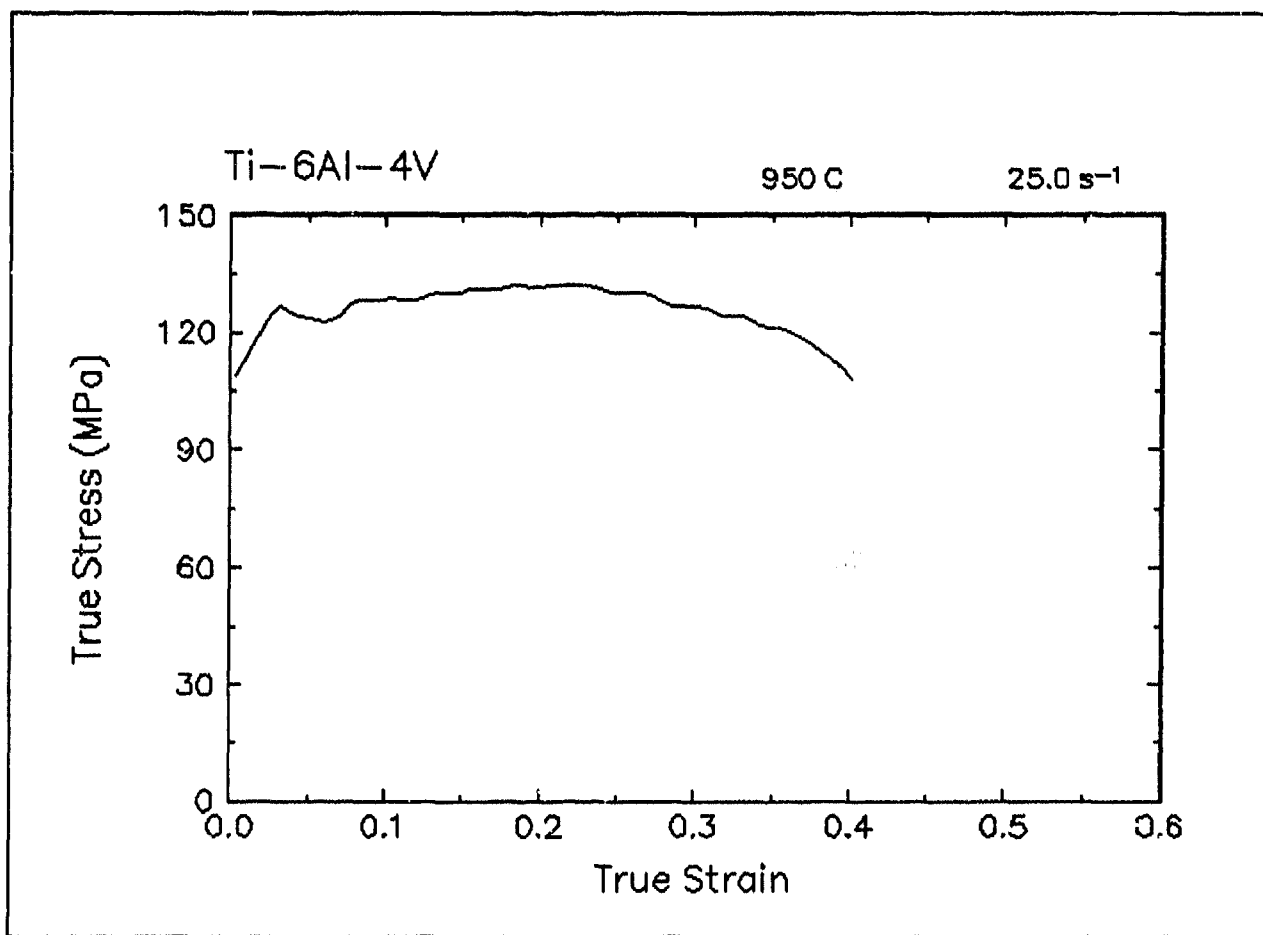


Figure 25. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 950 C and 25 s⁻¹.

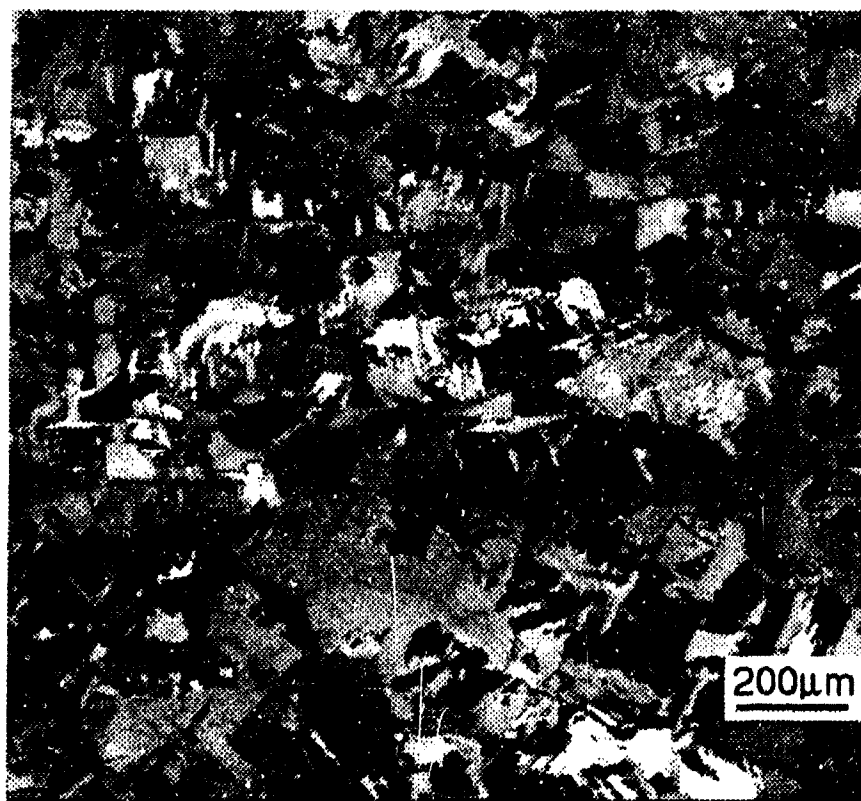
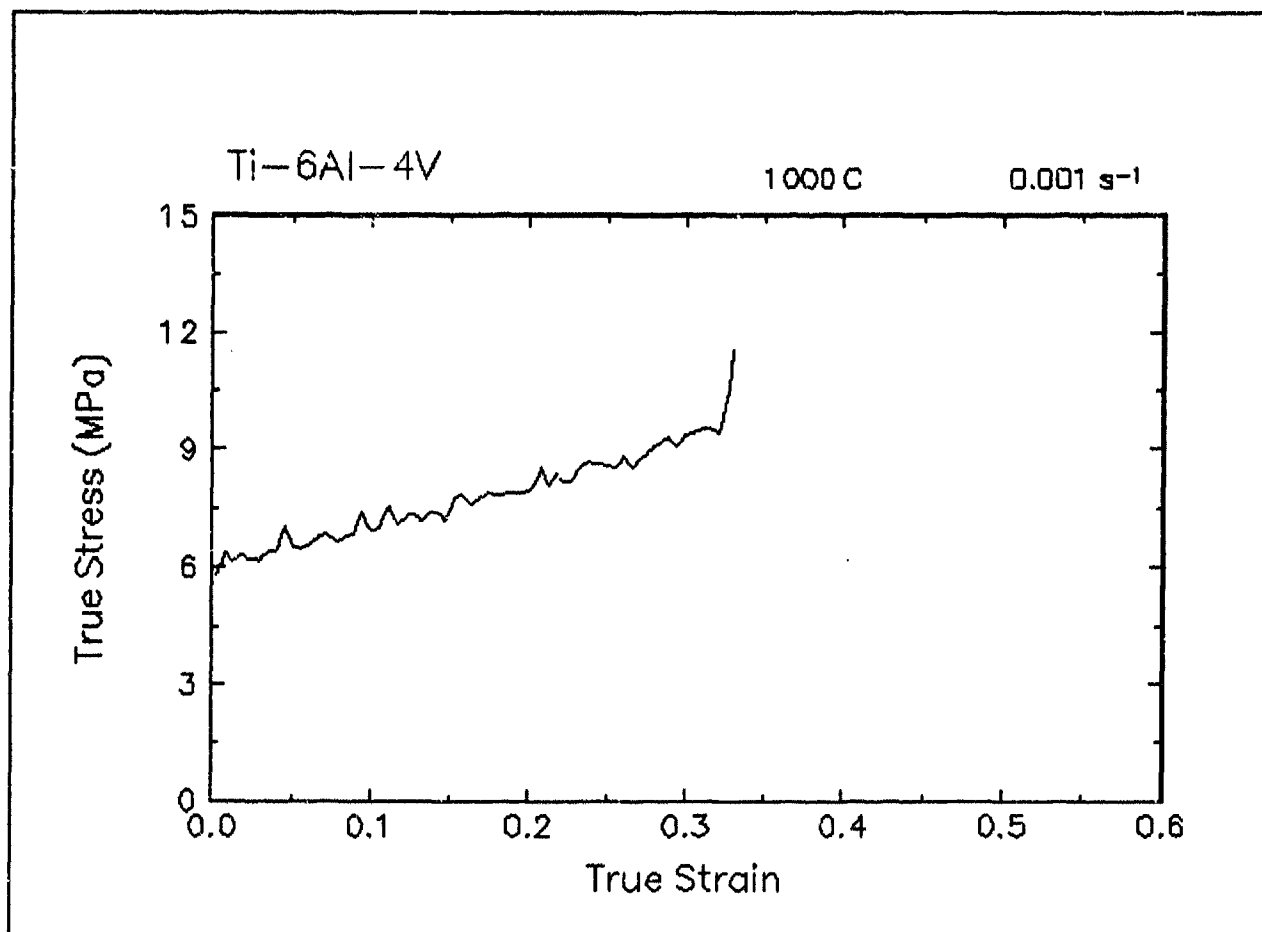


Figure 26. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1000 C and 0.001 s⁻¹.

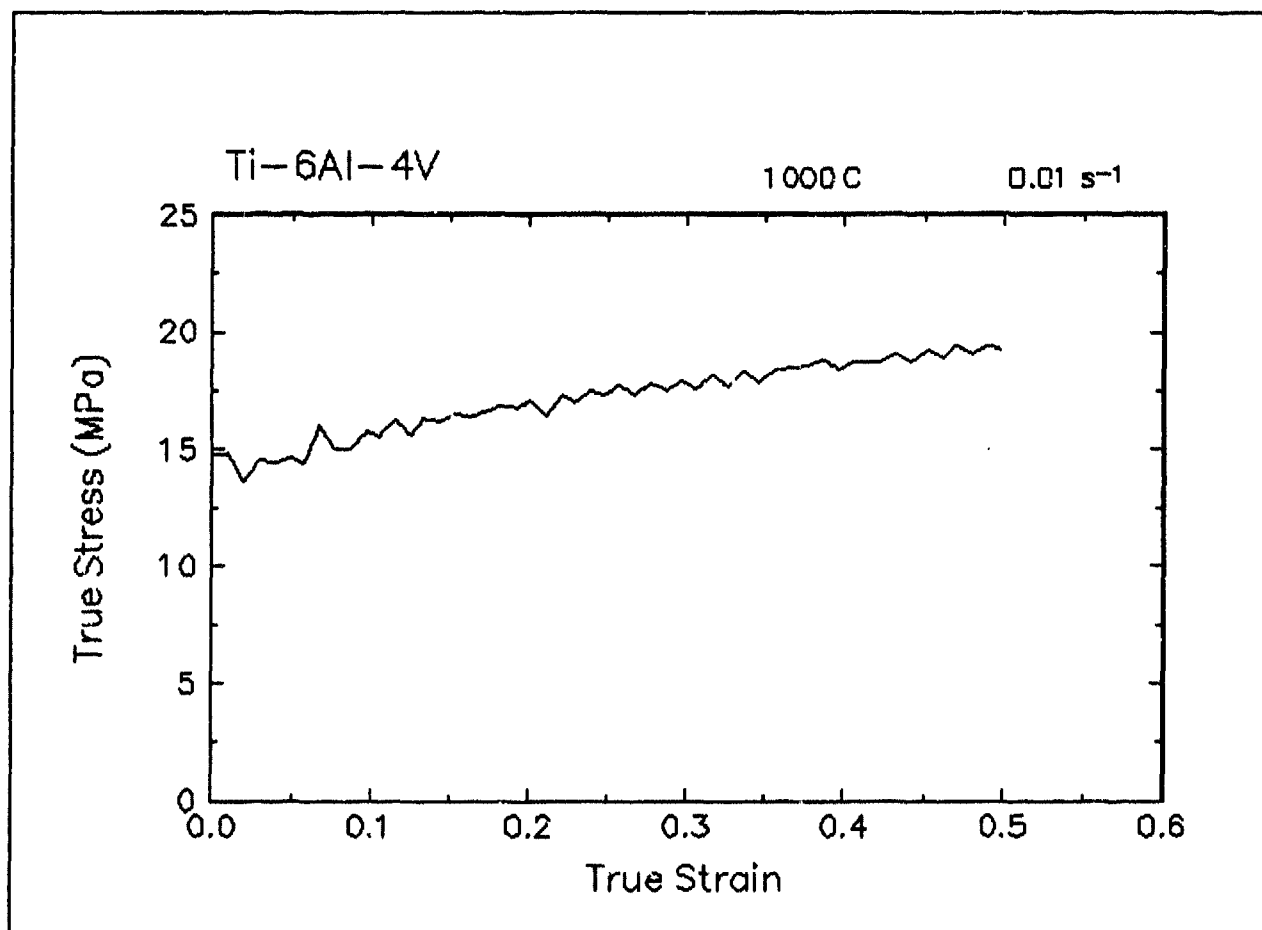


Figure 27. True stress-true strain curve, 1000 C and 0.01 s⁻¹.

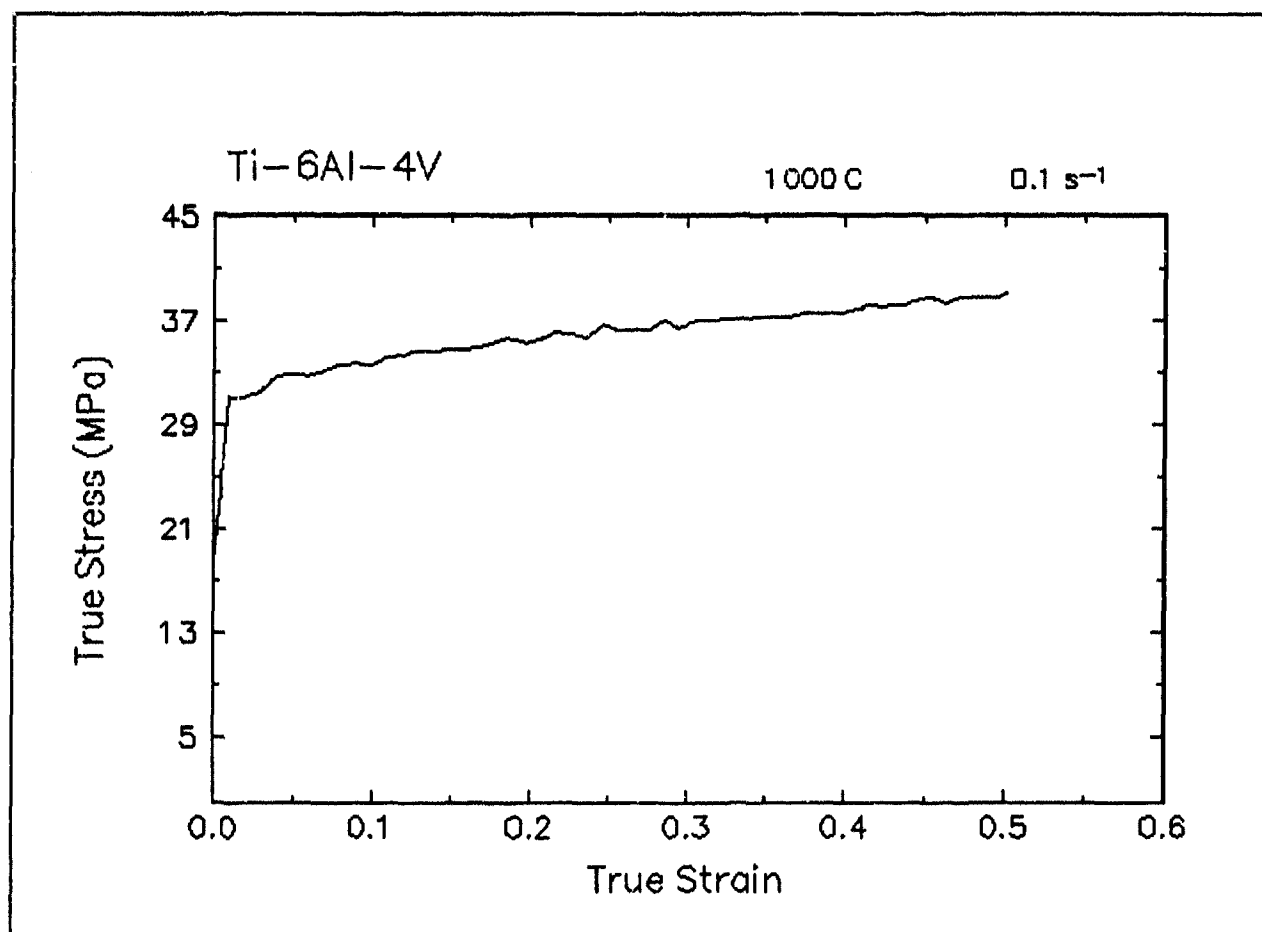


Figure 28. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1000 C and 0.1 s⁻¹.

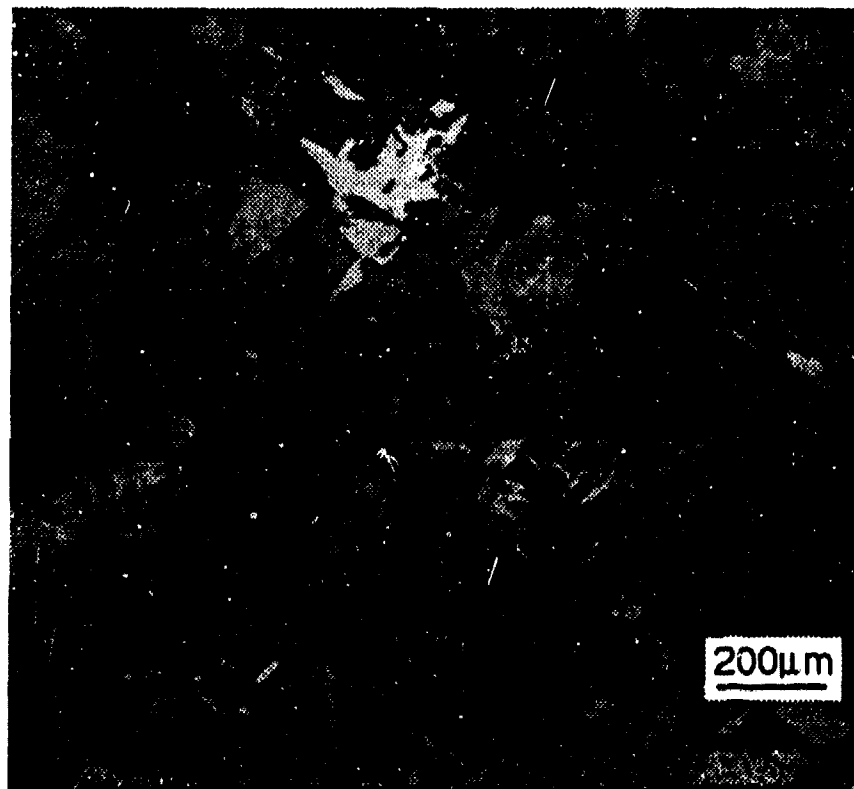
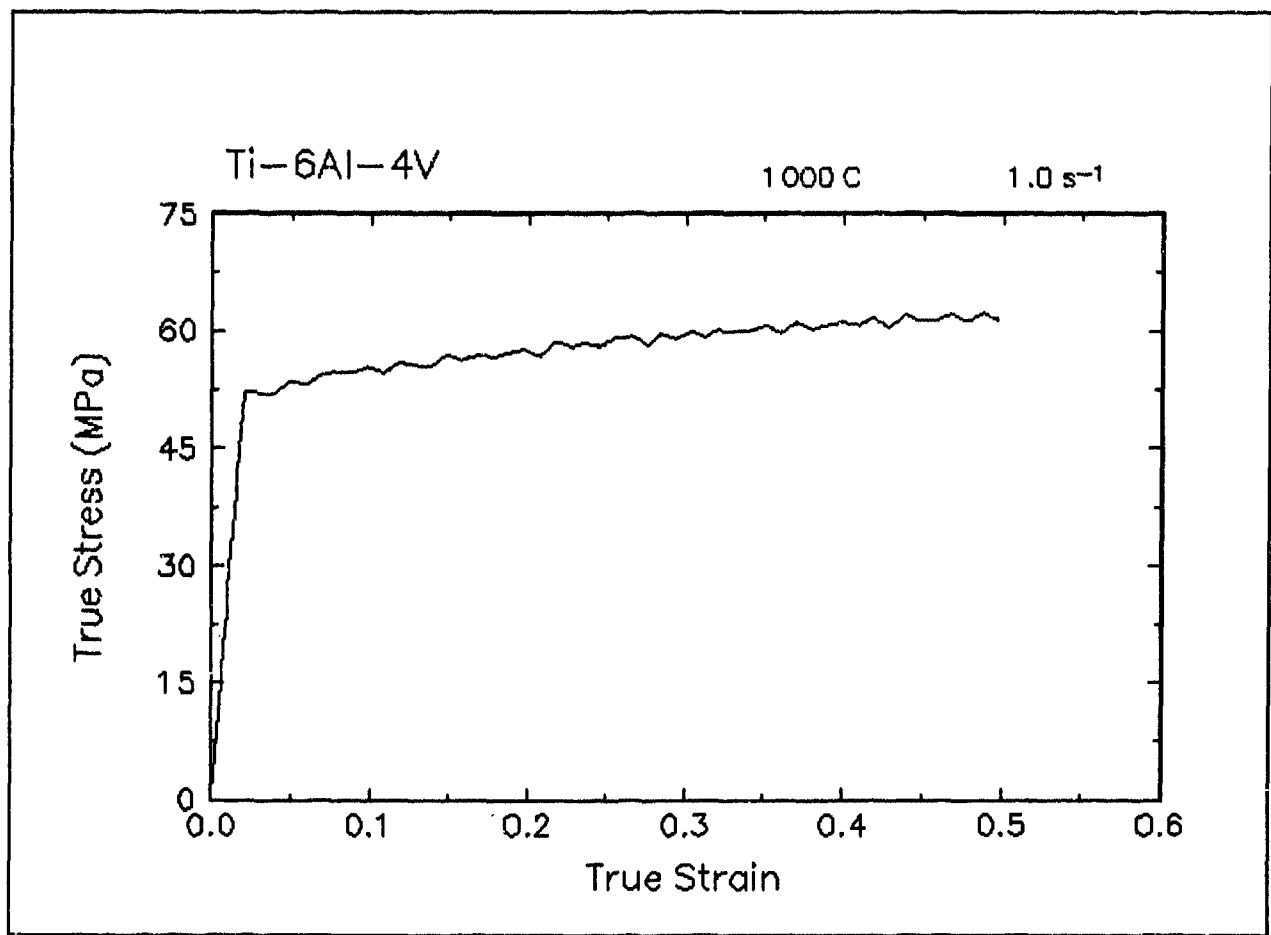


Figure 29. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1000 C and 1 s⁻¹.

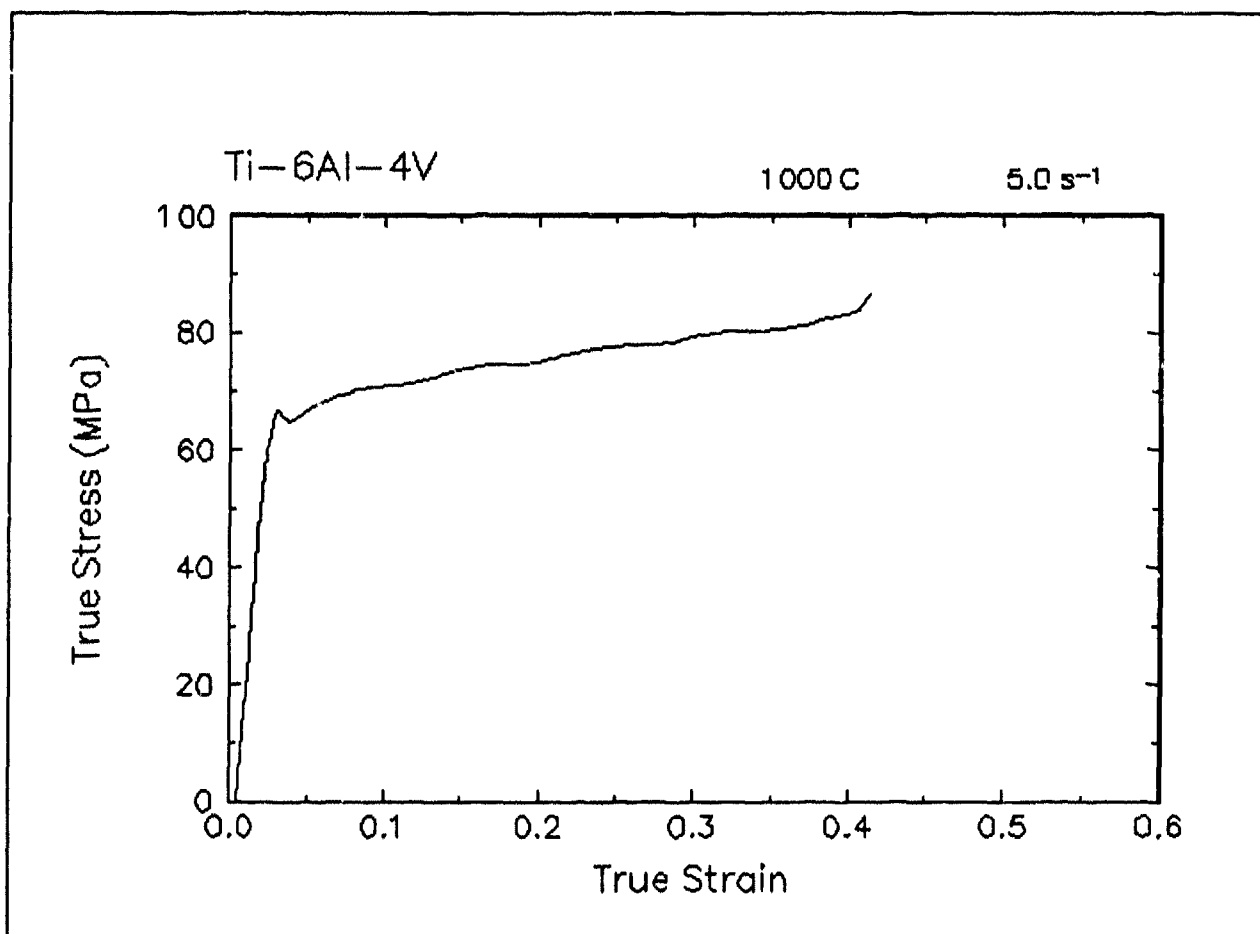


Figure 30. True stress-true strain curve, 1000 C and 5 s⁻¹.

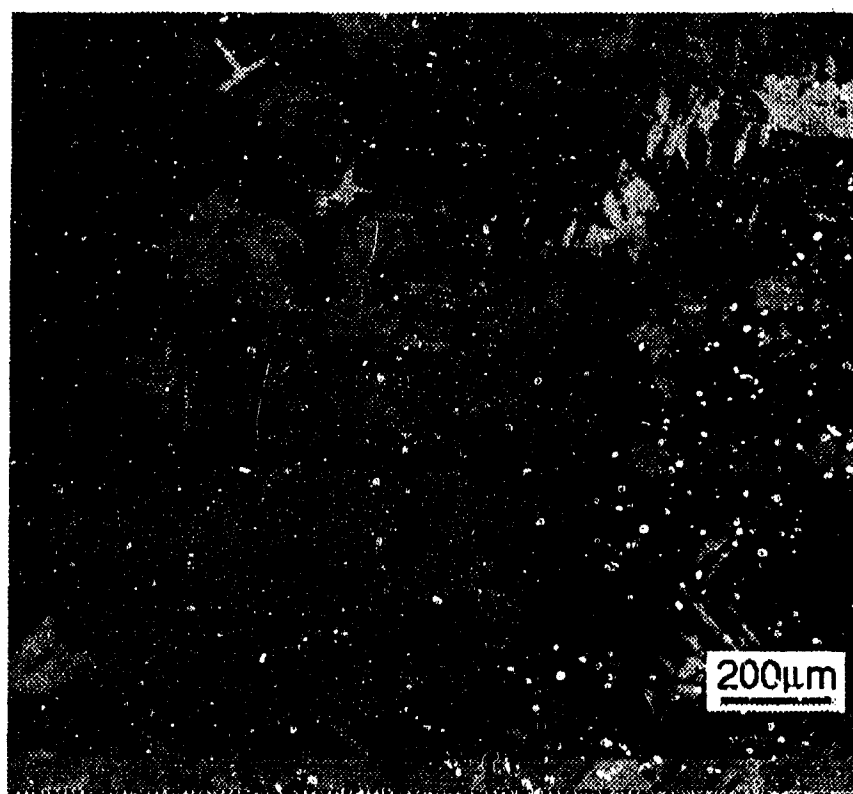
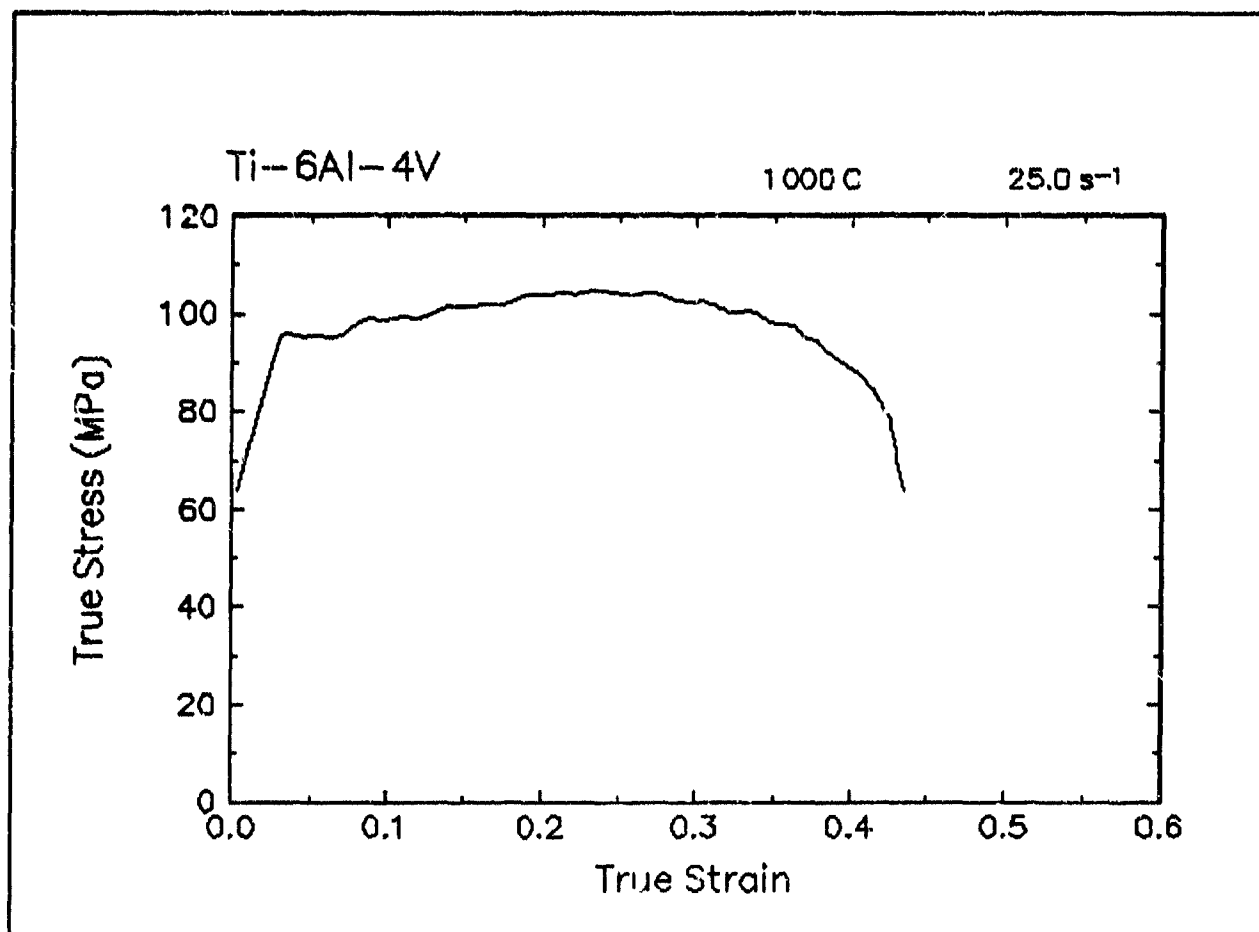


Figure 31. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1000 C and 25 s⁻¹.

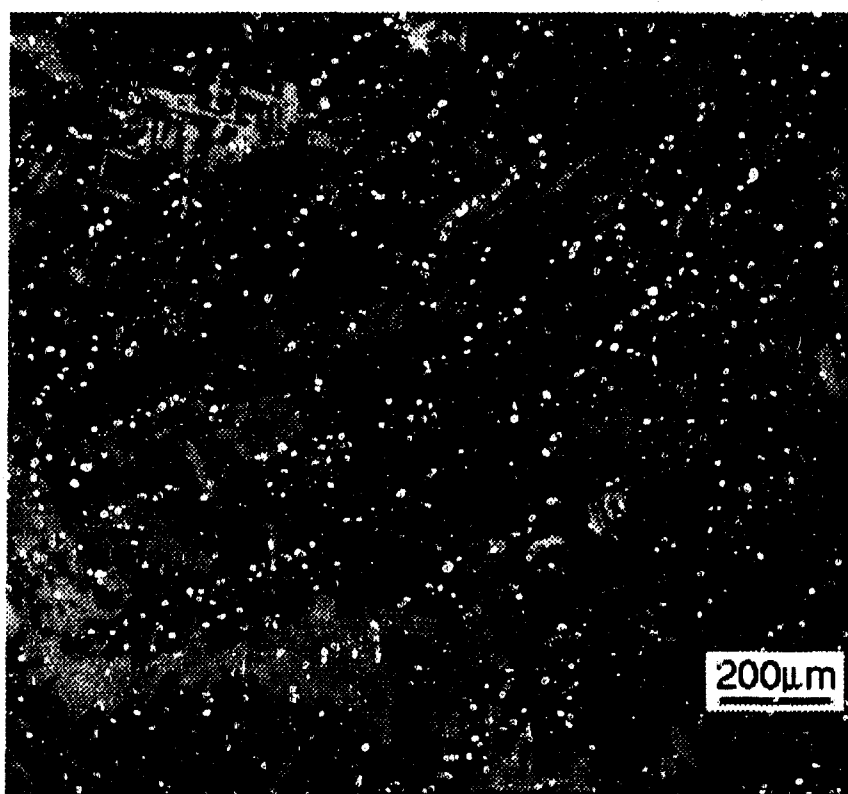
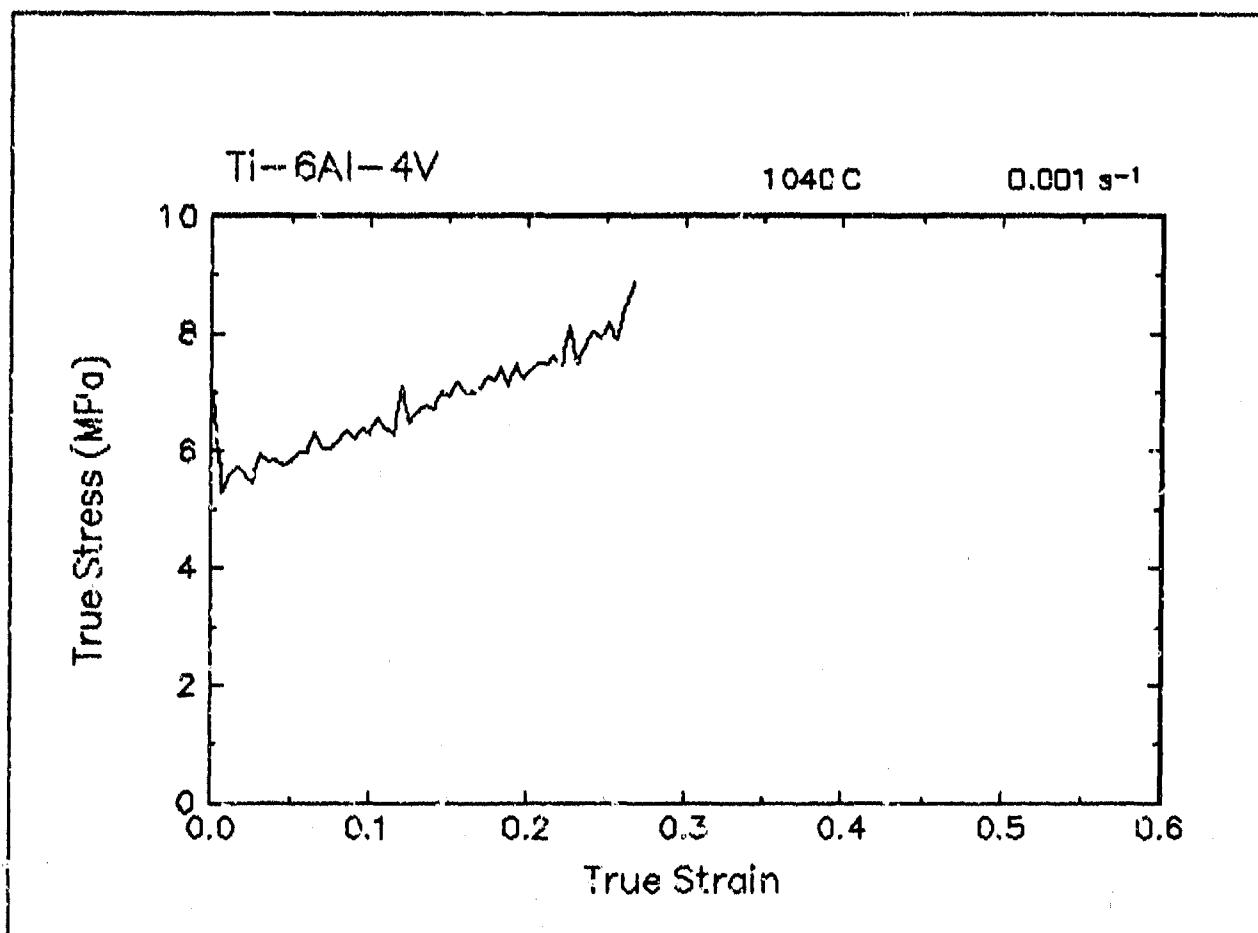


Figure 32. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1040 C and 0.001 s⁻¹.

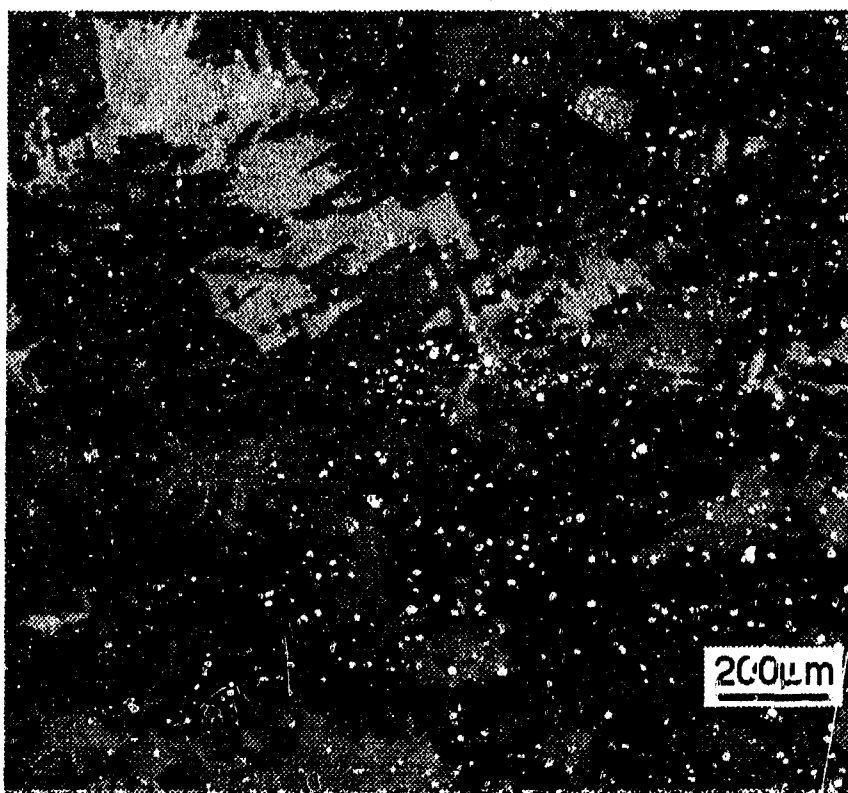
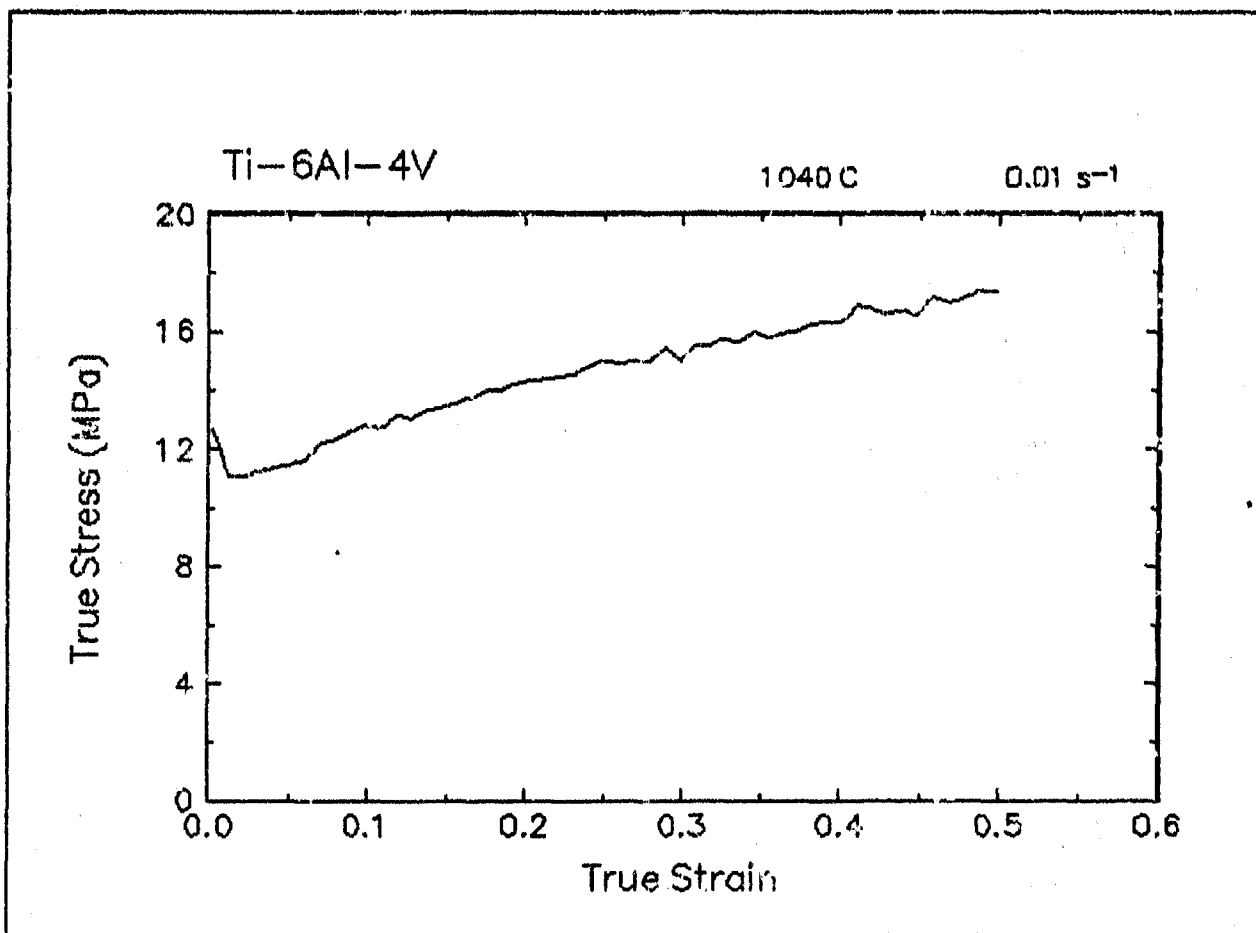


Figure 33. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1040 C and 0.01 s⁻¹.

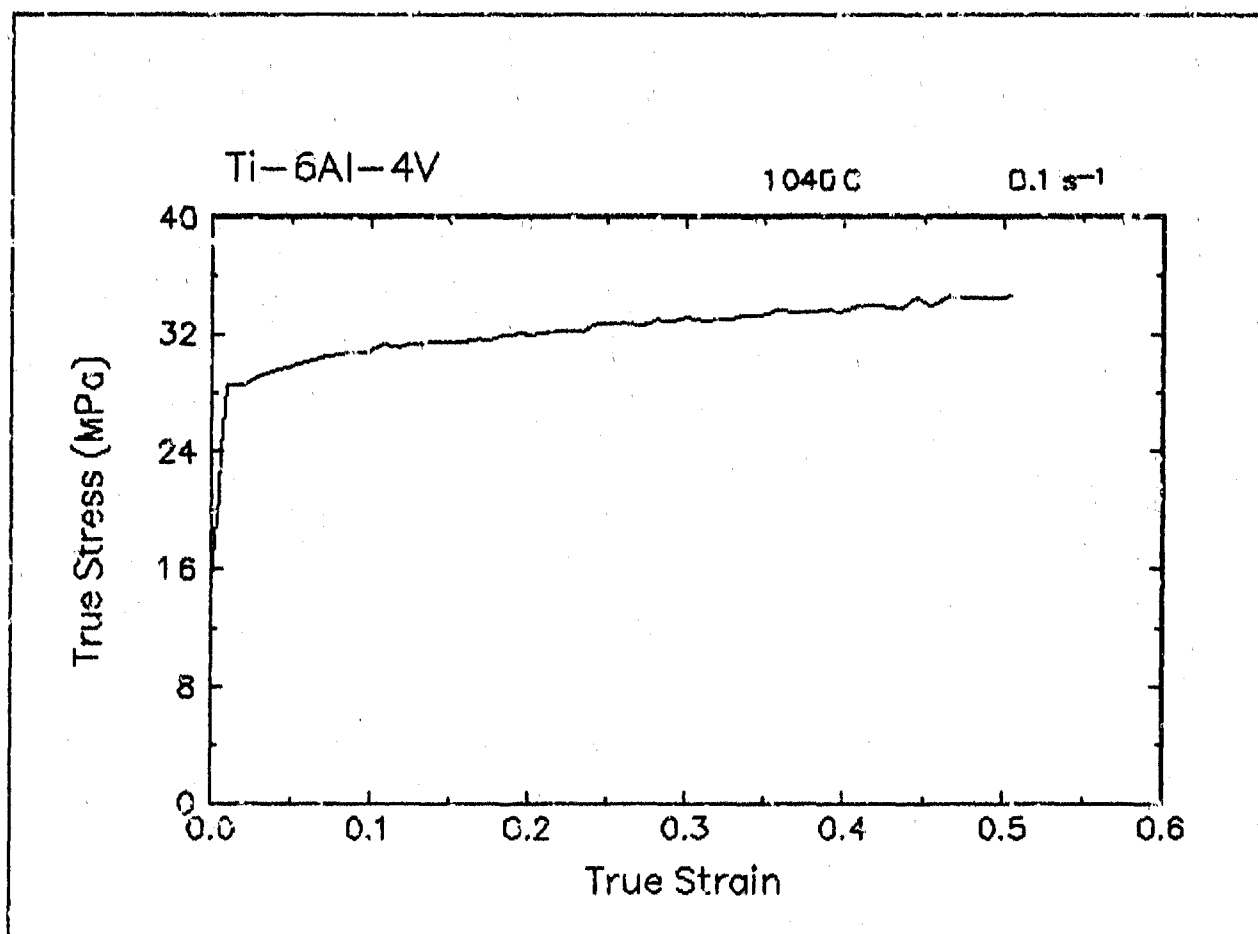


Figure 34. True stress-true strain curve, 1040 C and 0.1 s⁻¹.

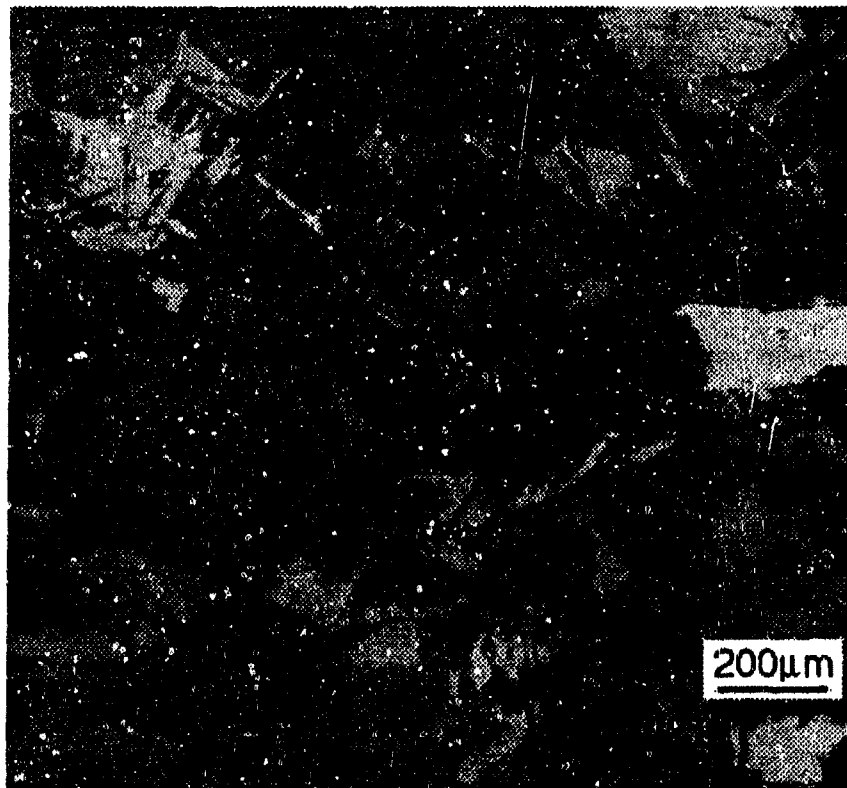
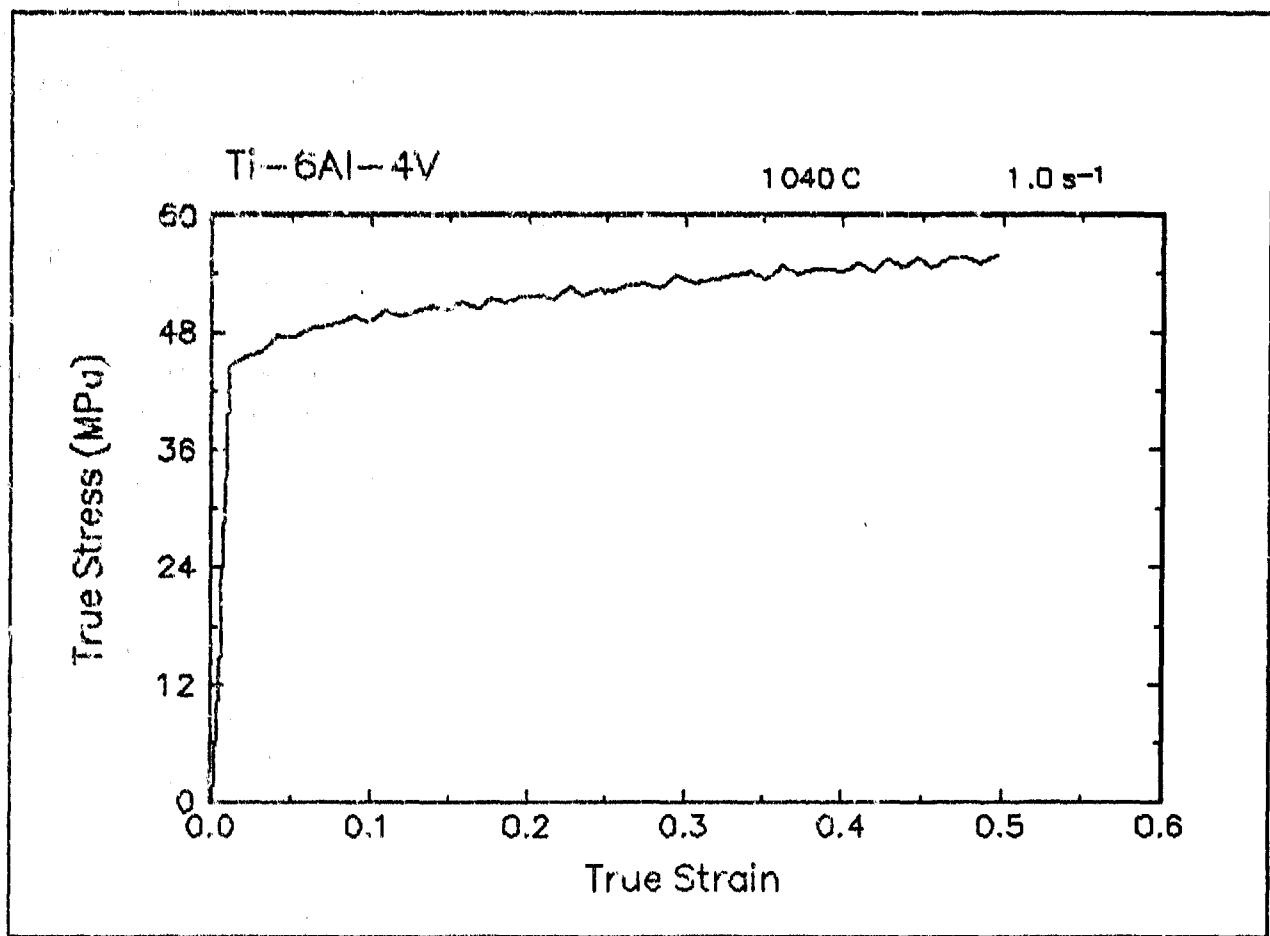


Figure 35. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1040 C and 1 s⁻¹.

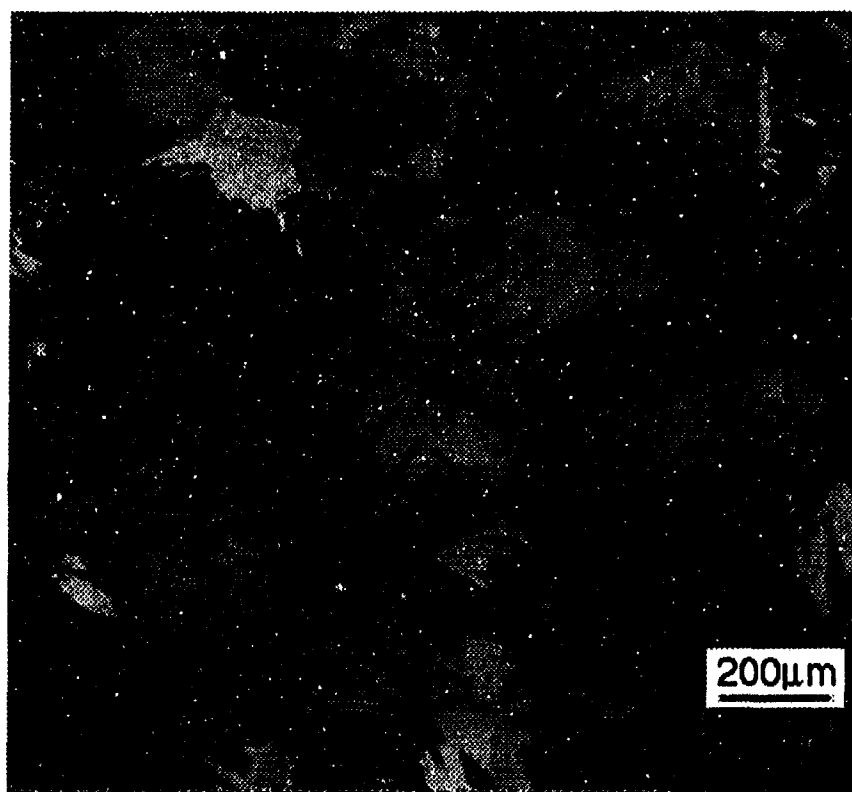
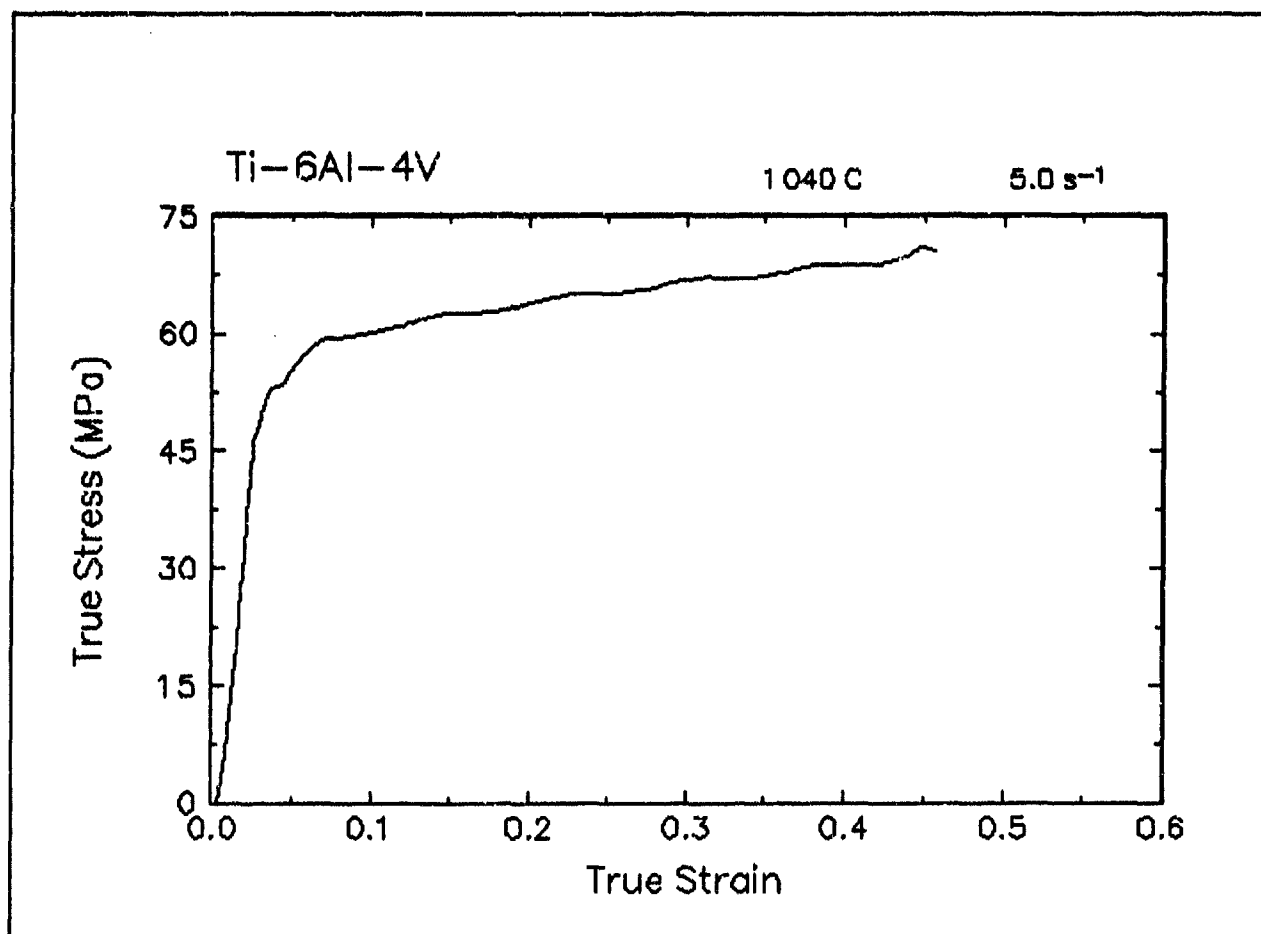


Figure 36. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1040 C and 5 s⁻¹.

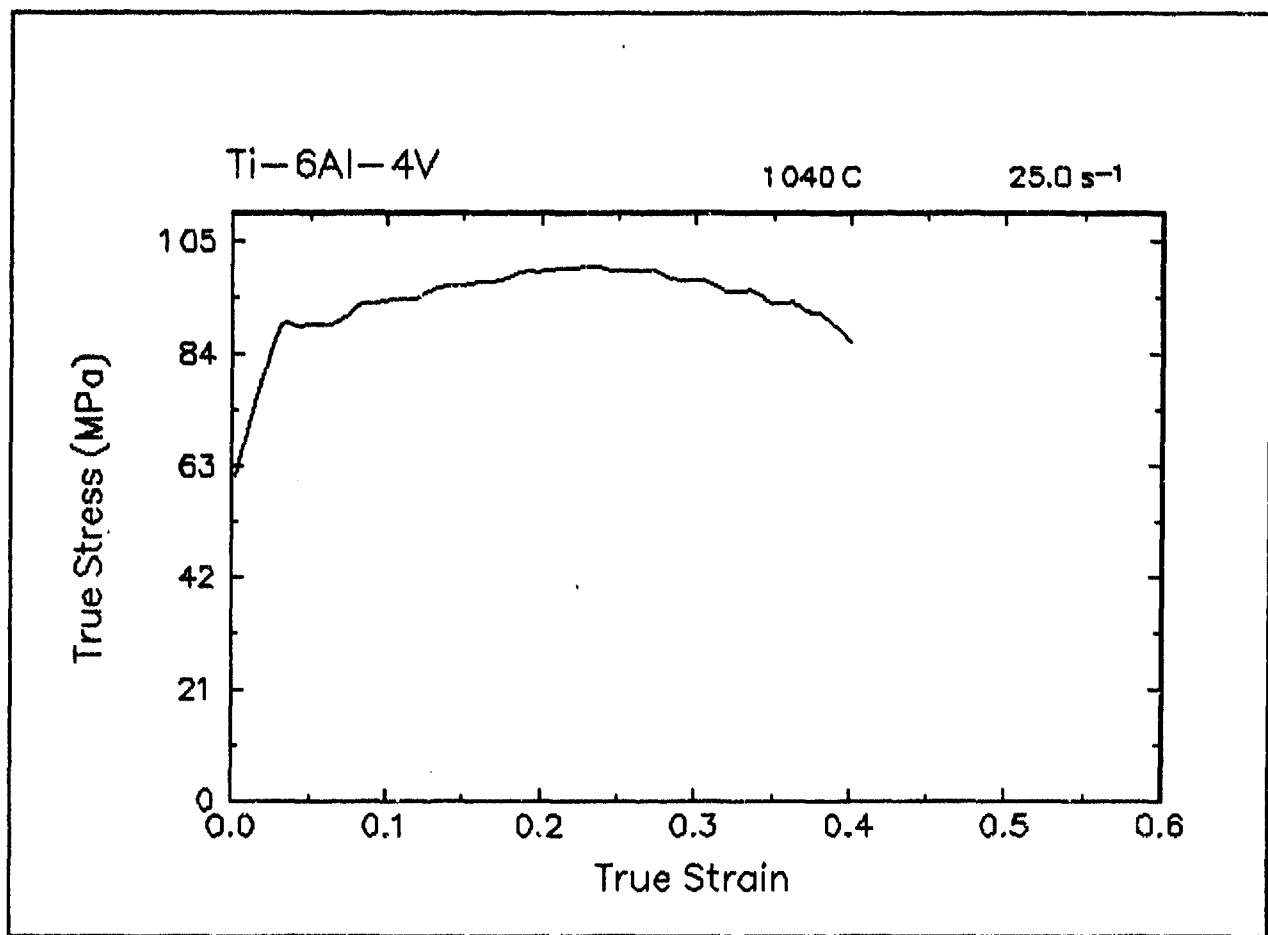


Figure 37. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1040 C and 25 s⁻¹.

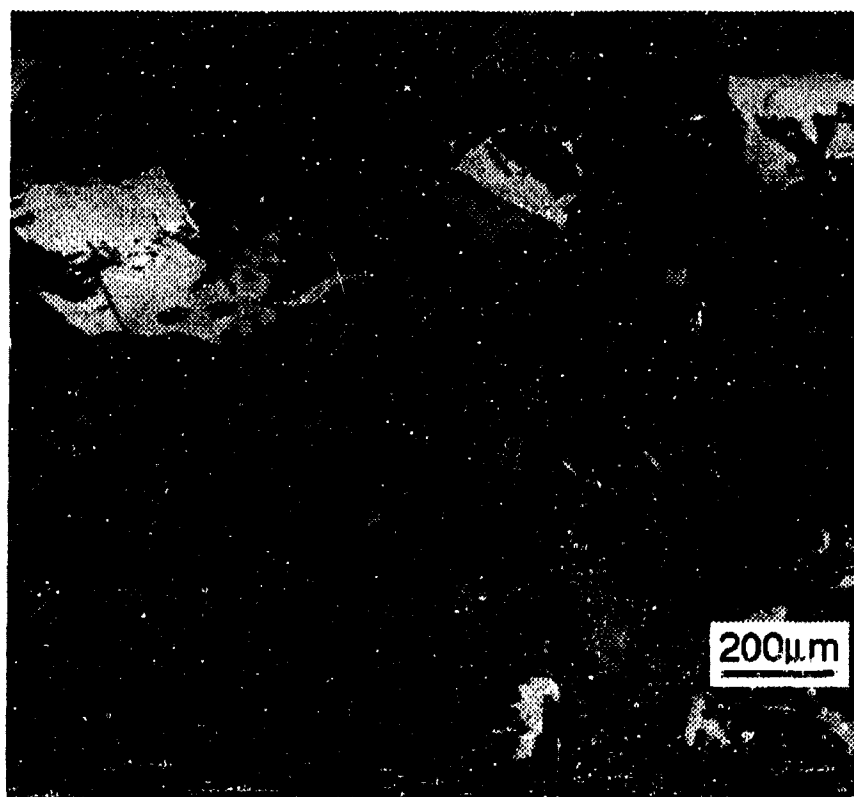
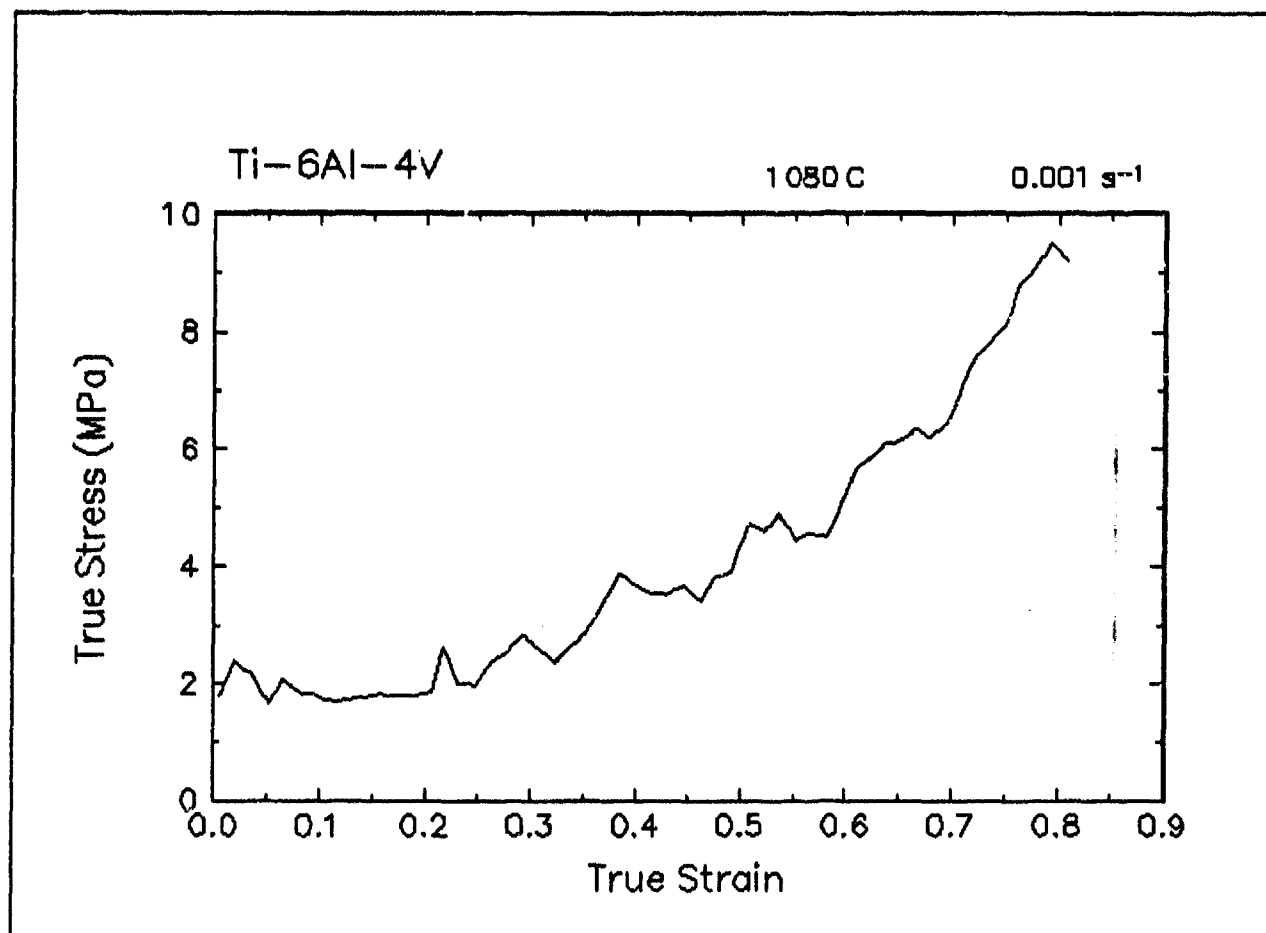


Figure 38. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1080 C and 0.001 s⁻¹.

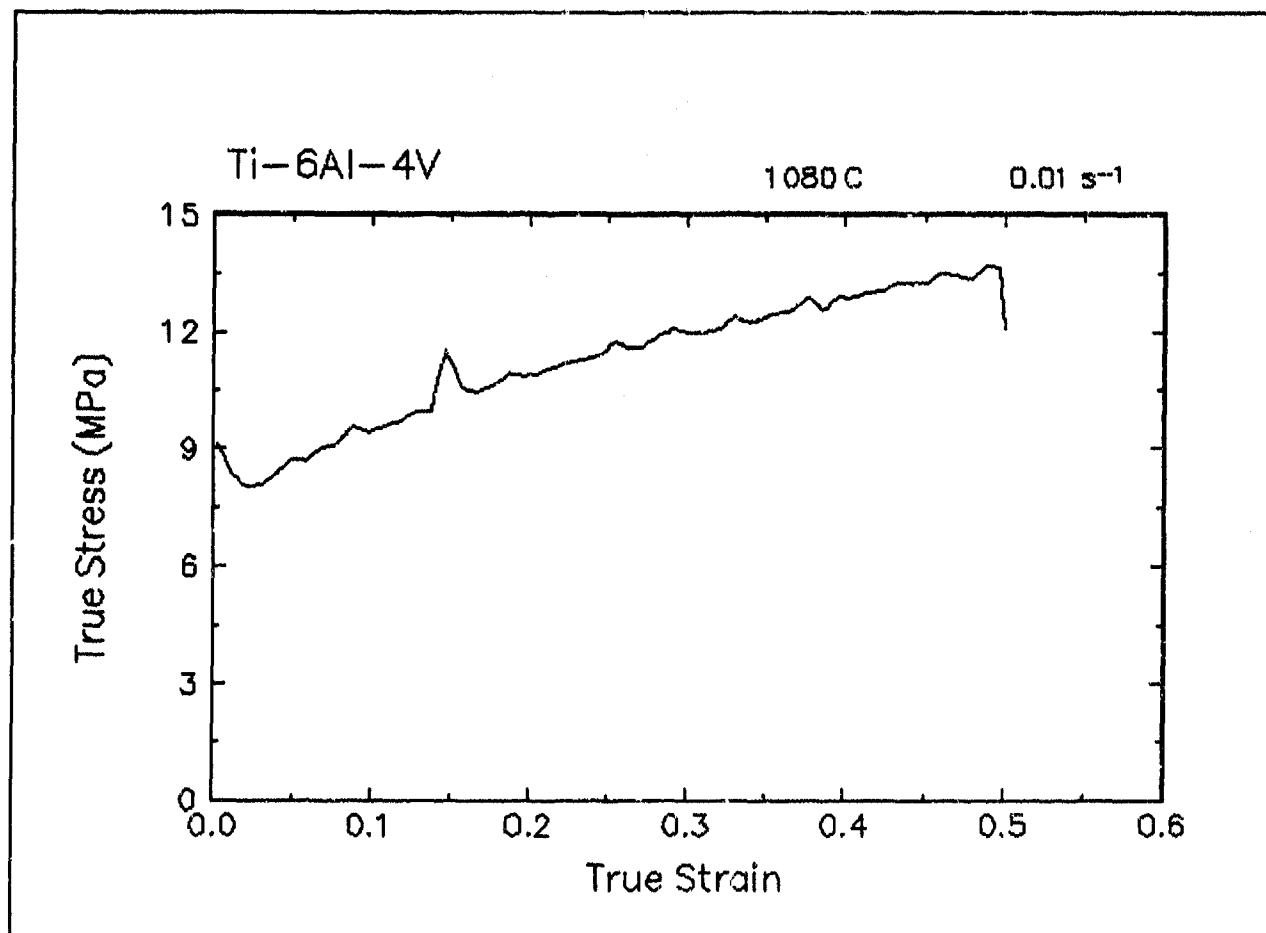


Figure 39. True stress-true strain curve, 1080 C and 0.01 s⁻¹.

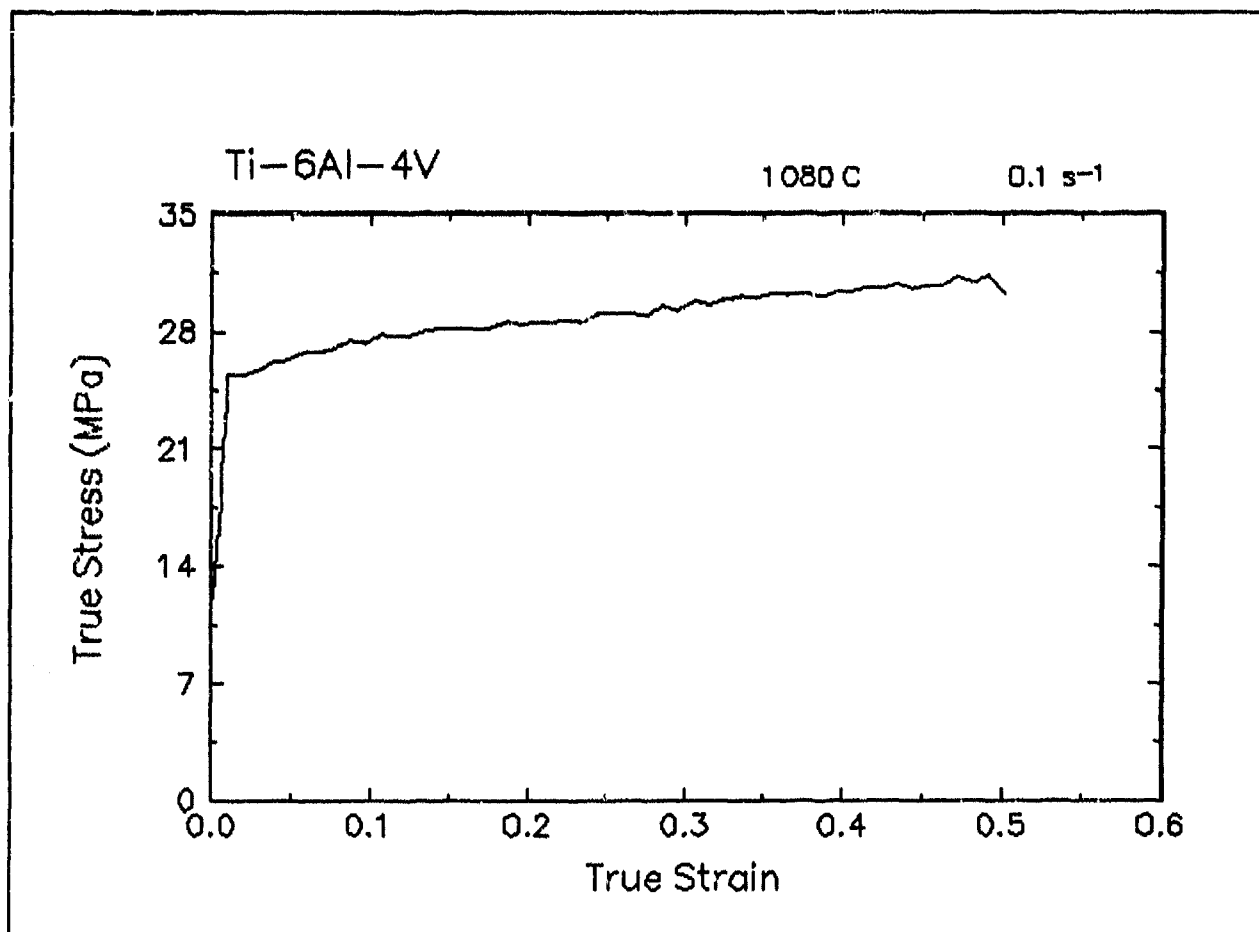


Figure 40. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1080 C and 0.1 s⁻¹.

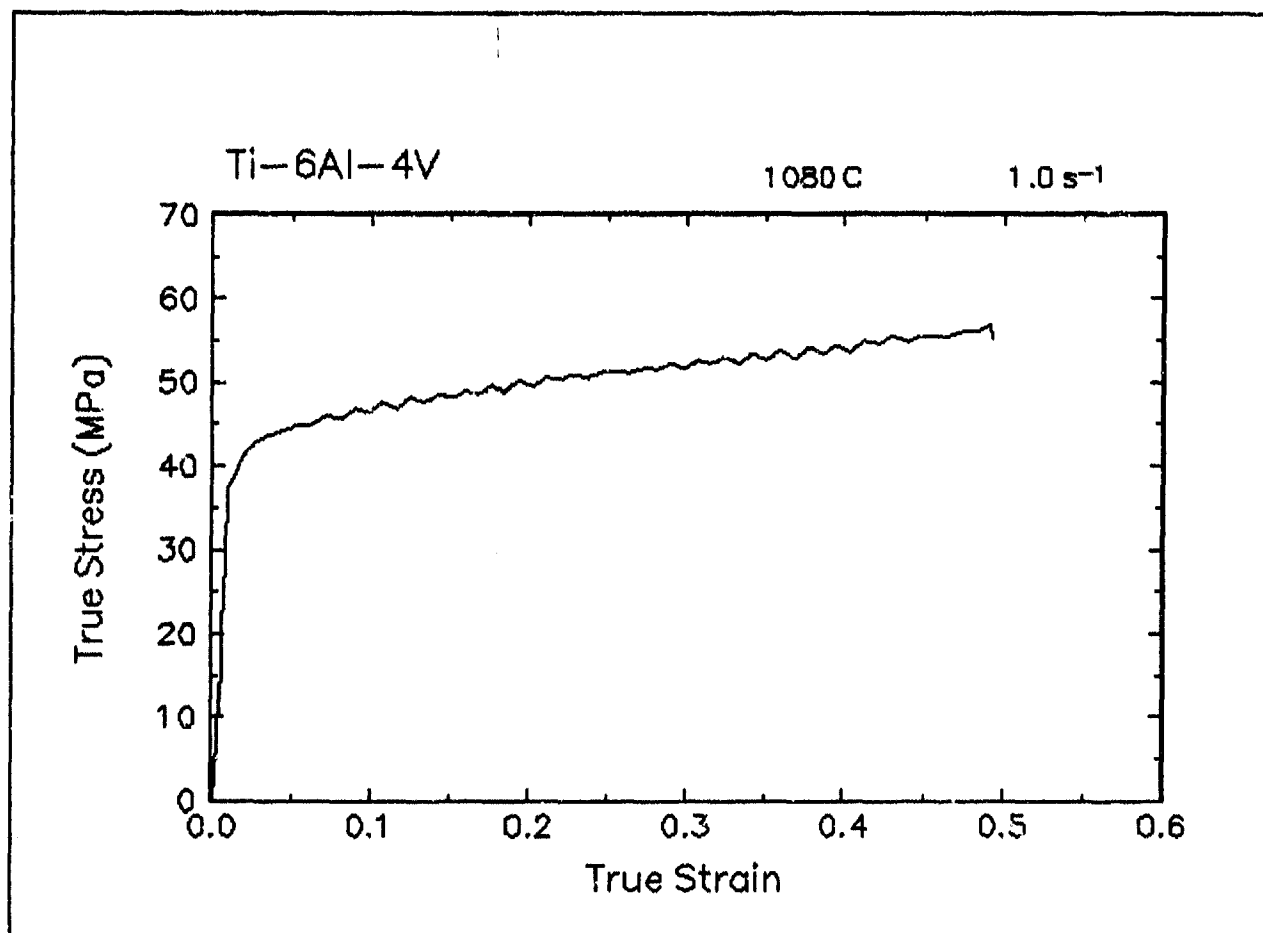


Figure 41. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1080 C and 1 s⁻¹.

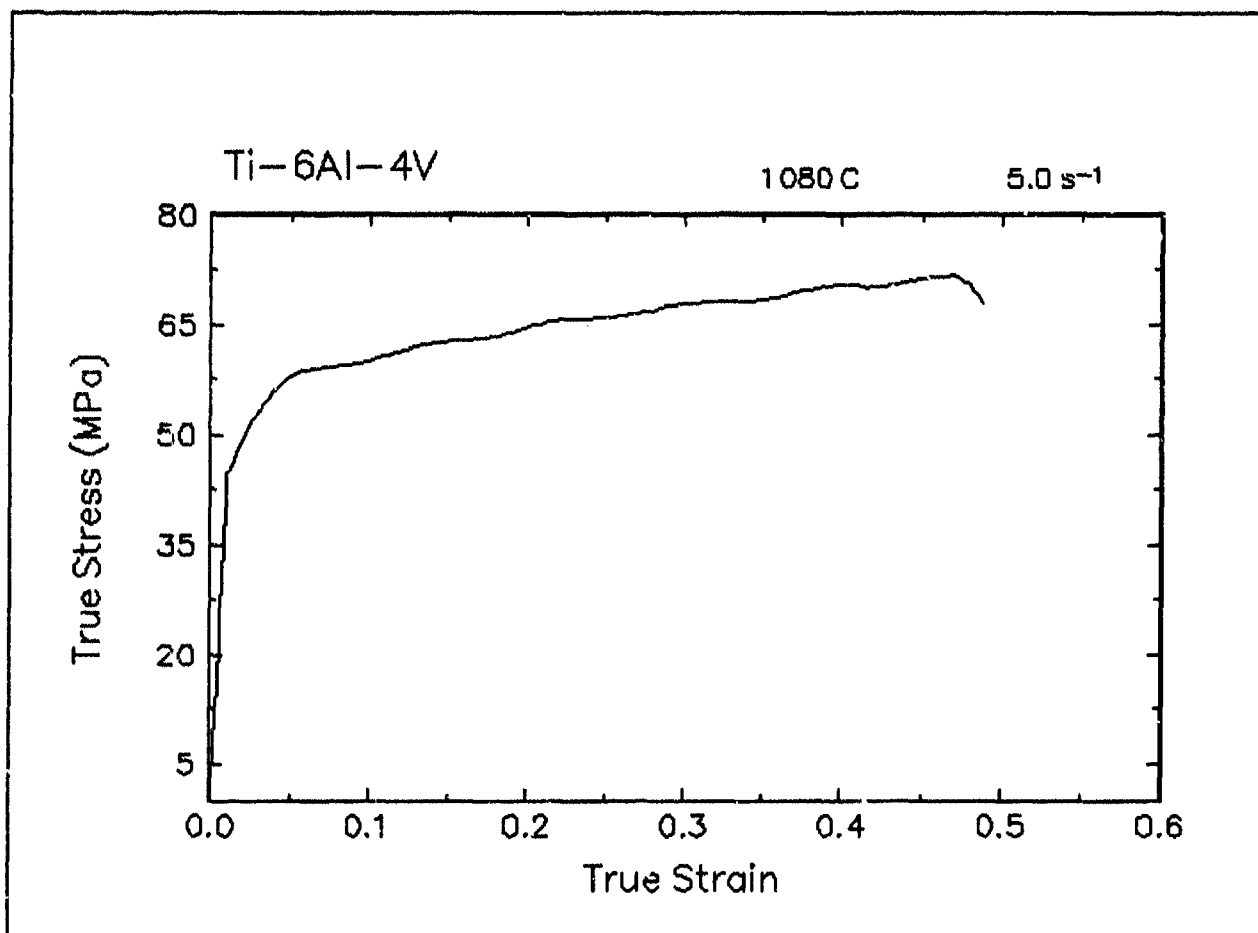


Figure 42. True stress-true strain curve, 1080 C and 5 s⁻¹.

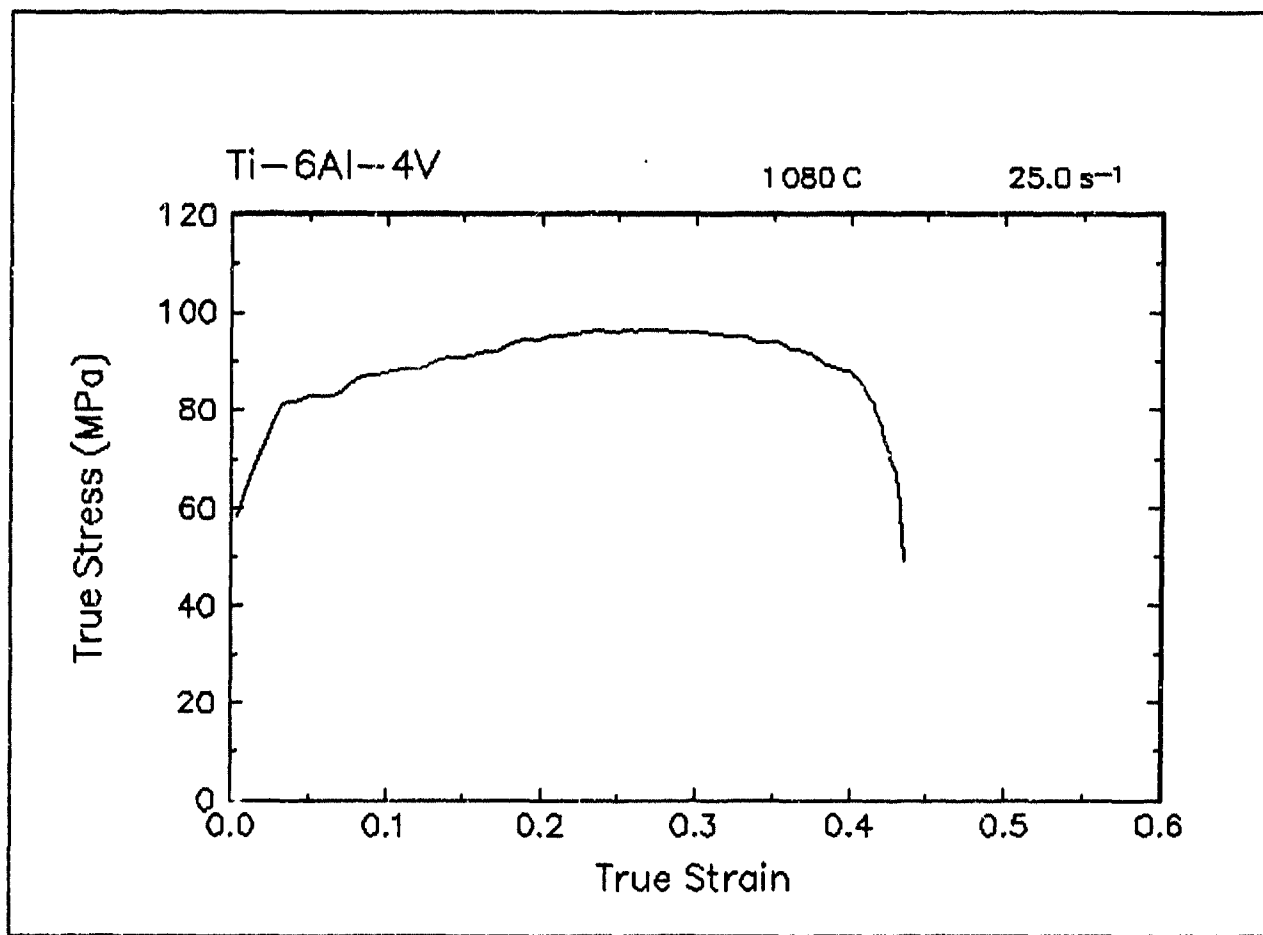


Figure 43. True stress-true strain curve and an optical micrograph from the center of the compressed sample cut through the compression axis, 1080 C and 25 s⁻¹.

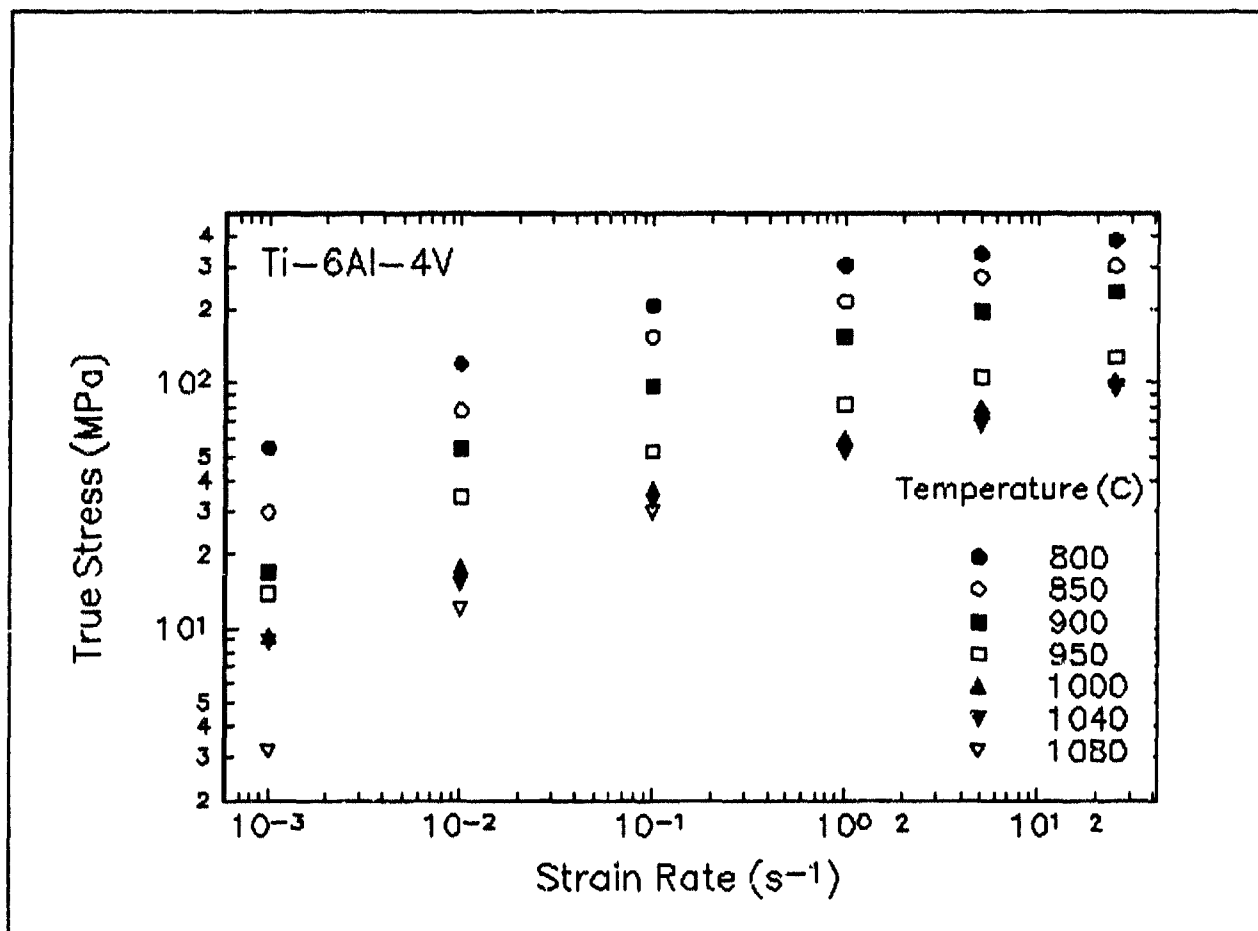


Figure 44. Effect of strain rate on stress in log-log scale at a true strain of 0.3 for Ti-6Al-4V ELI.

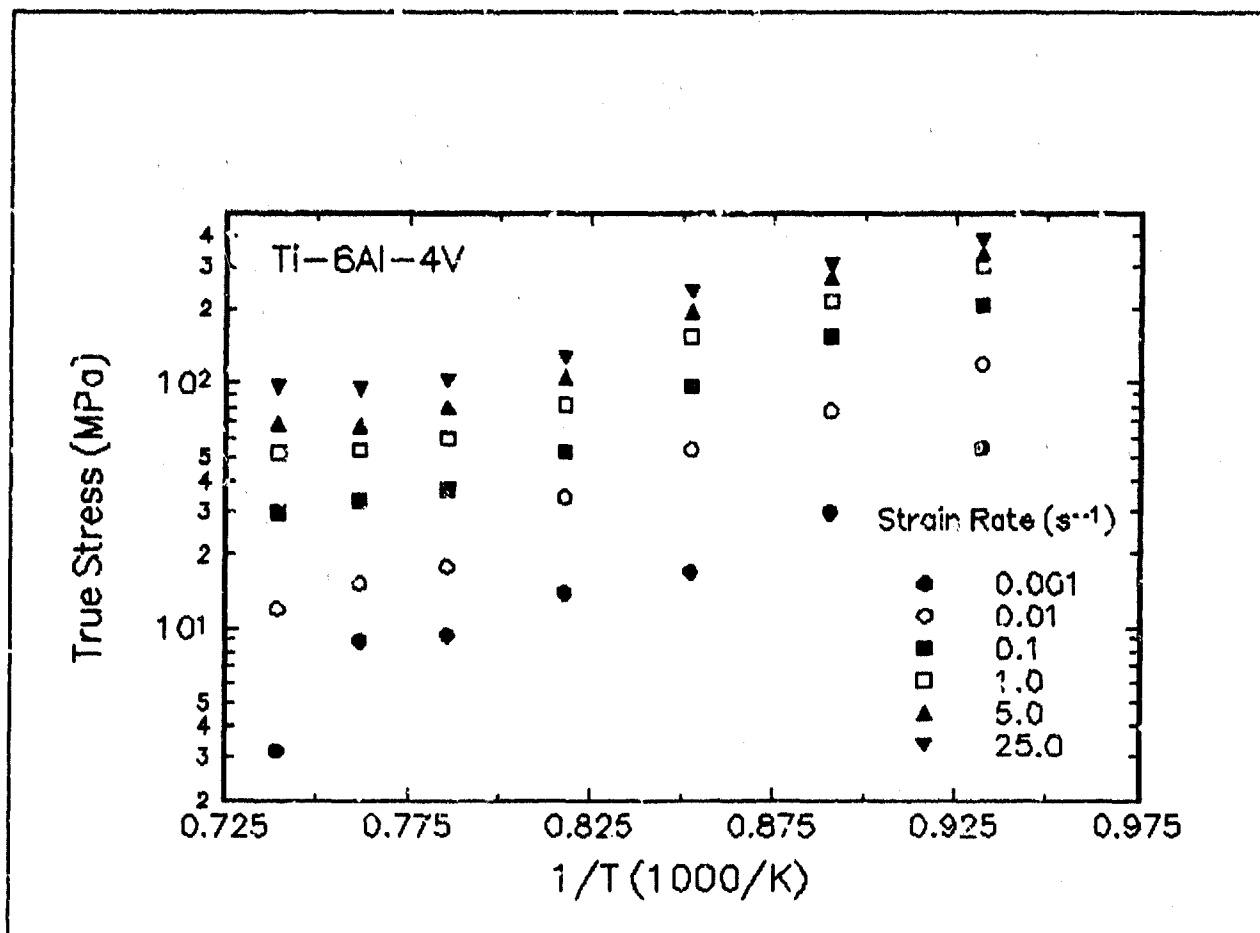


Figure 45. Effect of temperature on stress at a true strain of 0.3 for Ti-6Al-4V ELI.

Summary

Compression tests have been performed on Ti-6Al-4V ELI over a wide range of temperatures and strain rates. The experimental conditions used in this work are representative of those used in metalforming practices. From the stress-strain curves, the flow behavior was characterized and a processing map indicating the optimum processing condition was generated. This condition is approximately 896 C and 0.001 s^{-1} .

The deformed microstructures were characterized from the quenched specimens by optical microscopy and are presented for selective testing conditions together with the stress-strain curves.

Implementation of Data Provided by the Atlas of Formability

The Atlas of Formability program provides ample data on flow behavior of various important engineering materials in the temperature and strain rate regime commonly used in metalworking processes. The data are valuable in design and problem solving in metalworking processes of advanced materials. Microstructural changes with temperature and strain rates are also provided in the Bulletin, which helps the design engineer to select processing parameters leading to the desired microstructure.

The data can also be used to construct processing map using dynamic material modeling approach to determine stable and unstable regions in terms of temperature and strain rate. The temperature and strain rate combination at the highest efficiency in the stable region provides the optimum processing condition. This has been demonstrated in this Bulletin. In some metalworking processes such as forging, strain rate varies within the workpiece. An analysis of the process with finite element method (FEM) can ensure that the strain rates at the processing temperature in the whole workpiece fall into the stable regions in the processing map. Furthermore, FEM analysis with the data from the Atlas of Formability can be coupled with fracture criteria to predict defect formation in metalworking processes.

Using the data provided by the Atlas of Formability, design of metalworking processes, dynamic material modeling, FEM analysis of metalworking processes, and defect prediction are common practice in *Concurrent Technologies Corporation*. Needs in solving problems related to metalworking processes can be directed to Dr. Prabir K. Chaudhury, Manager of Forming Department, by calling (814) 269-2594.